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# **FT-23R**

## **TECHNICAL SUPPLEMENT**



**YAESU MUSEN CO., LTD.**

C.P.O. BOX 1500, TOKYO, JAPAN

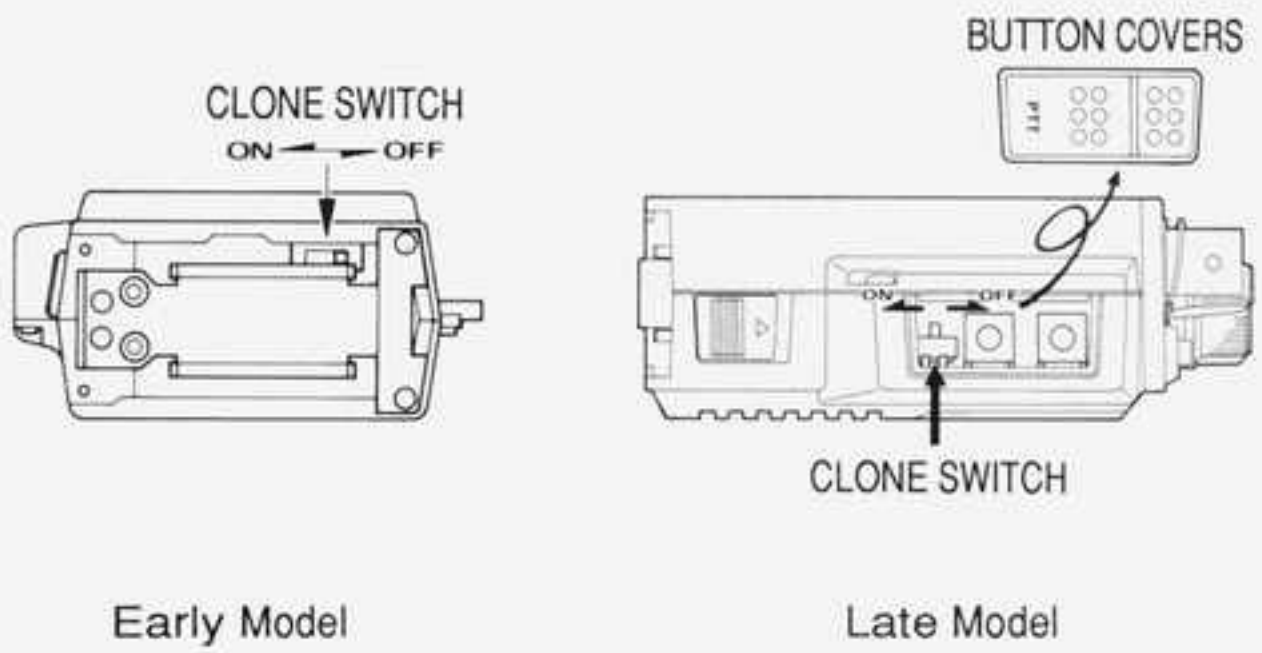
**YAESU U.S.A.**

17210 Edwards Rd., Cerritos, California 90701, U.S.A.

**YAESU EUROPE B.V.**

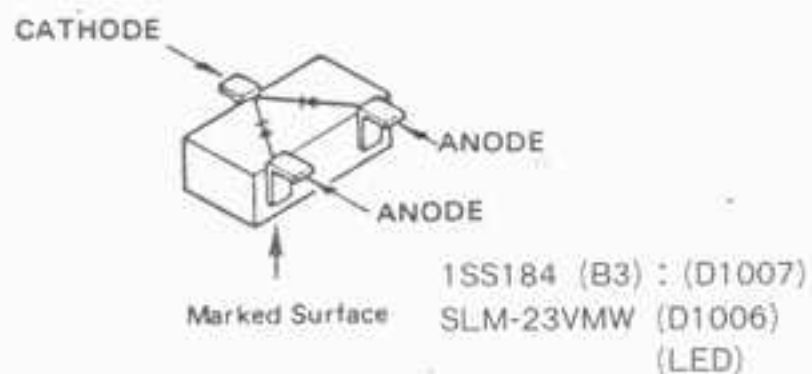
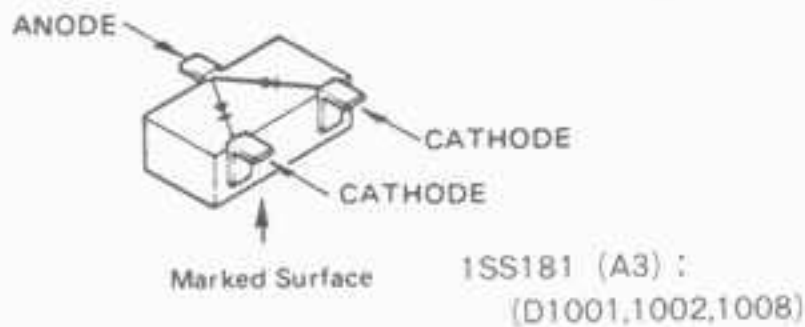
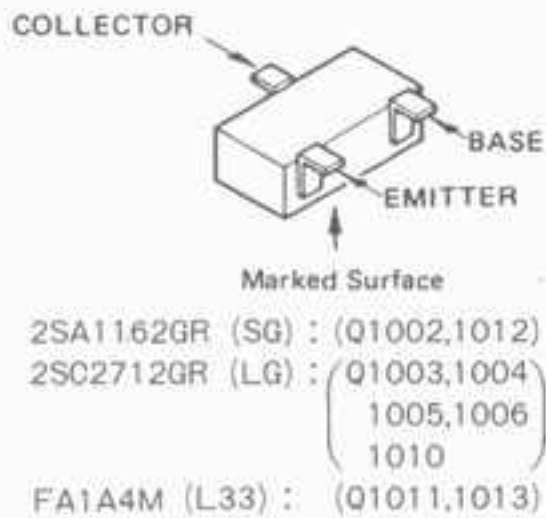
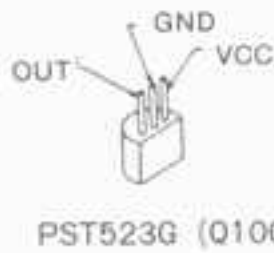
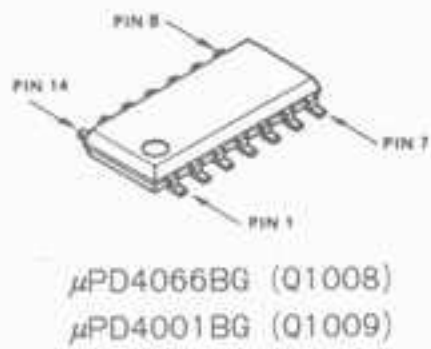
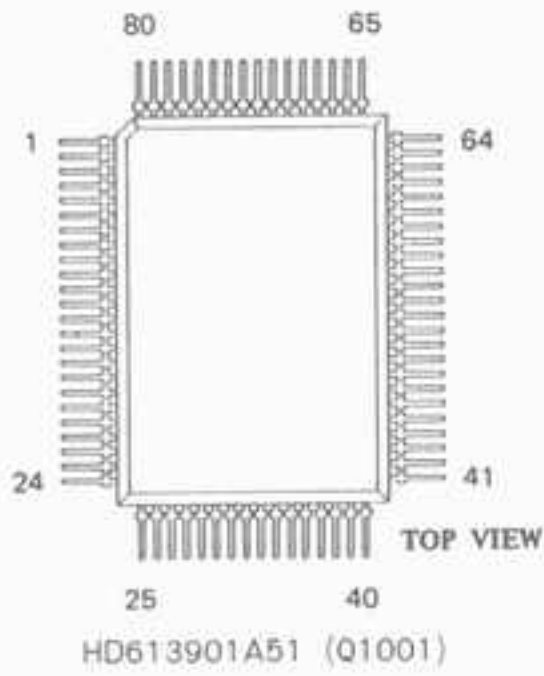
Snipweg 3. 1118AA Schiphol, The Netherlands

Early and late models can be distinguished by the location of the clone switch, as shown below.

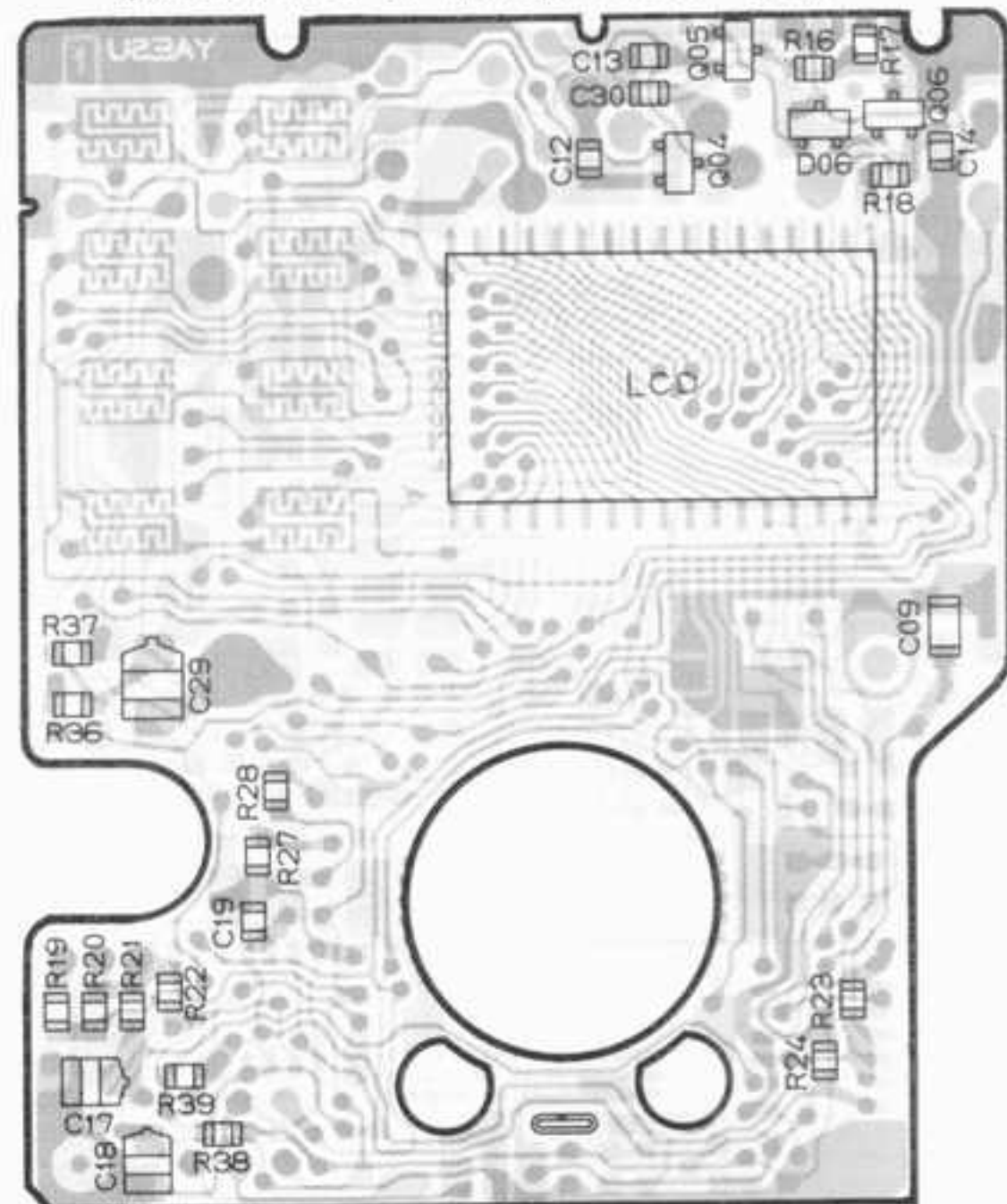
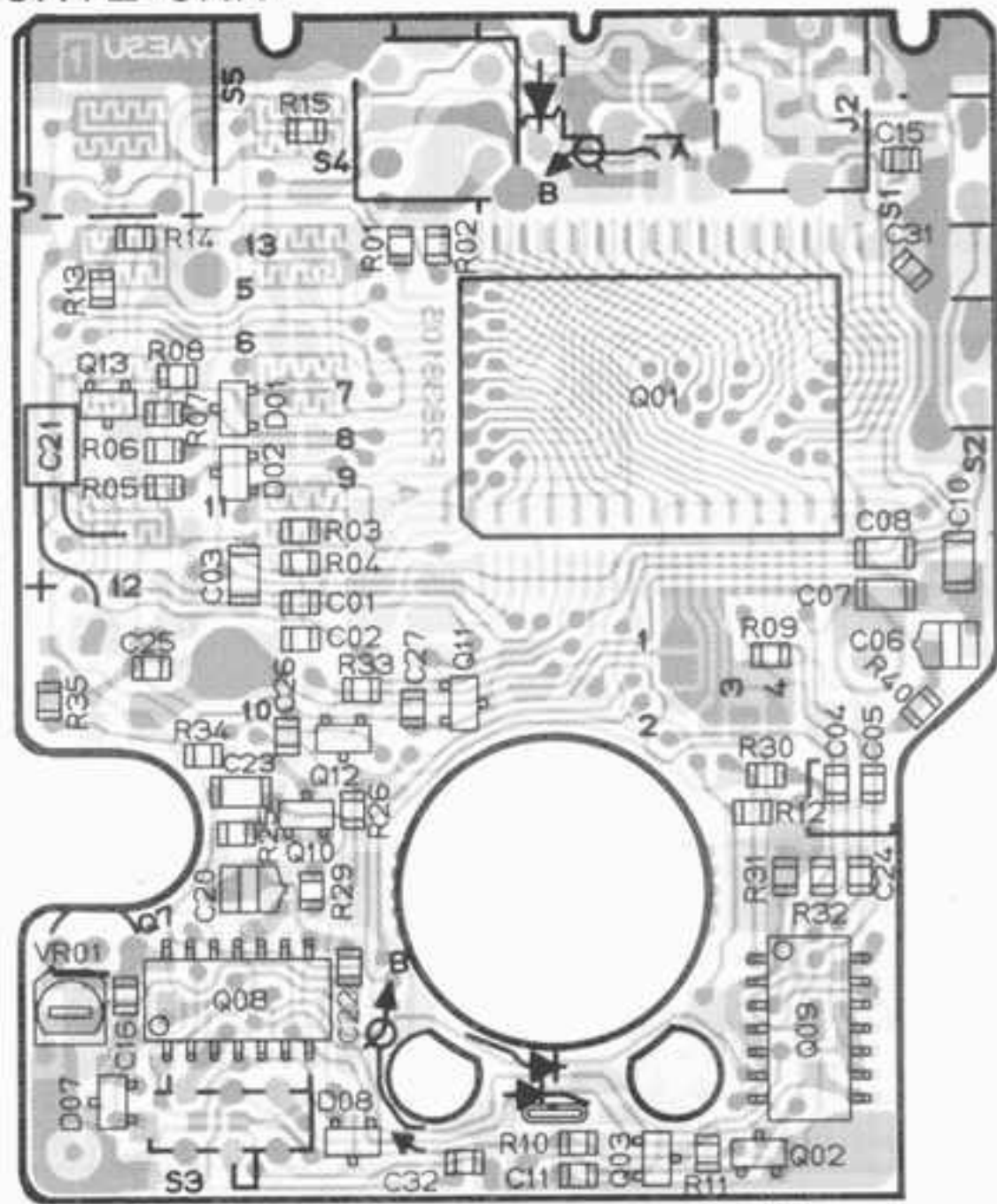


Early Model

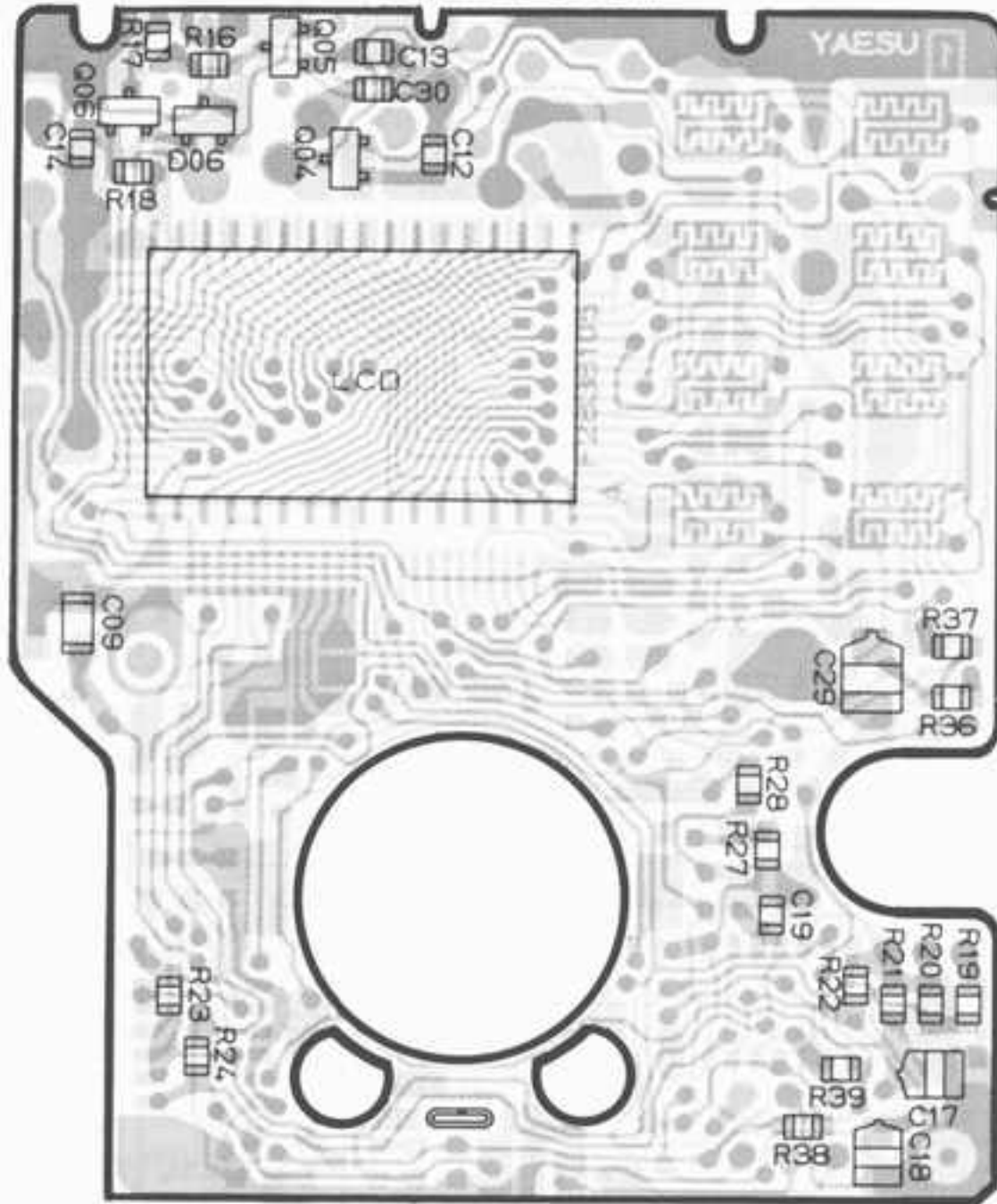
Late Model



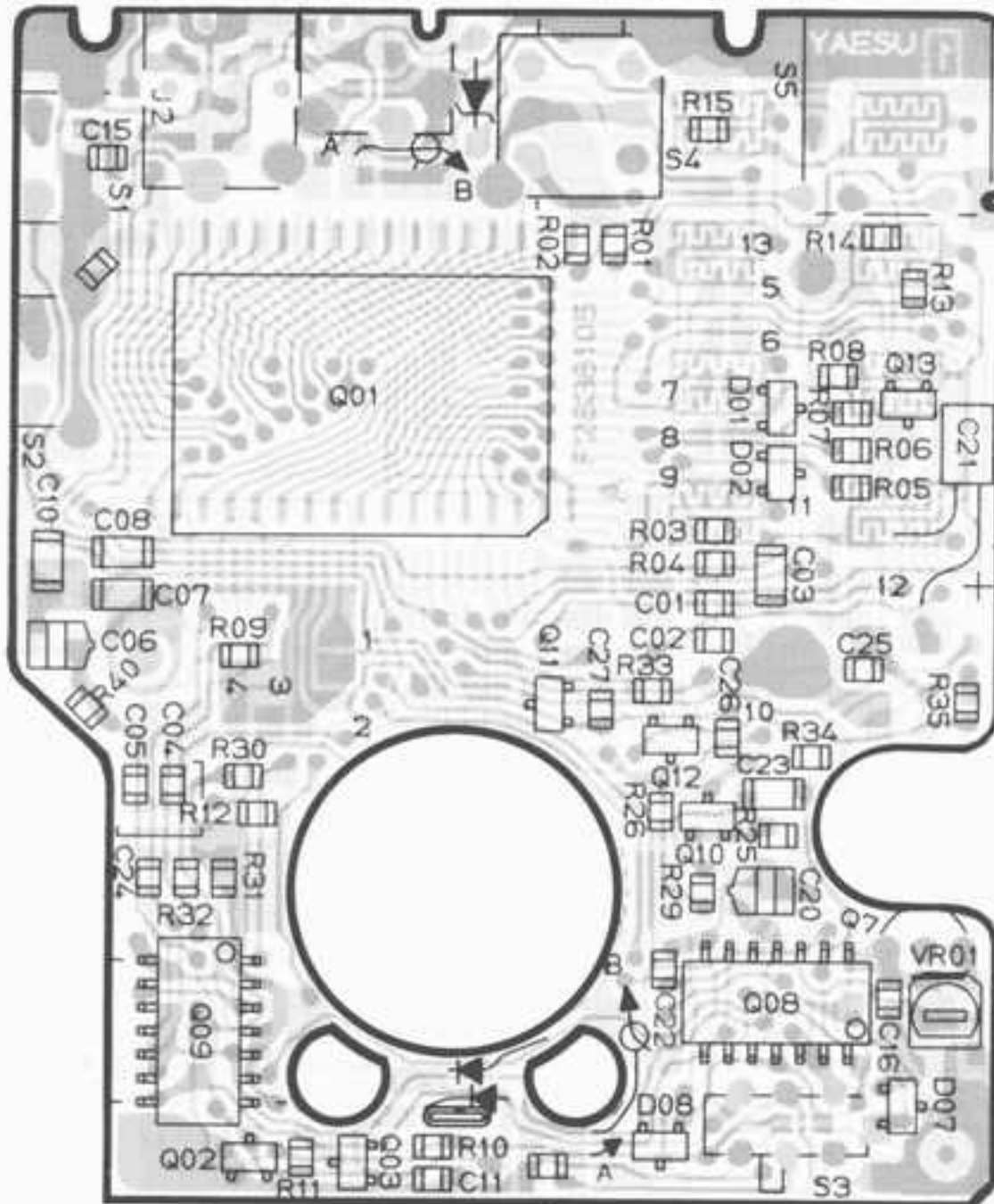
## CNTL UNIT



# CNTL UNIT



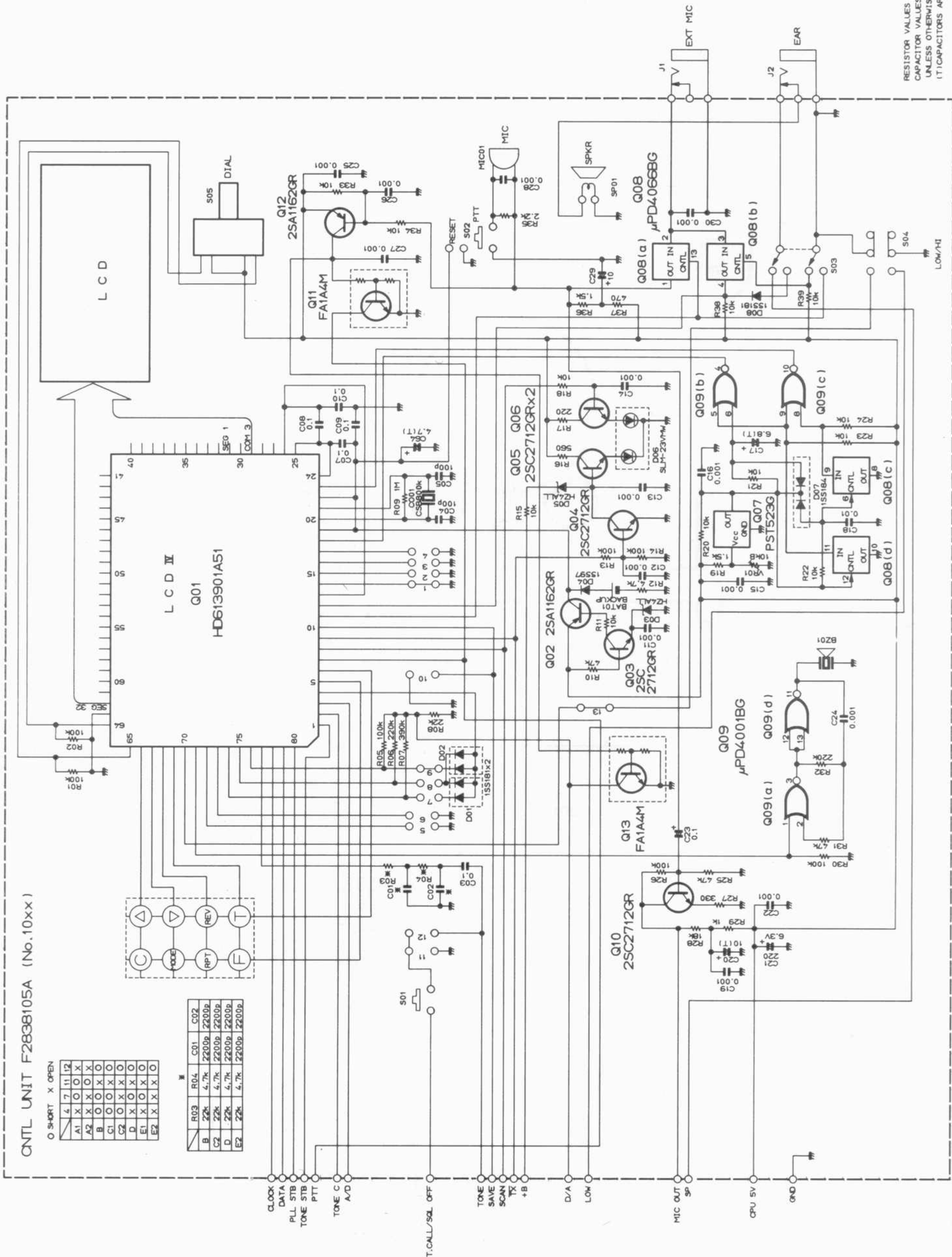
(obverse view of "display" side)



(reverse view of "microprocessor" side)



# CNTL UNIT



RESISTOR VALUES ARE IN  $\Omega$ , 1/10W;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50V;  
 UNLESS OTHERWISE NOTED.  
 (T) CAPACITORS ARE TANTALUM, 16V.

## ALIGNMENT

The FT-23R has been carefully aligned by highly skilled technicians at the factory, and is designed so that no further alignment should ever be required. However, in the unlikely event of a component failure, re-alignment may be necessary. All component replacement and service should be performed only by an authorized Yaesu representative, or the warranty policy may be voided.

The following test equipment is required for alignment:

RF Signal Generator:  
calibrated output level at 150 MHz

Deviation Meter (linear detector)

Oscilloscope

AF Millivoltmeter

SINAD Meter

Inline Wattmeter: 150 MHz

Regulated DC Power Supply:  
adjustable from 4 to 17V, 2A

50-ohm Non-reactive Dummy Load: 10W at 150 MHz

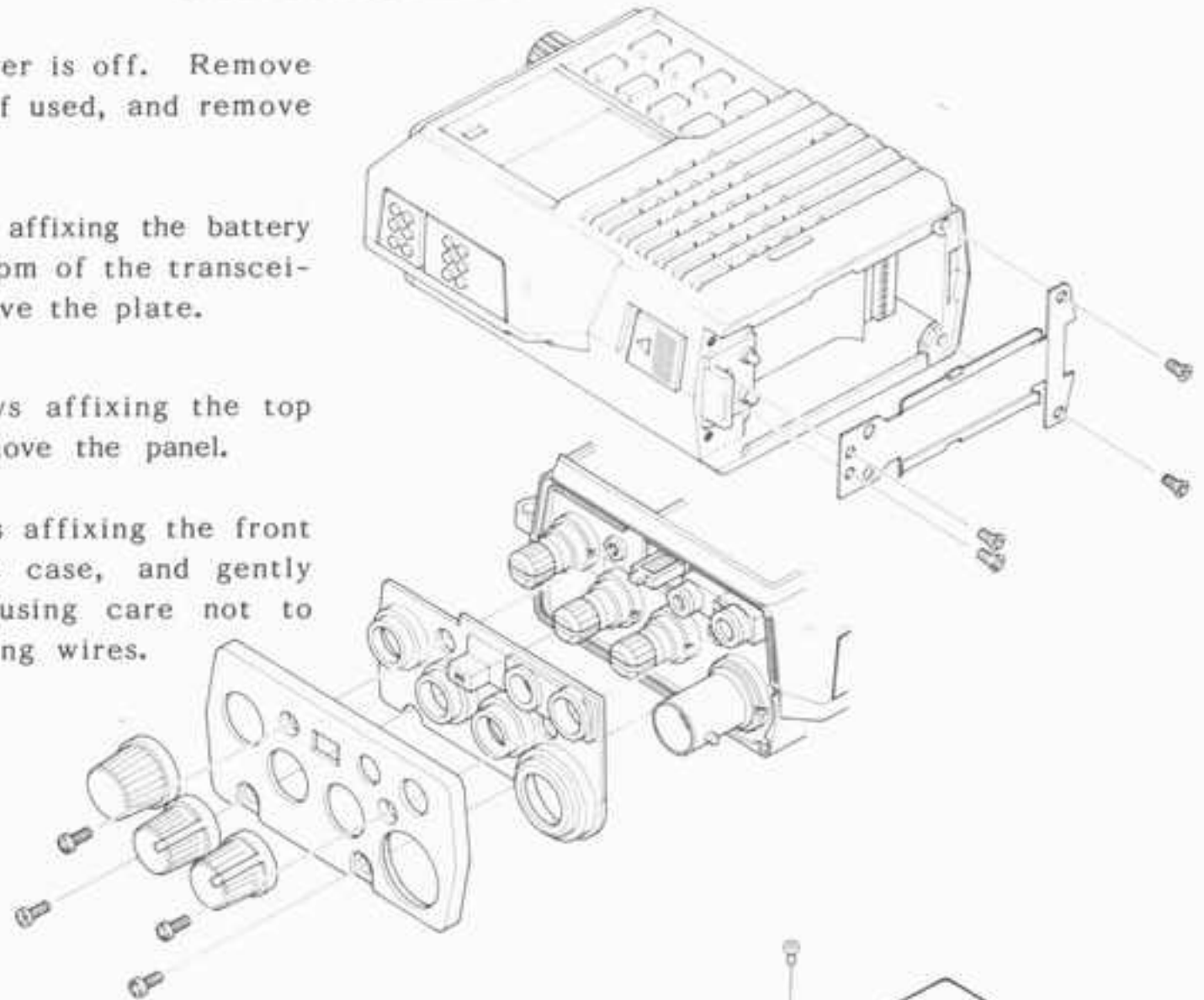
Frequency Counter: 0.2ppm accuracy at 150 MHz

AF Signal Generator

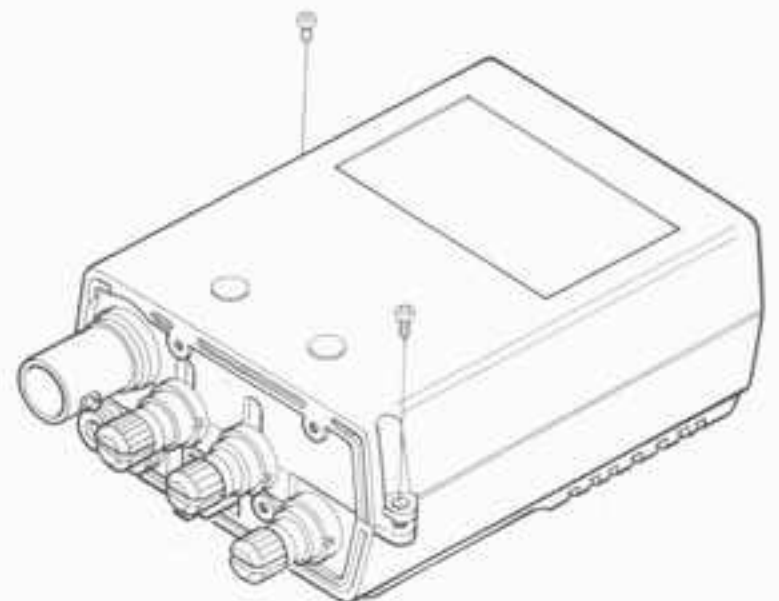
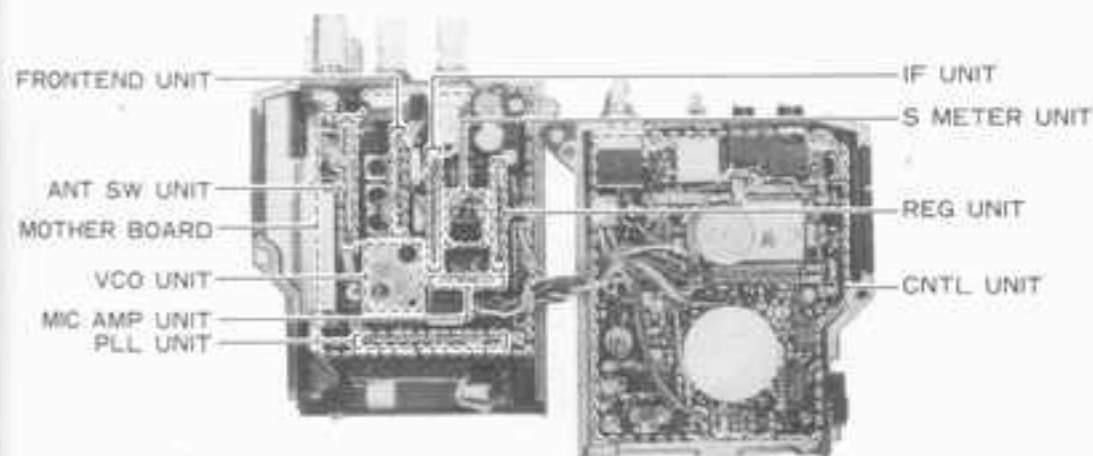
DC Voltmeter: high impedance

## CASE DISASSEMBLY

1. Make sure the transceiver is off. Remove the hard or soft case, if used, and remove the battery pack.
2. Remove the four screws affixing the battery spring plate on the bottom of the transceiver, and carefully remove the plate.
3. Remove the four screws affixing the top panel, and carefully remove the panel.
4. Remove the two screws affixing the front and rear halves of the case, and gently separate the halves, using care not to stress the interconnecting wires.



## BOARD LAYOUT





## I. PLL & TRANSMITTER

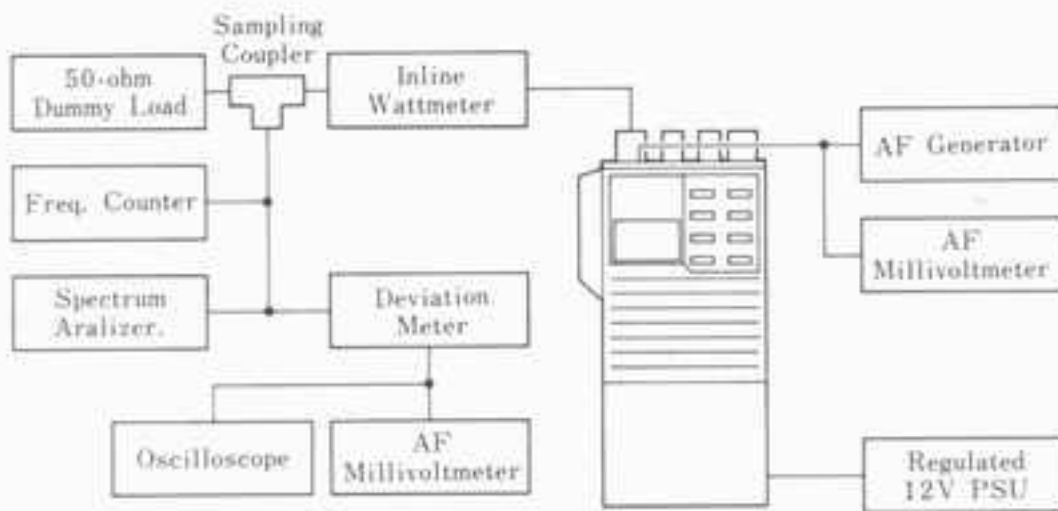
Set up the test equipment as shown in the diagram below for transmitter alignment. Adjust the supply voltage to 12.0V for all steps except Transmitter Output Power alignment (B).

### A. PLL VCV (Varactor Control Voltage)

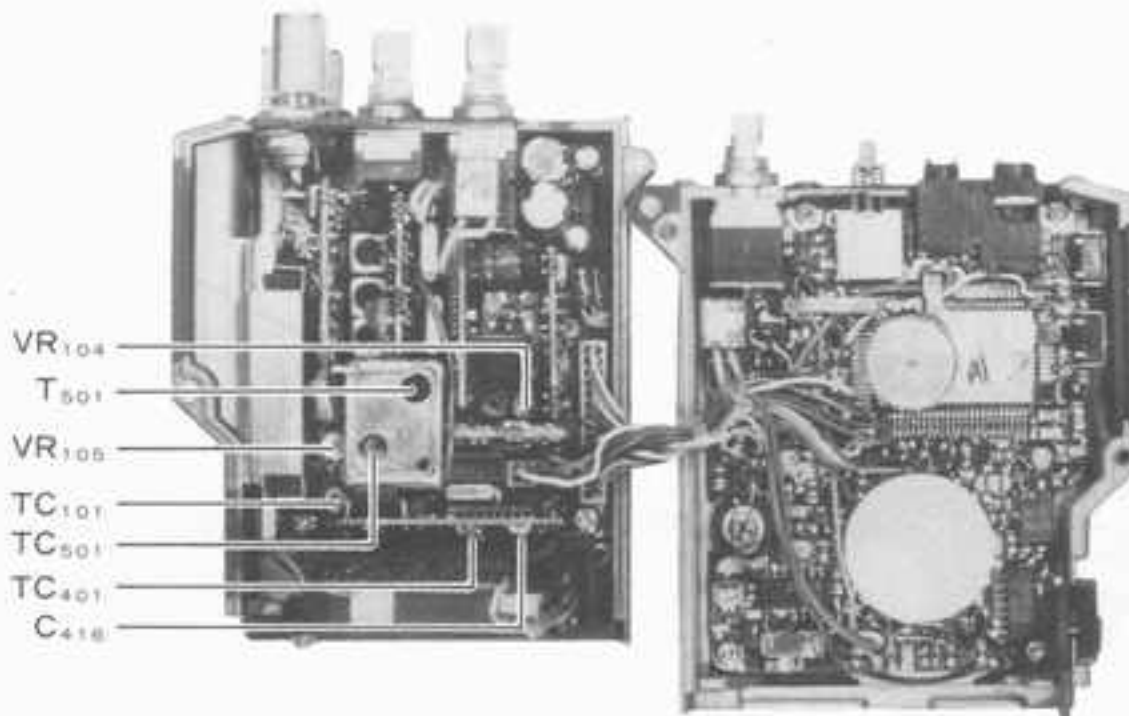
- (1) Connect the DC voltmeter between C416 on the PLL Unit and chassis ground.
- (2) While transmitting on 144.000 MHz adjust transformer T501 on the VCO Unit for  $1.35 \pm 0.05$  VDC.
- (3) While receiving on 144.000 MHz adjust trimmer TC501 on the VCO Unit for  $1.1 \pm 0.05$  VDC.
- (4) Retune the transceiver and confirm the high-end VCV for the transceiver version being aligned, as follows:

Version	Frequency	Tx VCV	Rx VCV
A, C, E	148.000	<1.8V	<1.6V
B, D	146.000	<1.7V	<1.5V

### PLL & TRANSMITTER ALIGNMENT SETUP



### PLL & TRANSMITTER ALIGNMENT POINTS



## B. Transmitter Output Power

- (1) Tune the transceiver to band center (145 or 146 MHz), and set the LOW switch to the undepressed position.
- (2) Increase the supply voltage to 12.5V.
- (3) Adjust TC101 on the Mother Board for peak output power on the wattmeter (at least 5W with less than 1.5A supply current).
- (4) Press the LOW switch on the top panel, and adjust VR105 on the Mother Board for 0.5 watts output.
- (5) Return the supply voltage to 12.0V.

## C. PLL Reference Frequency

With the transceiver tuned to band center (145 or 146 MHz), adjust TC401 on the PLL Unit, if necessary, so that the display frequency matches the frequency counter when transmitting.

## D. Modulation Level

- (1) With the transceiver tuned to band center (145 or 146 MHz), adjust the AF generator for 25mV output at 1 kHz to the MIC jack.
- (2) Adjust VR104 on the Mother Board for  $\pm 4.5$  kHz deviation on the deviation meter.



## II. RECEIVER

Set up the test equipment as shown above for receiver alignment.

### A. Sensitivity

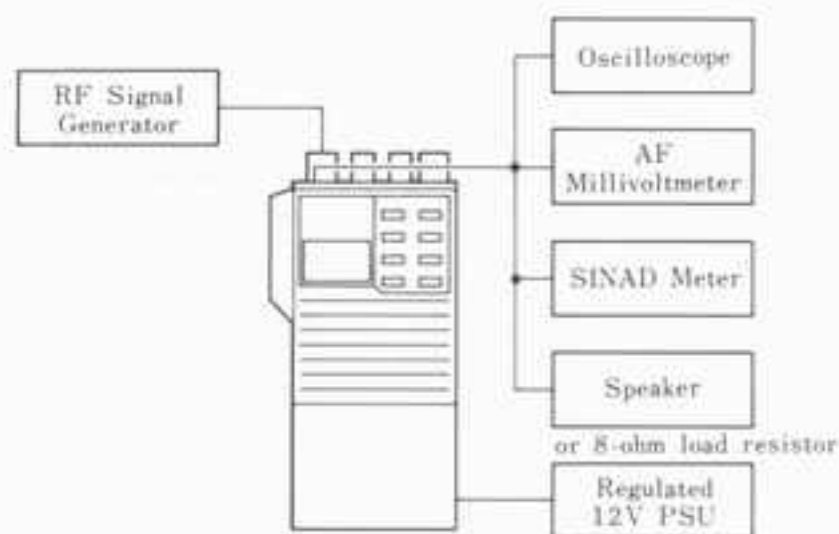
- (1) With the transceiver and RF signal generator both tuned to band center (145 or 146 MHz), set the generator for  $\pm 3.5$  kHz deviation of 1 kHz tone modulation, and set the output level for 40 dBu at the antenna jack.
- (2) Preset VR103 on the Mother Board fully clockwise.
- (3) Adjust T101 through T104 on the Mother Board for maximum S-meter indication, reducing the generator level if more than four bargraph segments turn on.

After step (3), generator level should be 0.2  $\mu$ V or less for 12dB SINAD. Perform the following adjustment next.

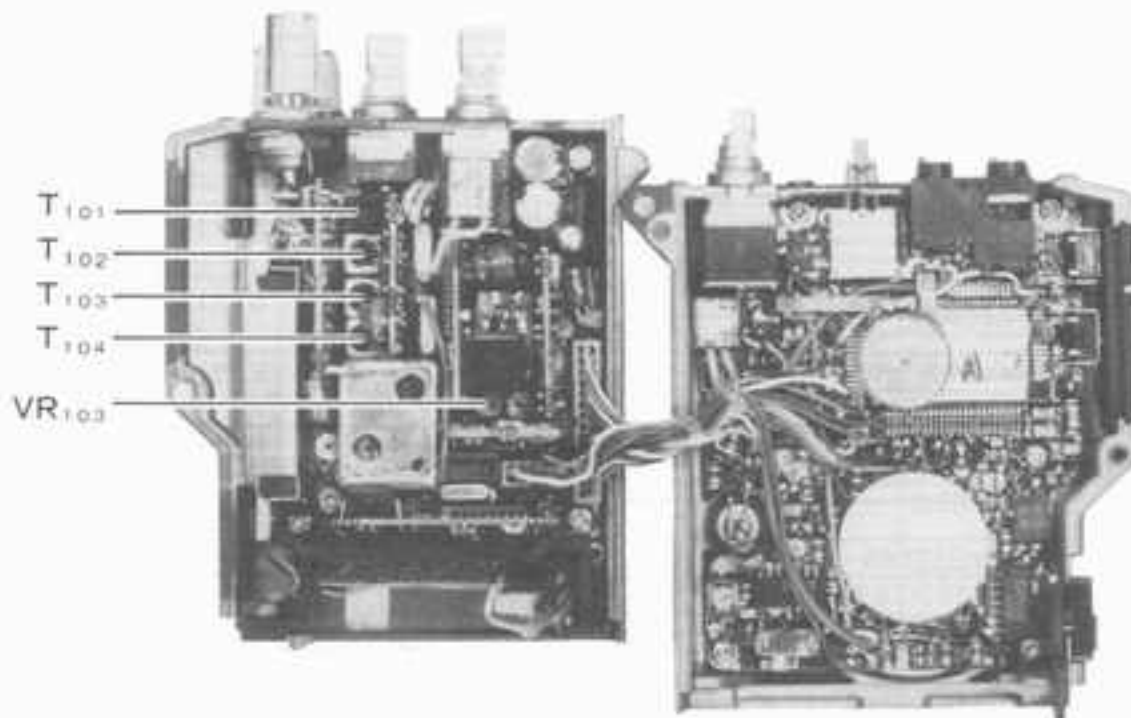
### B. S-meter Sensitivity

- (1) With the transceiver and RF signal generator set up as in step (1) of the above Sensitivity adjustment procedure, set the signal generator for 20 dBu output.
- (2) Adjust VR103 on the Mother Board so that all bargraph segments are just turned on.
- (3) Reduce the generator output so that only two bargraph segments are on, and confirm that the generator output level is now 5 dBu or less.

### RECEIVER ALIGNMENT SETUP



### RECEIVER ALIGNMENT POINTS



# PARTS LIST

MAIN CHASSIS					
Symbol No.	Part No.	Name & Description			
		CONNECTOR			
J01	P1090541	BNC-RM ANT			CERAMIC FILTER
			CF101	H3900280	LF-B12
		MISCELLANEOUS			
	R3116390	DIAL Knob			RESISTORS
	R3116620	VOL,SQL Knobs	R112	J24205479	RMC 1/10T4R7J 1/10W 4.7Ω
	R3508300	PTT Button Cover	R113	J24205100	" " 100J " 10Ω
	R3508310	UNLOCK Lever	R102	J24205220	" " 220J " 22Ω
	R0117370	Coil Spring	R106,109	J24205221	" " 221J " 220Ω
	R0507950B	Battery Spring Plate	R110	J24205331	" " 331J " 330Ω
	R3503650A	Top Panel Gasket	R111	J24205102	" " 102J " 1kΩ
	R3507960	Jack Seal Gasket	R114	J24205103	" " 103J " 10kΩ
			R107,118A,F	J24205223	" " 223J " 22kΩ
			R116	J00215223	Carbon film 1/8W 22kΩ
			R101	J24205333	RMC 1/10T333J 1/10W33kΩ
			R108,115	J24205473	" " 473J " 47kΩ
			R103-105,117	J24205104	" " 104J " 100kΩ
MOTHER BOARD					
Symbol No.	Part No.	Name & Description			
	F2838104A	Printed Circuit Board			
	C028384AA	PCB with Components			POTENTIOMETERS
			VR101	J60800128	K091K0004-20KB 20kΩ B
			VR102	J60800129	K0911100D-20KA 20kΩ A
			VR103-105	J51776473	RH0411CS4J 47kΩ B
					CAPACITORS
			C104-106	K22170203	Chip Ceramic 50WV 2pF CH (C2012CH1H020CFA)
			C107	K22170204	" " " 3pF " (C2012CH1H030CFA)
			C101,108	K22170206	" " " 5pF " (C2012CH1H050CFA)
			C130,133	K22170209	" " " 8pF " (C2012CH1H080DFA)
			C143	K22170211	" " " 10pF " (C2012CH1H100DFA)
Q101	G1090558	IC LA4145	C103	K22170221	" " " 27pF " (C2012CH1H270JFA)
			C111,122,125-127 131,135-141	K22170805	" " " 0.001μF B (C2012B1H102MFA)
		PWR-MODULE	C102,132,134	K22170817	" " " 0.01μF " (C2012B1H103MFA)
Q107	G1090732	M57796MA	C128,142	K22171008	" " " 0.047μF F (C2012F1H473ZFA)
			C109,110,112,115 119,120,129	K22141904	" " " 25WV 0.1μF D (C3216D1E104MFA)
		TRANSISTORS	C121	K78130001	Tantalum 20WV 0.47μF (F951D474MRAAF1Q2)
Q102	G3111627G	2SA1162GRTE85R			
Q103	G3327127G	2SC2712GRTE85R			
Q104	G3070001	FA1A4M	C113,118,123	K40129052	Electrolytic 16WV 10μF (RC3-16V100M)
Q105	G3333567	2SC3356-T2B			
Q106	G3329547	2SC2954-T2B	C114,124	K40129038	" " 16WV 100μF (RC2-16V101M)
			C116,117	K40089020	" " 6.3WV 100μF (RC3-6V101M)
		DIODE			
DI01	G2070009	1SS184TE85R SI			
					TRIMMER CAPACITOR
			TC101	K91000149	VCT31E161A 20pF
		CRYSTAL FILTER			
XF101	H1102114	10M15BM 10.7MHz			





C311	K78080004	Chip Tantalum 6.3W 15 $\mu$ F (F950J156MVCAF1Q2)	TC401	K91000154	TRIMMER CAPACITOR ECR-KN020E11X 20pF
		INDUCTOR			INDUCTORS
L301	L1190344	LAL02KR100K 10 $\mu$ H	L401	L1190311	LAL02NA221K 220 $\mu$ H
<b>PLL UNIT</b>					
Symbol No.	Part No.	Name & Description	<b>VCO UNIT</b>		
	F2838108A	Printed Circuit Board	Symbol No.	Part No.	Name & Description
	C028388AA	PCB with Components Model A1,A2,D,E2 5kHz steps		F2838106	Printed Circuit Board VCO-LC
	C028388AB	" " " Model F 10kHz steps		F2838110	" " "
	C028388AC	" " " Model B,C2 12.5kHz steps		C028386AF	VCO-OSC PCB with Components
		ICs	Q501	G3802387S	FET 2SK238-K17
Q401	G1090725	MC12017P			
Q402	G1090582	JLC1007P			
					TRANSISTOR
			Q502	G3327597C	2SC2759-T2B U23
		DIODE			
D401	G2090118	1SS97 Schottky			
					DIODES
			D501	G2090297	1SS110 Si
		CRYSTAL	D502,503	G2090271	1T33 Varactor
X401**	H0102771	UM-1 10.240MHz			
X401■	H0102772	UM-1 12.800MHz			
					RESISTORS
			R504	J24205470	RMC 1/10T 470J 1/10W 47 $\Omega$
		RESISTORS	R505	J24205101	" " 101J " 100 $\Omega$
R408	J24205000	RMC 1/10T 000J 1/10W 0 $\Omega$	R501	J24205682	" " 682J " 6.8k $\Omega$
R402,403	J24205220	" " 220J " 22 $\Omega$	R506	J24205683	" " 683J " 68k $\Omega$
R404,405,407	J24205222	" " 222J " 2.2k $\Omega$	R503	J24205224	" " 224J " 220k $\Omega$
R406■	J24205472	" " 472J " 4.7k $\Omega$	R502	J24205225	" " 225J " 2.2M $\Omega$
R401,406*	J24205103	" " 103J " 10k $\Omega$			
R406*	J24205153	" " 153J " 15k $\Omega$			
					CAPACITORS
			C508	K22170201	Chip Ceramic 50WV 0.5pF CH (C2012CH1HOR5CFA)
C401	K22170206	Chip Ceramic 50WV 5pF CH (C2012CH1H050CFA)	C503	K22170211	" " " 10pF " (C2012CH1H100DFA)
C411,412	K22170227	" " " 47pF " (C2012CH1H470JFA)	C506,507	K22170311	" " " " UJ (C2012UJ1H100DFA)
C408-410,419	K22170235	" " " 100pF " (C2012CH1H101JFA)	C501	K22170215	" " " 15pF CH (C2012CH1H150JFA)
C402,403,405,407 413-415	K22170805	" " " 0.001 $\mu$ F B (C2012B1H102MFA)	C502,505,510	K22170805	" " " 0.001 $\mu$ F B (C2012B1H102MFA)
C416,417	K22141904	" " 25WV 0.1 $\mu$ F D (C3216D1E104MFA)	C509	K78080002	Chip Tantalum 6.3WV 4.7 $\mu$ F (F950J475MSAAF1Q2)
C404,406,420	K78080002	Chip Tantalum 6.3WV 4.7 $\mu$ F (F950J475MSAAF1Q2)	C504	K78080003	" " " 10 $\mu$ F (F950J106MTAAF1Q2)
C418	K78100003	" " 10WV 6.8 $\mu$ F (F951A685MTAAF1Q2)			

- \* Model A1,A2,D,E2
- Model B,C2



# Early Model FT-23R

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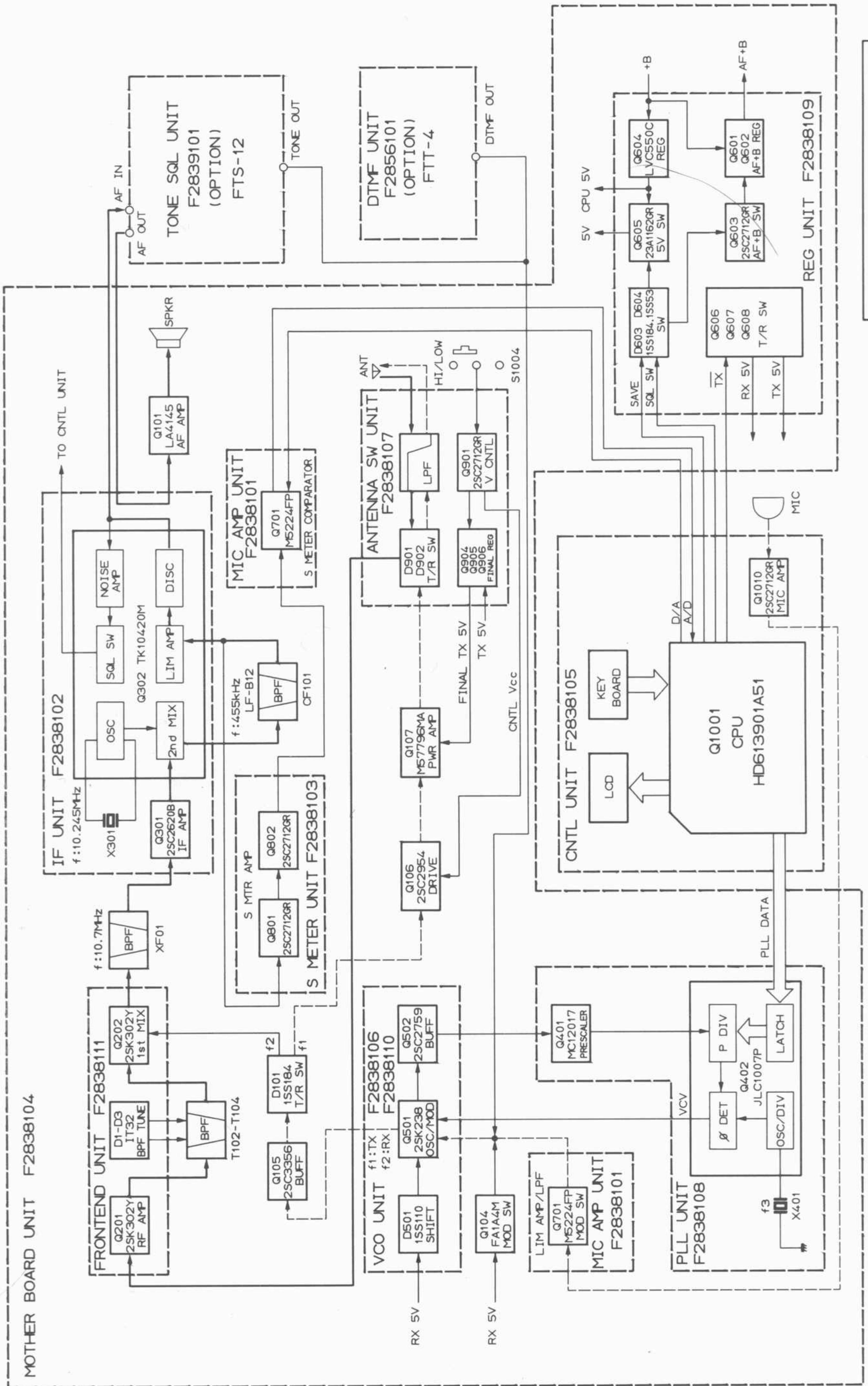
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MOTHER BOARD UNIT F2838104

# FT-23R BLOCK DIAGRAM

RECEIVE  
TRANSMIT  
COMMON/CNTL

A1.A2.D.E1.E2	B.C1.C2
f3	10.240MHz 12.8MHz

A1.C1.G1	A2.C2.E2	B.D
f1	144-148MHz	140-160MHz 144-148MHz
f2	133.3-137.3MHz	129.3-149.3MHz 133.3-135.3MHz

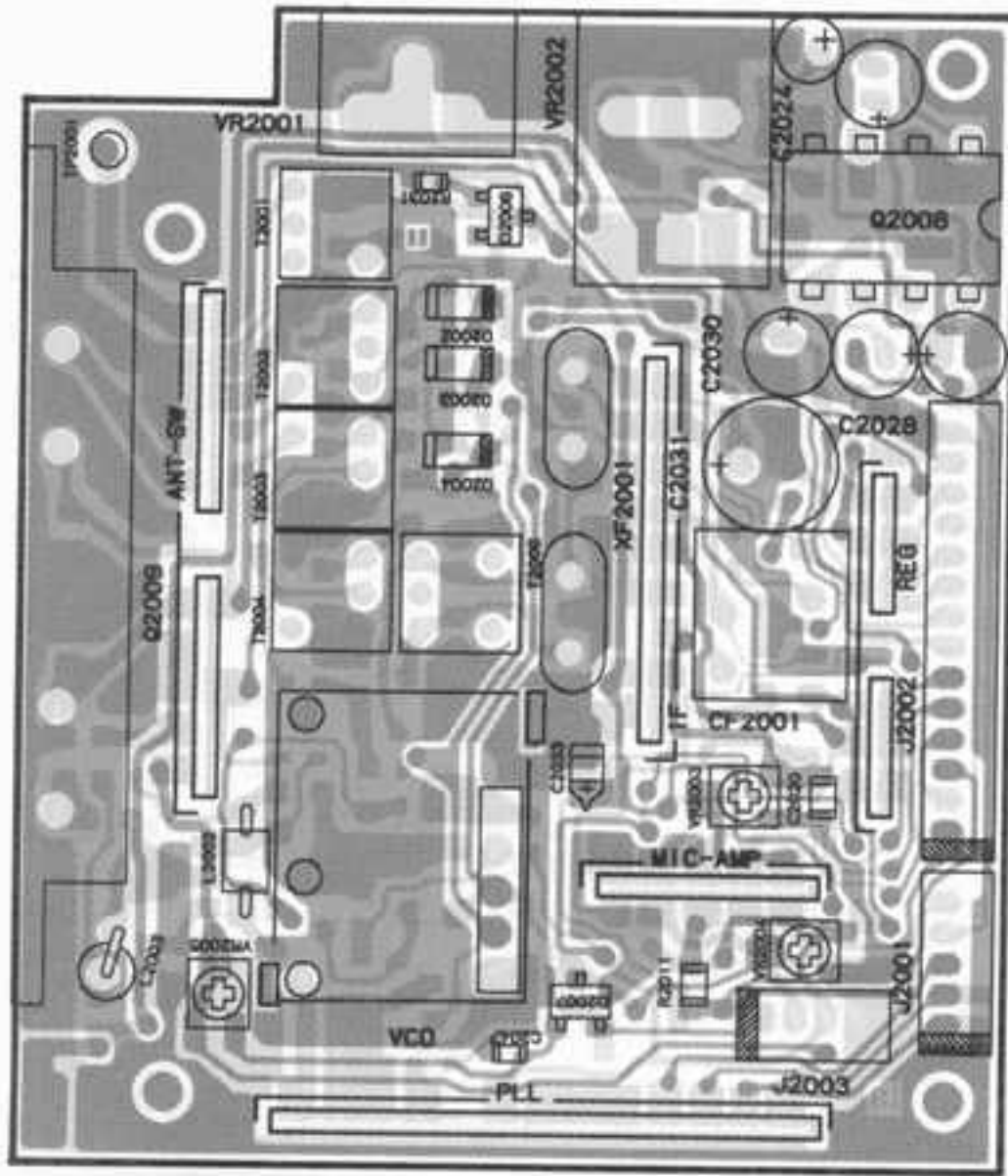


# Late Model FT-23R

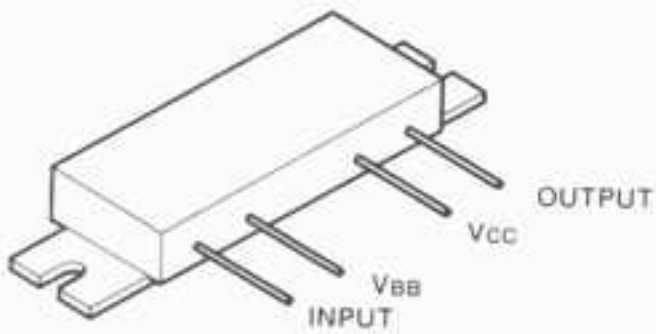
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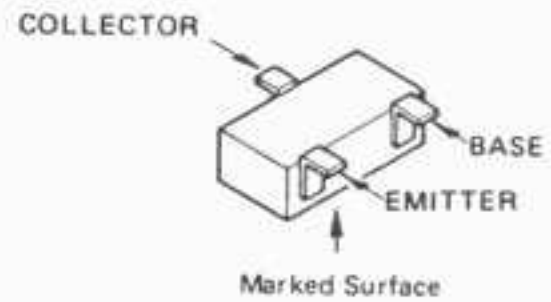
# MOTHER BOARD



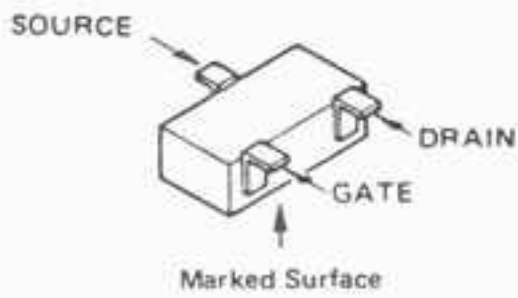
(obverse view of "mixed-component" side)



M57796MA (Q2009)



- 2SC3120 (HB) : (Q2002)
- 2SC3356 (R22) : (Q2003)
- FA1A4M (L33) : (Q2005)
- 2SC2712GR (LG) : (Q2007)
- 2SA1162GR (SG) : (Q2010)

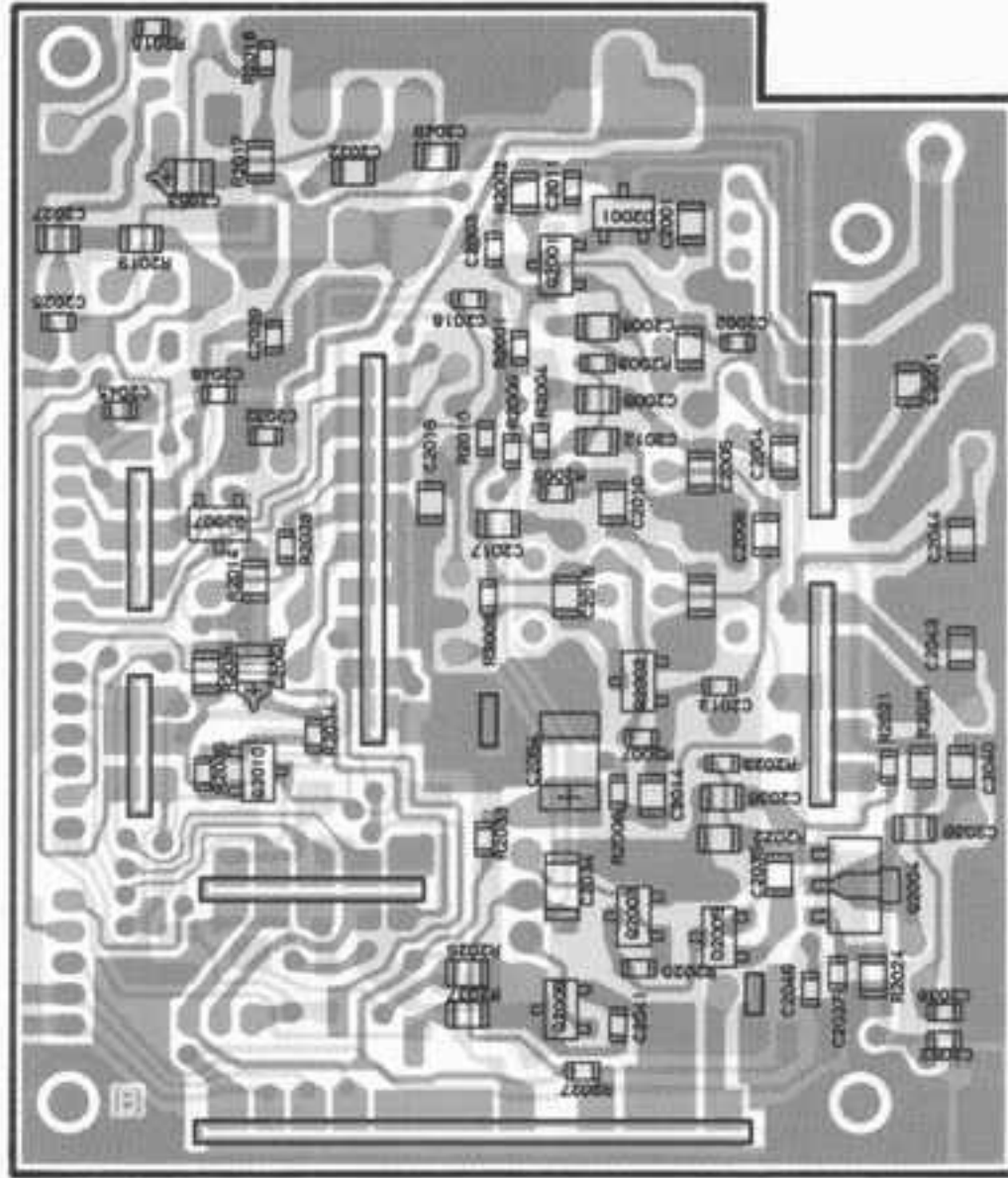


2SK302Y (TY) : (Q2001)

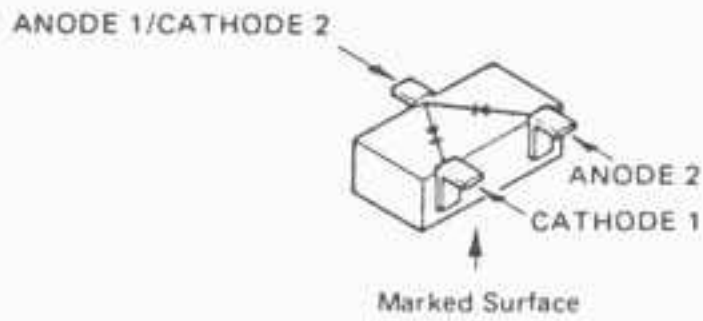


2SC2954 (OK) : (2004)

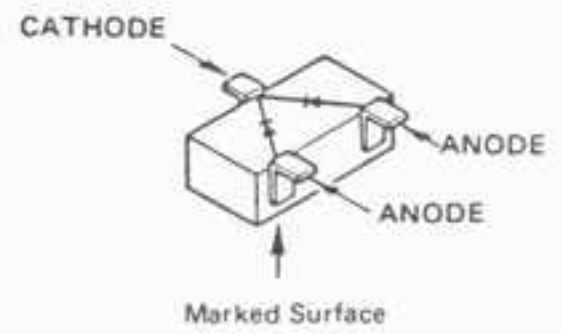
# MOTHER BOARD



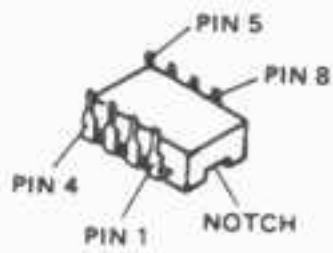
(obverse view of "chip-only" side)



1SS226 (C3) : (D2001,D2007)



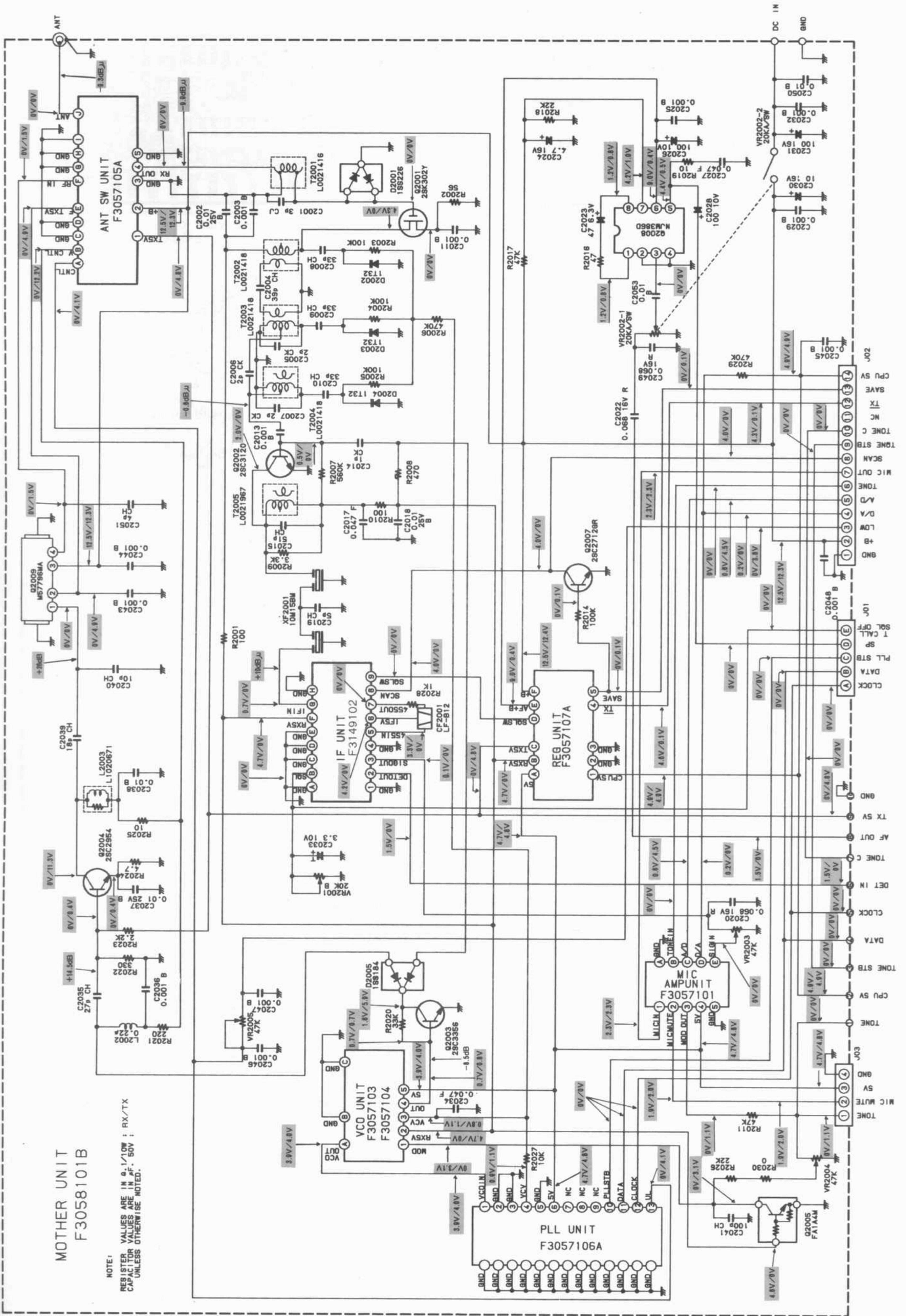
1SS184 (B3) : (D2005)



NJM386D (Q2008)



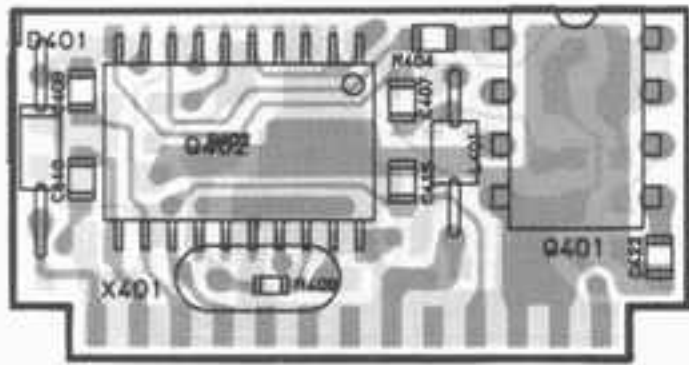
# MOTHER BOARD



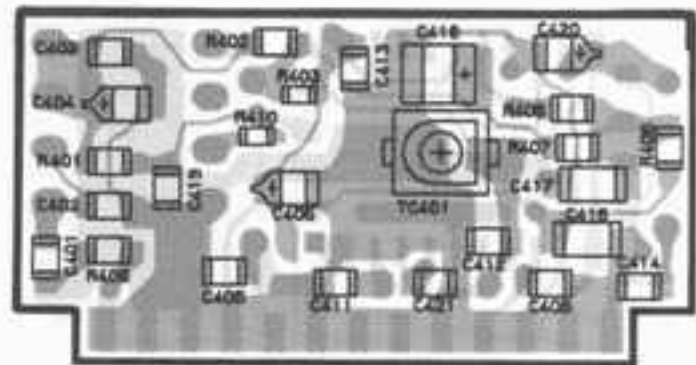




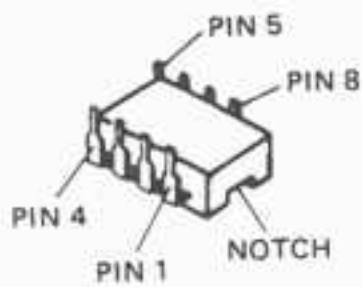
# PLL UNIT



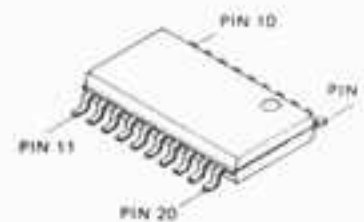
(obverse view of "mixed-component" side)



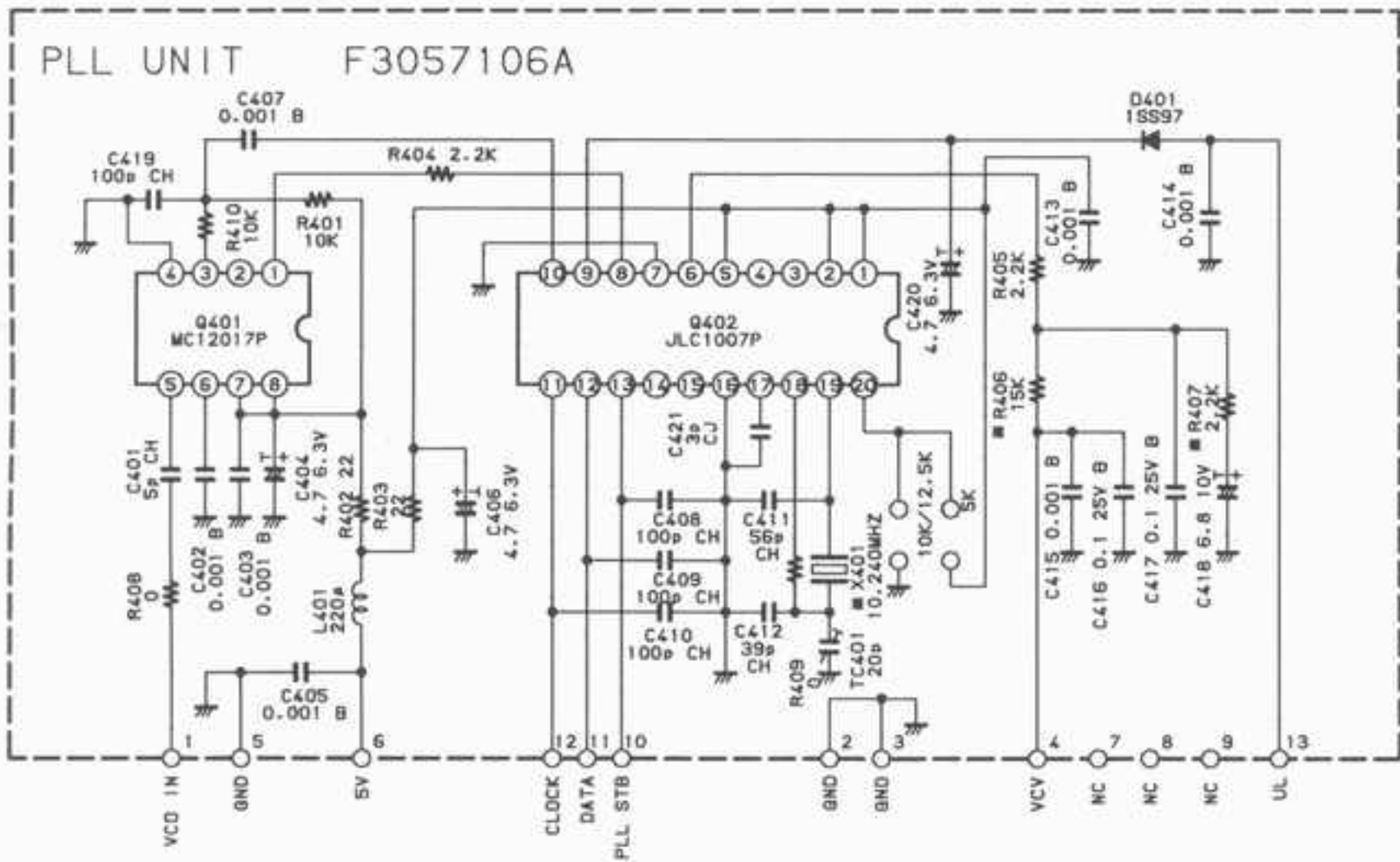
(obverse view of "chip-only" side)



MC12017P (Q401)



JLC1007P (Q402)

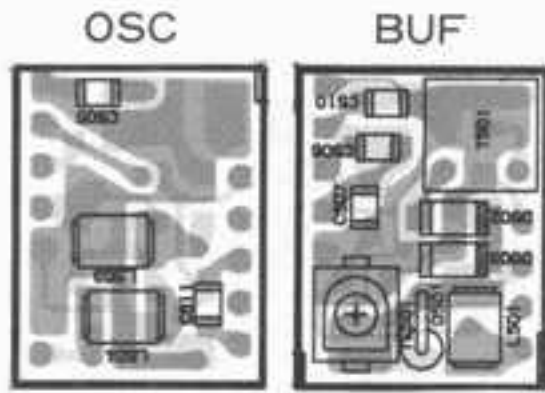


	XF401	R406	R407
A1, A2, D, E2, A3 TYPE	10.240MHZ	15K $\Omega$	1.5K $\Omega$
B, C2 TYPE	12.800MHZ	4.7K $\Omega$	1K $\Omega$

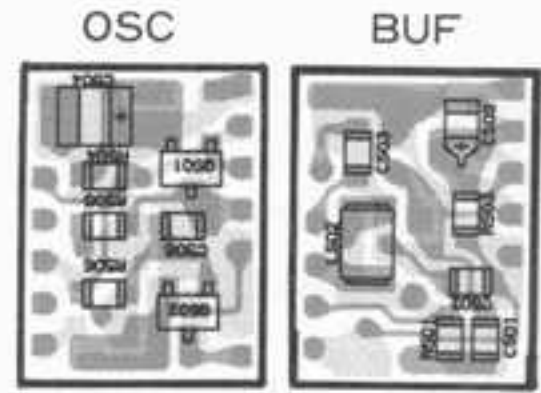
NOTE:  
 RESISTOR VALUES ARE IN  $\Omega$ , 1/10W ;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50V ;  
 (T) CAPACITOR VALUES ARE TANTALUM ;  
 INDUCTOR VALUES ARE IN H  
 UNLESS OTHERWISE NOTED.



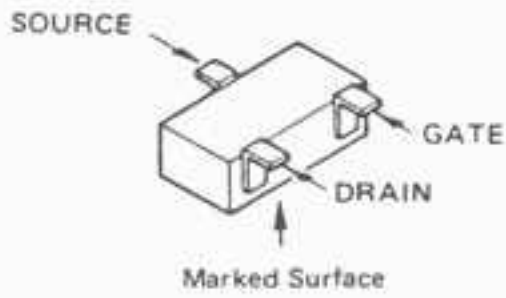
# VCO UNIT



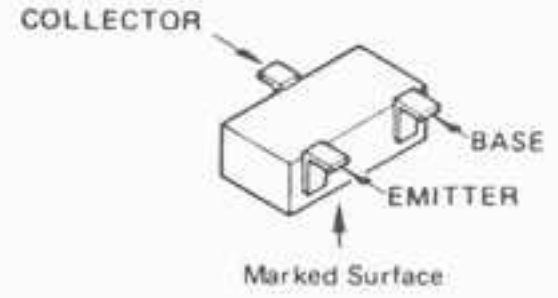
(obverse view of "top" side)



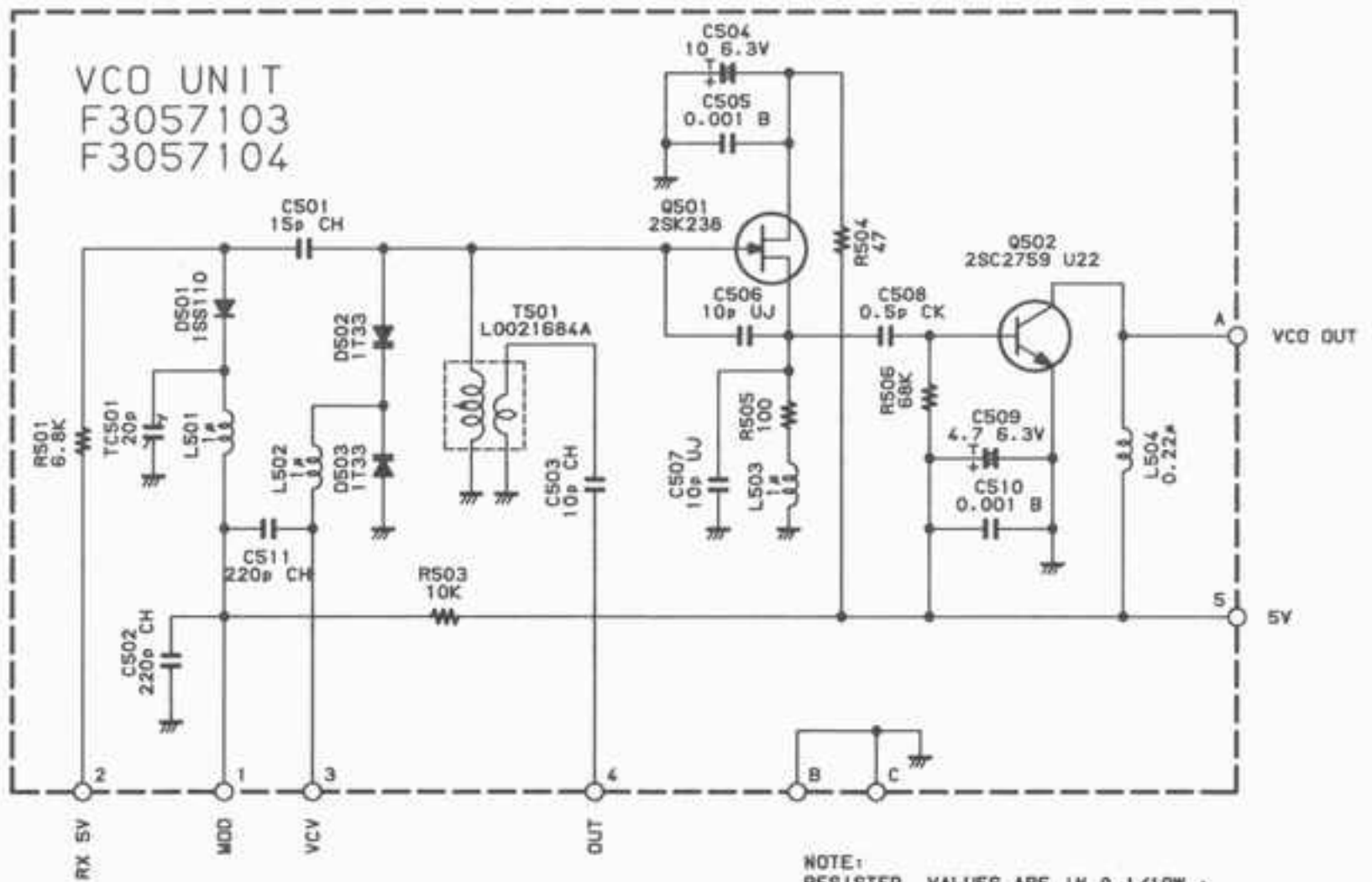
(obverse view of "bottom" side)



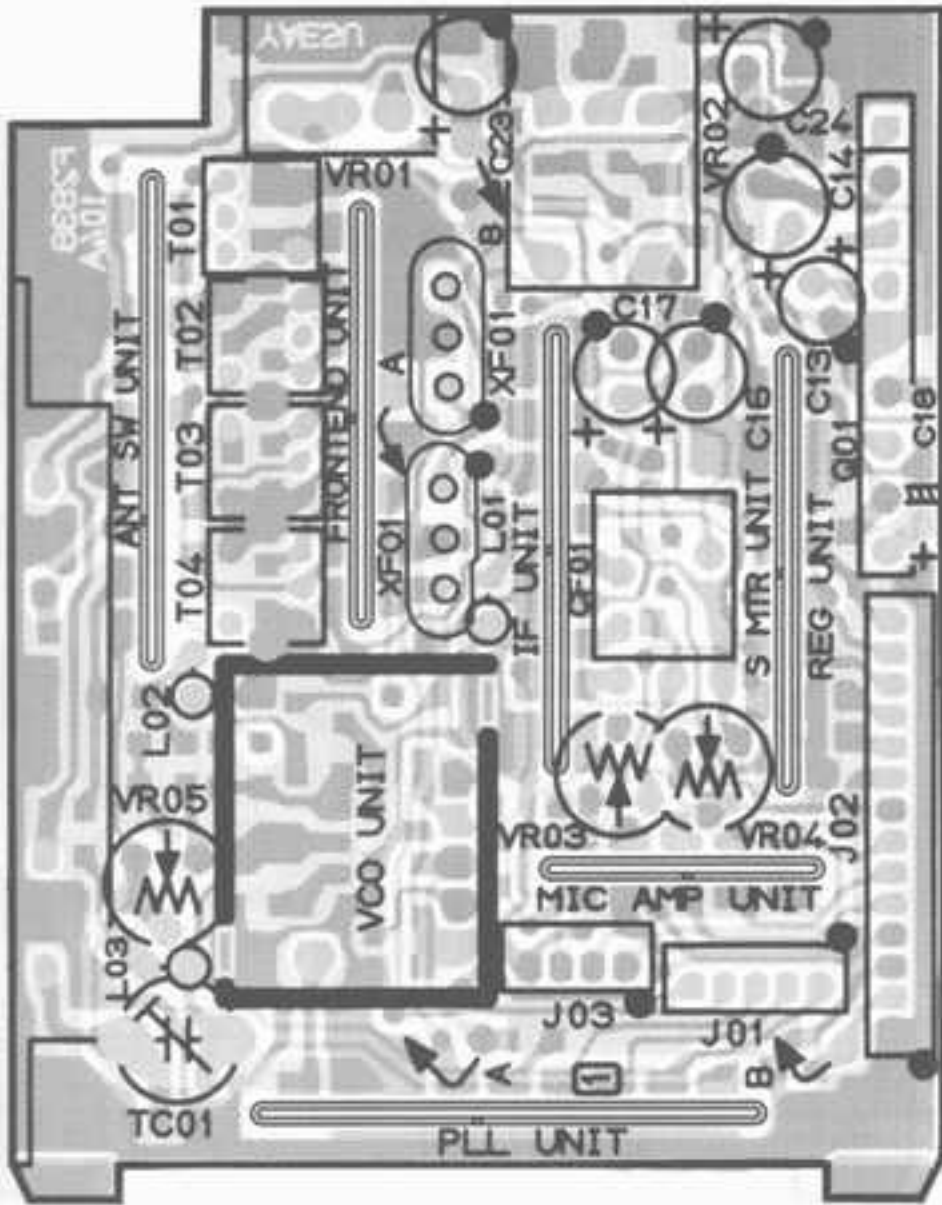
2SK238 (K17) : (Q501)



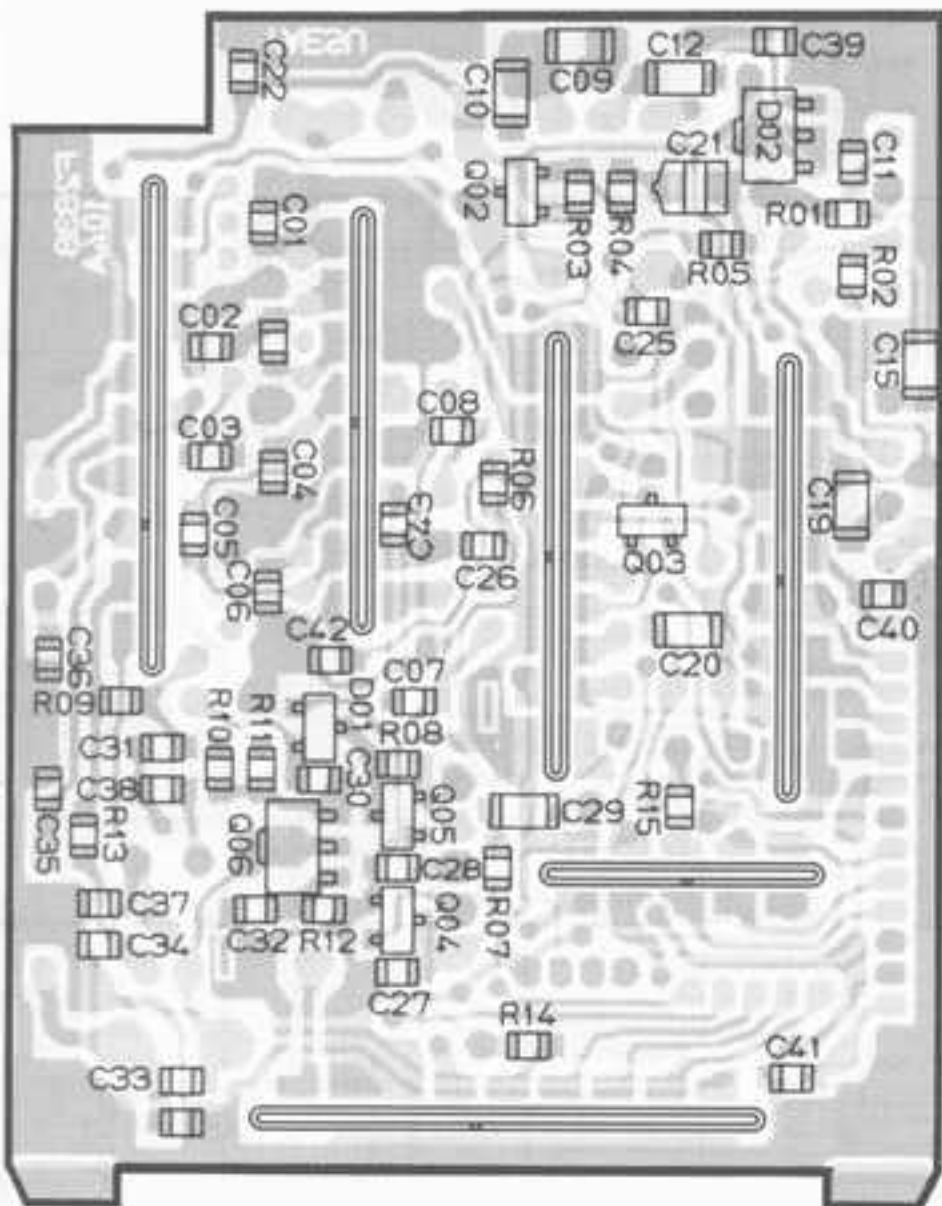
2SC2759 (U22) : (Q502)



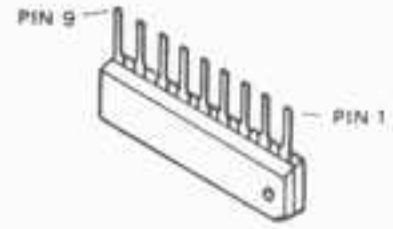
# MOTHER BOARD



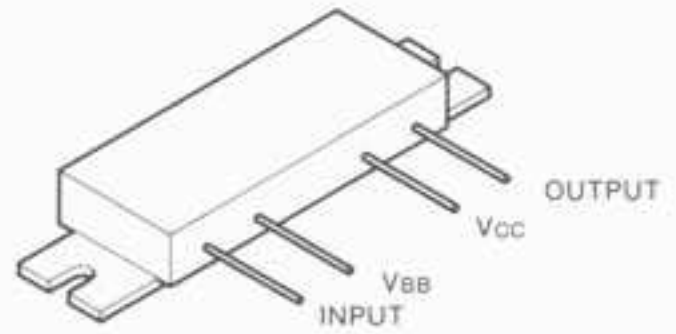
(obverse view of "component" side)



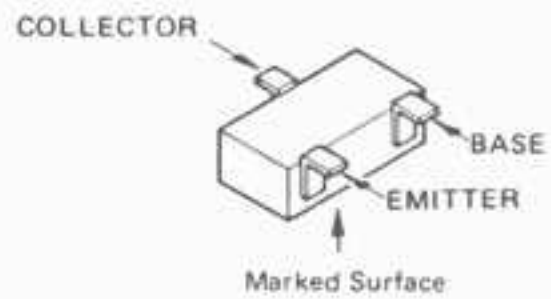
(reverse view of "chip-only" side)



LA4145 (Q101)



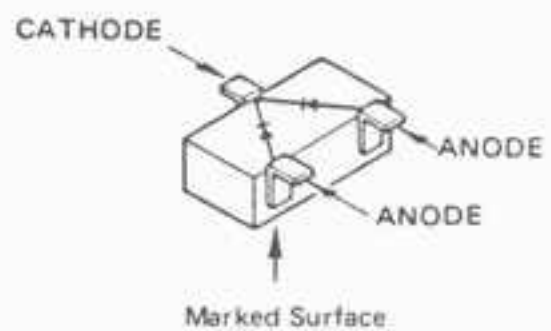
M57796MA (Q107)



- 2SA1162GR (SG) : (Q102)
- 2SC2712GR (LG) : (Q103)
- 2SC3356 (R22) : (Q105)
- FA1A4M (L33) : (Q104)

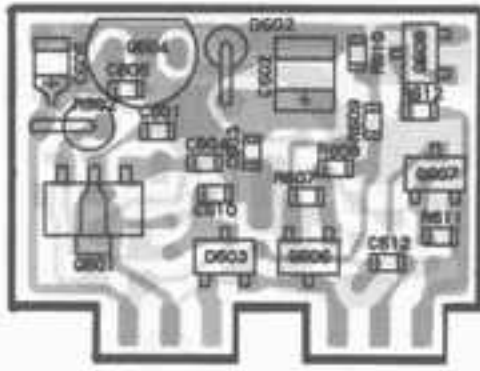


2SC2954 (Q106)

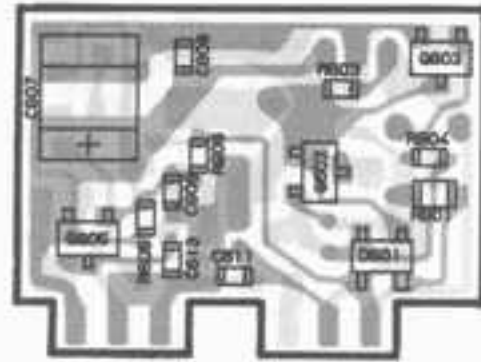


1SS184 (B3) : (D101)

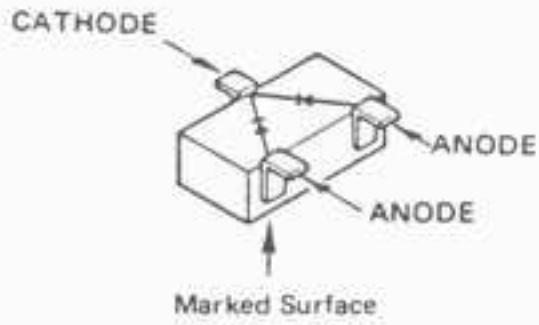
# REG UNIT



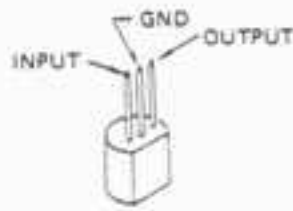
(obverse view of "top" side)



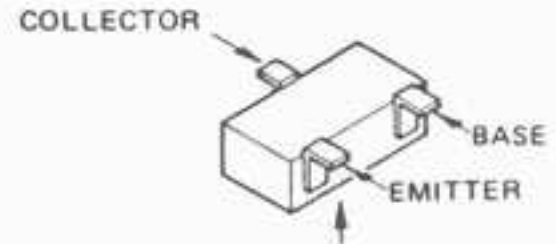
(obverse view of "bottom" side)



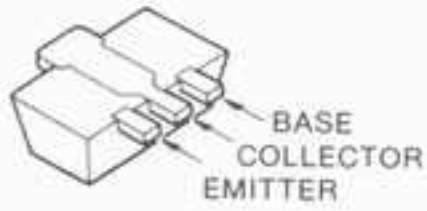
1SS184 (B3) : (D603)



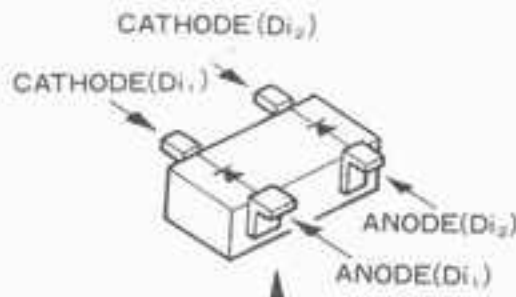
LM2931AZ-5.0 (Q604)



2SA1162GR (SG) (Q605,606,607)



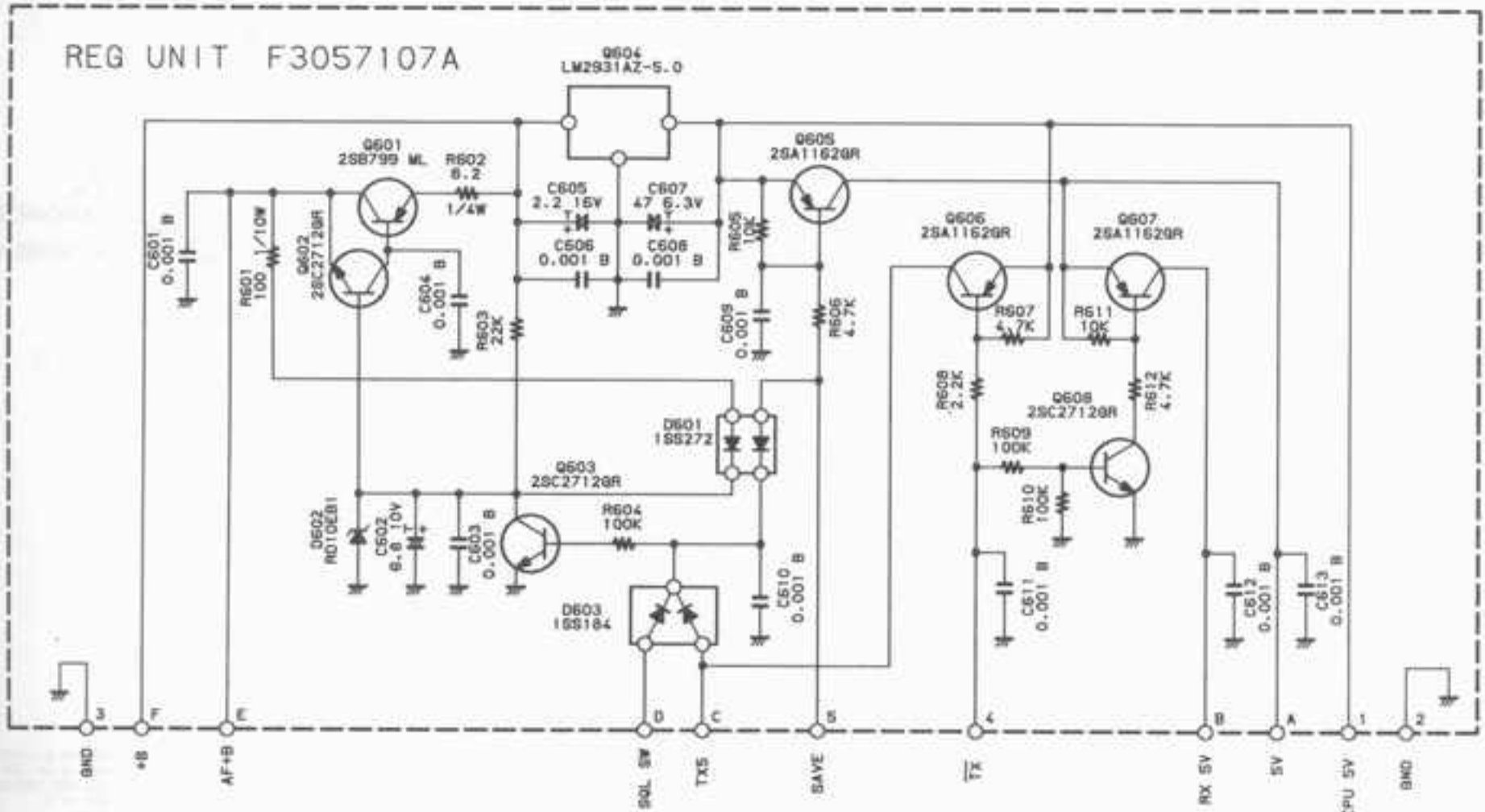
2SB799 (Q601)



1SS272 (A1) : (D601)

2SC2712GR (LG) (Q602,603,608)

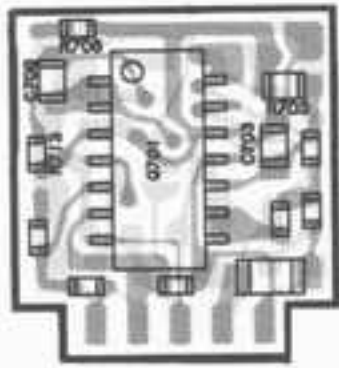
## REG UNIT F3057107A



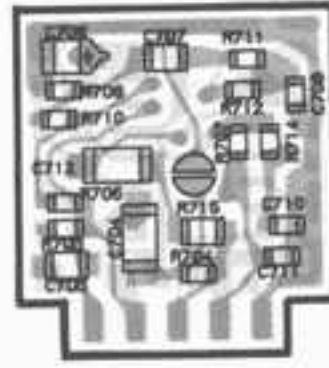
NOTE:  
RESISTOR VALUES ARE IN  $\Omega$ , 1/10W ;  
CAPACITOR VALUES ARE IN  $\mu$ F, 50V ;  
(T) CAPACITOR VALUES ARE TANTALUM ;  
INDUCTOR VALUES ARE IN H  
UNLESS OTHERWISE NOTED.



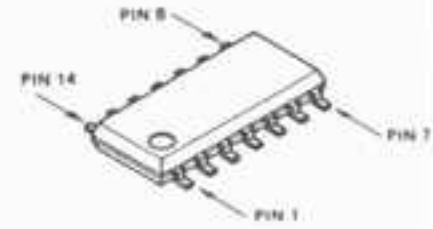
# MIC AMP UNIT



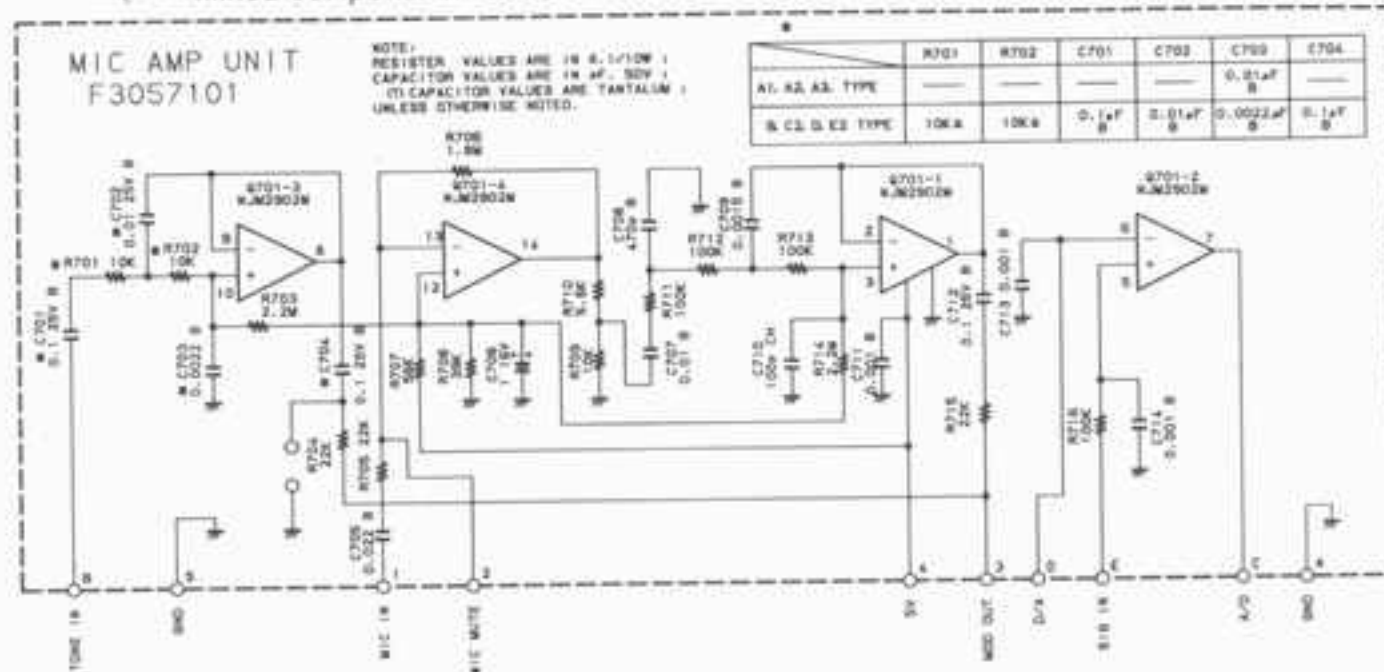
(obverse view of "mixed-component" side)



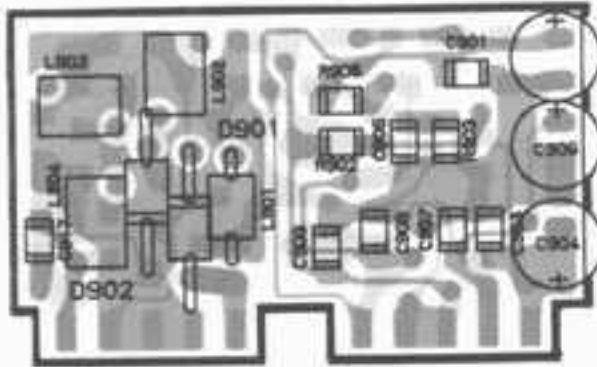
(obverse view of "chip-only" side)



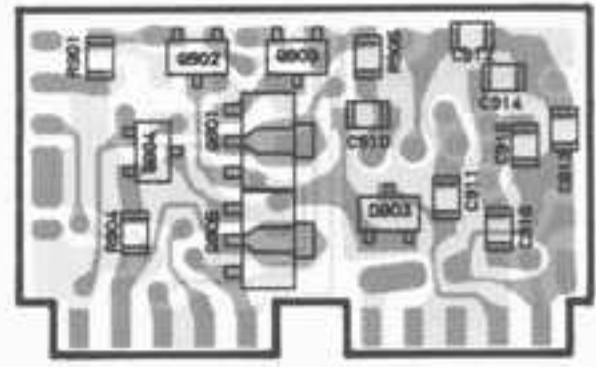
NJM2902M (Q701)



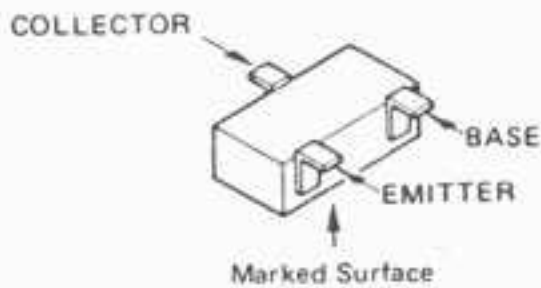
# ANT SW UNIT



(obverse view of "mixed-component" side)



(obverse view of "chip-only" side)



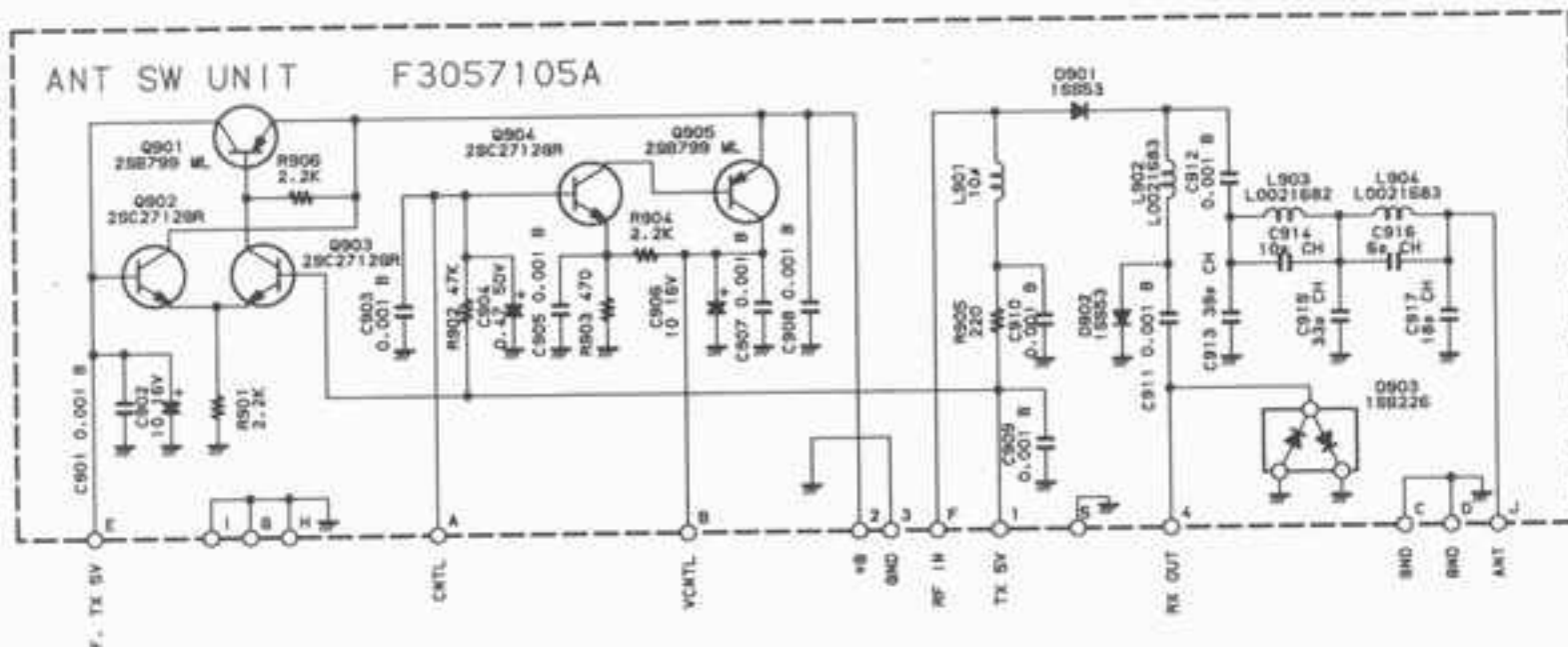
25C2712GR (LQ)  
(Q902,903,904)



25B799 (Q901,905)

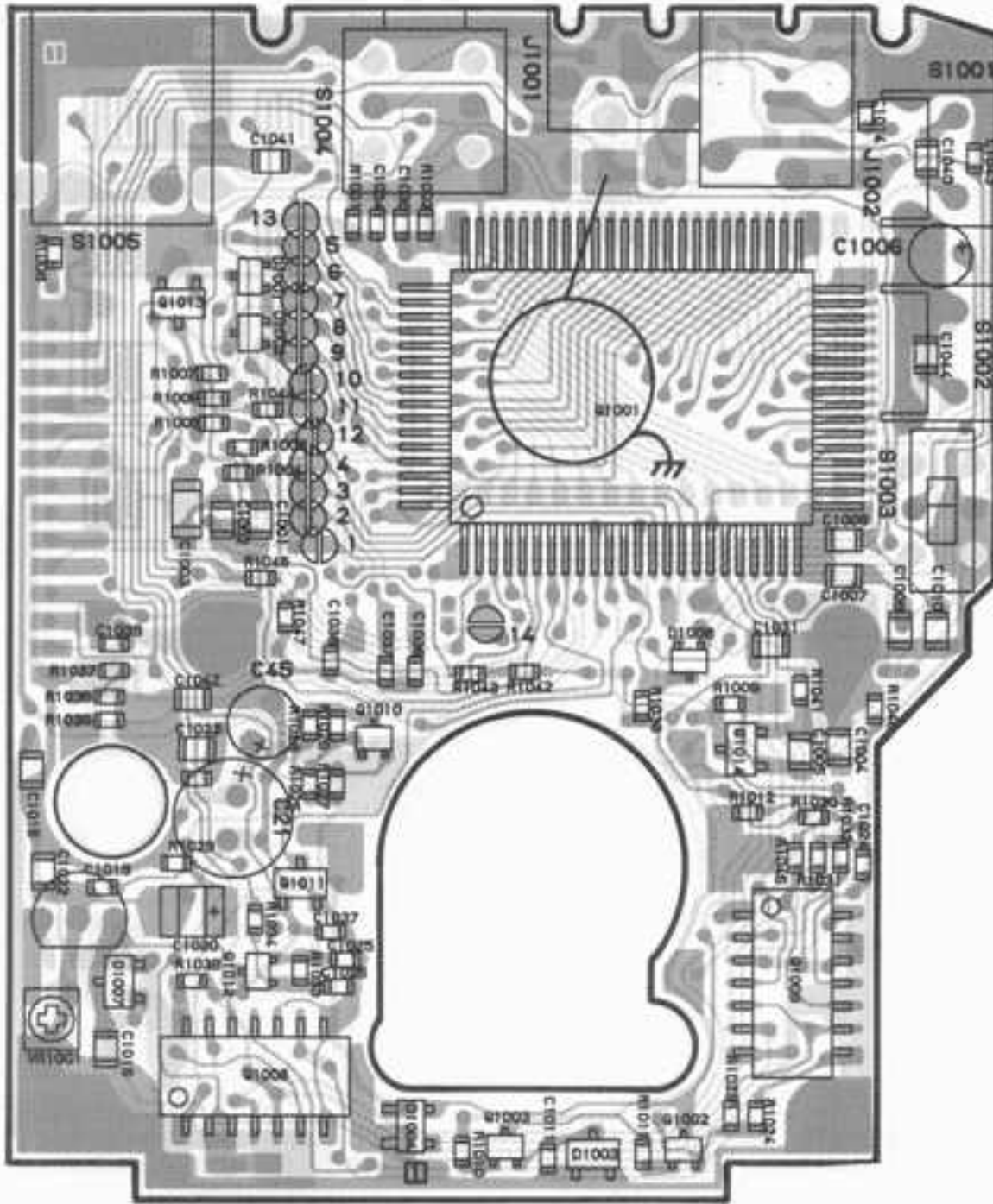


1SS226 (C3) : (D903)

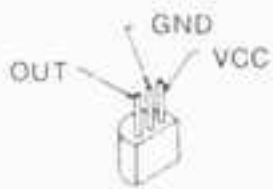


NOTE: RESISTOR VALUES ARE IN  $\Omega$ , 1/10W; CAPACITOR VALUES ARE IN  $\mu$ F, 50V; (T) CAPACITOR VALUES ARE TANTALUM; INDUCTOR VALUES ARE IN H; UNLESS OTHERWISE NOTED.

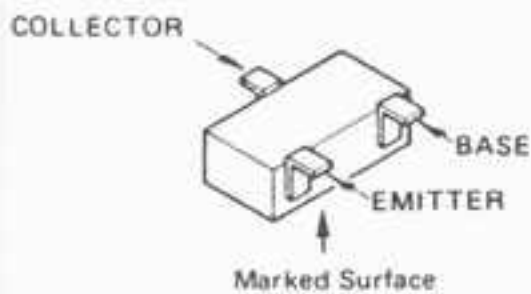
# CNTL UNIT



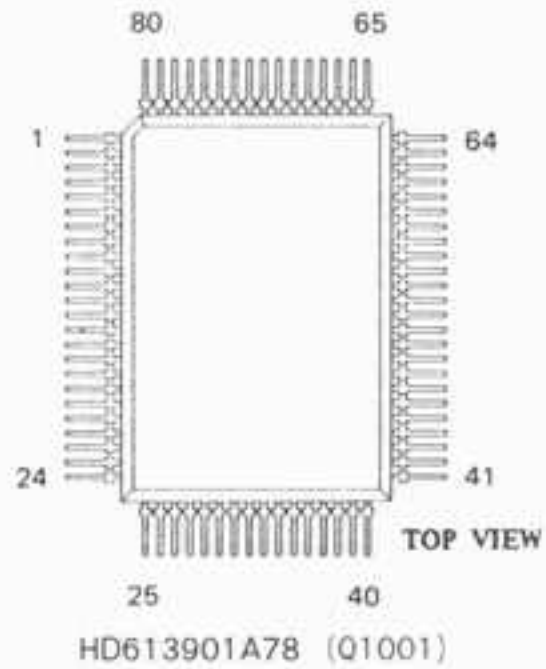
(obverse view of "mixed-component" side)



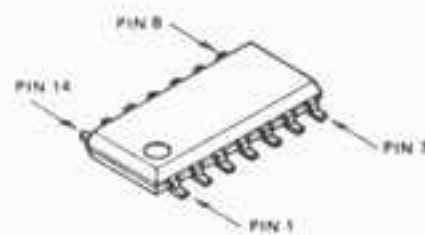
PST523G (Q1007)



- 2SA1586Y (SY) : (Q1002, Q1012)
- 2SC4116GR (LG) : (Q1003, Q1004, Q1005, Q1006, Q1010)
- FA1A4M (L33) : (Q1011, Q1013)
- 2SC1623 ((L6)) : (Q1014)



HD613901A78 (Q1001)

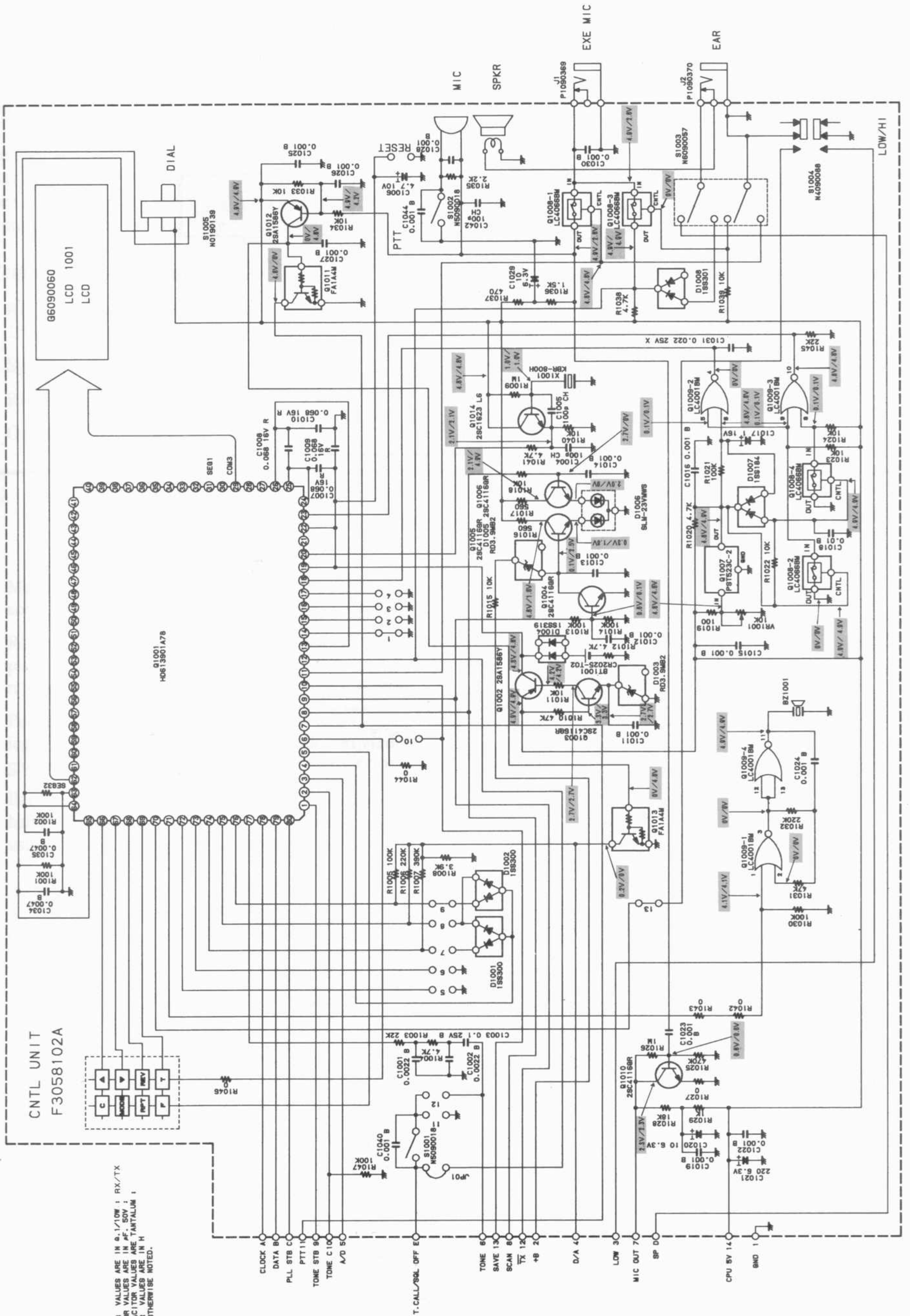


$\mu$ PD4066BG (Q1008)  
 $\mu$ PD4001BG (Q1009)



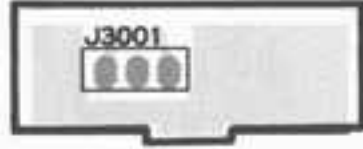


# CNTL UNIT



NOTE: RESISTOR VALUES ARE IN  $\Omega$ , 1/10W, 1 RX/TX CAPACITOR VALUES ARE IN  $\mu$ F, 50V. (D) CAPACITOR VALUES ARE TANTALUM. (T) CAPACITOR VALUES ARE IN H UNLESS OTHERWISE NOTED.

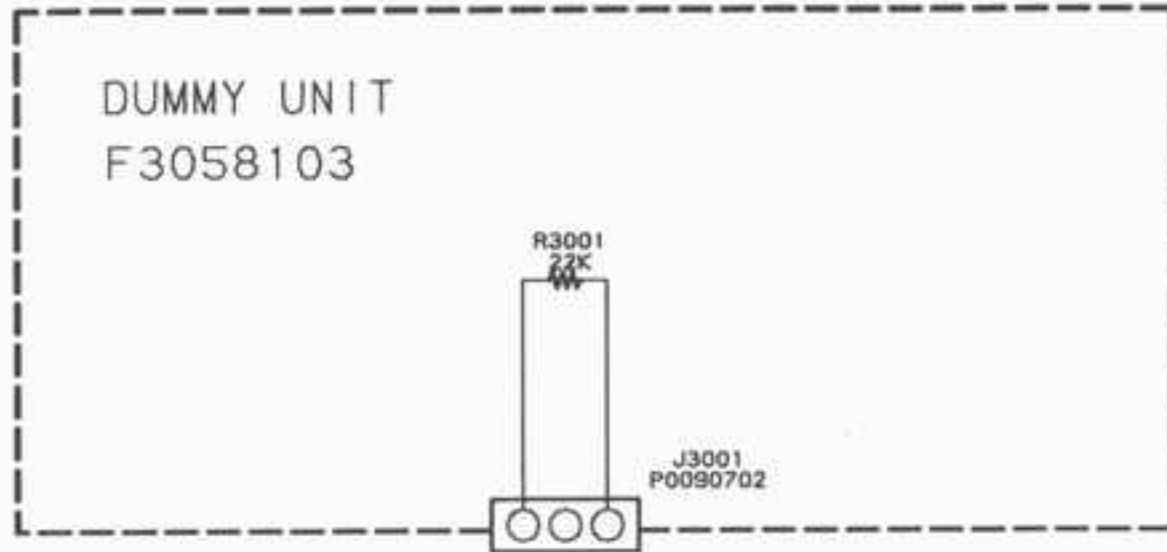
# DUMMY UNIT



(obverse view of  
"connector" side)



(obverse view of  
"chip-only" side)



NOTE:  
RESISTOR VALUES ARE IN 0.1/16W ;  
UNLESS OTHERWISE NOTED.



## ALIGNMENT

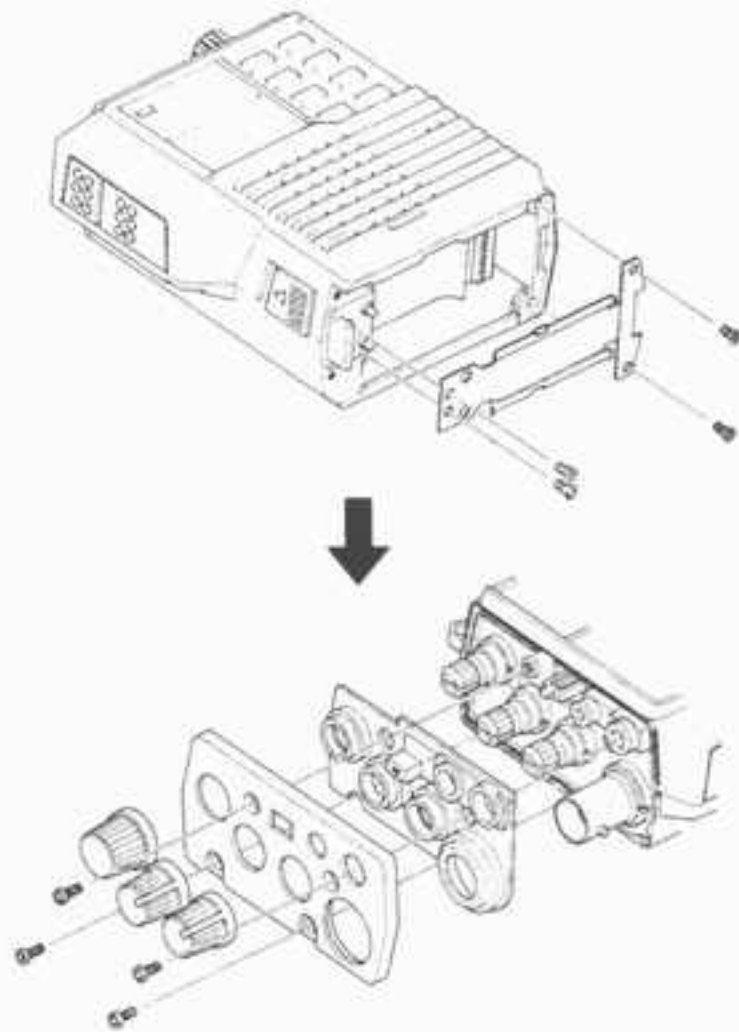
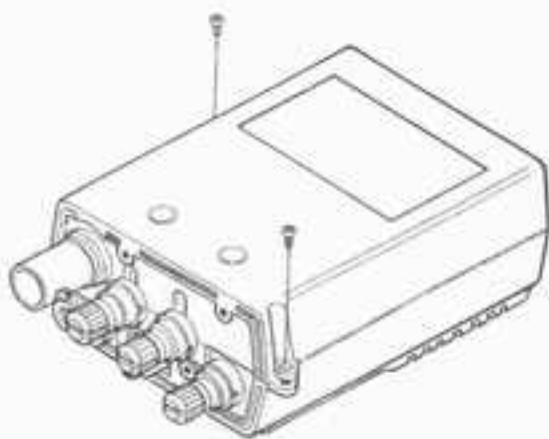
The FT-23R has been aligned by highly-skilled technicians at the factory, and is designed so that no further alignment should ever be required. However, in the unlikely event of a component failure, realignment may be necessary. All component replacement and service should be performed only by an authorized Yaesu representative, or the warranty policy may be voided.

### Required Test Equipment

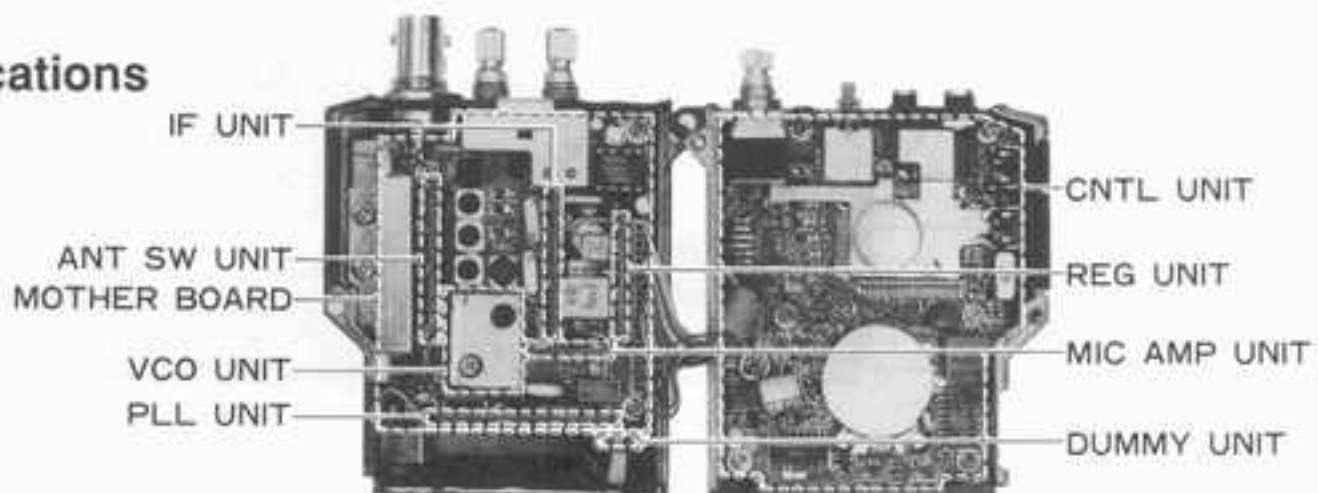
- RF Signal Generator with calibrated output level at 150 MHz
- Spectrum Analyzer
- RF Sampling Coupler
- Oscilloscope
- AF Millivoltmeter
- Deviation Meter
- SINAD Meter
- Inline Wattmeter with 5% accuracy at 150 MHz
- Regulated DC Power Supply adjustable from 10 to 15V, 2A
- 50- $\Omega$  Non-reactive Dummy Load: 10W at 150 MHz
- Frequency Counter:  $\pm 0.2$ ppm accuracy at 150 MHz
- AF Signal Generator
- DC Voltmeter: high impedance
- External Loudspeaker or 8- $\Omega$  load resistor.

## Case Disassembly

- Make sure the transceiver is off. Remove the hard or soft case, if used, and remove the battery pack.
- Remove the four screws affixing the battery spring plate on the bottom of the transceiver, and carefully remove the plate.
- Pull off the knobs, and remove the four screws affixing the top panel. Remove the panel and rubber gasket under it.
- Remove the two screws affixing the front and rear halves of the case, and gently separate the halves, using care not to stress the interconnecting wires.



## Board Locations





## PLL & Transmitter

Set up the test equipment as shown below for transmitter alignment. Adjust the supply voltage to 12.0V for all steps except Transmitter Output Power.

### PLL VCV (Varactor Control Voltage)

- (1) Connect the DC voltmeter between C417 on the PLL Unit and chassis ground.
- (2) Set the transceiver to 144.00 MHz. Key the transmitter and adjust transformer T501 on the VCO Buffer Unit for  $11.5 \pm 0.05$  V DC on the voltmeter.
- (3) While receiving on 144.00 MHz, adjust trimmer TC501 on the VCO Unit for  $0.8 \pm 0.05$  V DC.
- (4) Tune the transceiver to the high band edge and confirm the correct high-end VCV for the transceiver version being aligned, in both transmit and receive, as follows:

Version	High Band Edge	Tx VCV	Rx VCV
A, C & E	148.000 MHz	<1.6 V	<1.3 V
B & D	146.000 MHz	<1.5 V	<1.2 V

## Transmitter Output Power

- (1) Tune the transceiver to band center (145 or 146 MHz), and select high power output (LOW switch not depressed).
- (2) Increase the supply voltage to 12.5 V, and then adjust VR2005 on the Mother Board for peak output power on the wattmeter (at least 5 watts with less than 1.5 A supply current).
- (3) Now press the LOW button, and adjust VR2005 (again), this time for  $0.5 \pm 0.1$  watt.

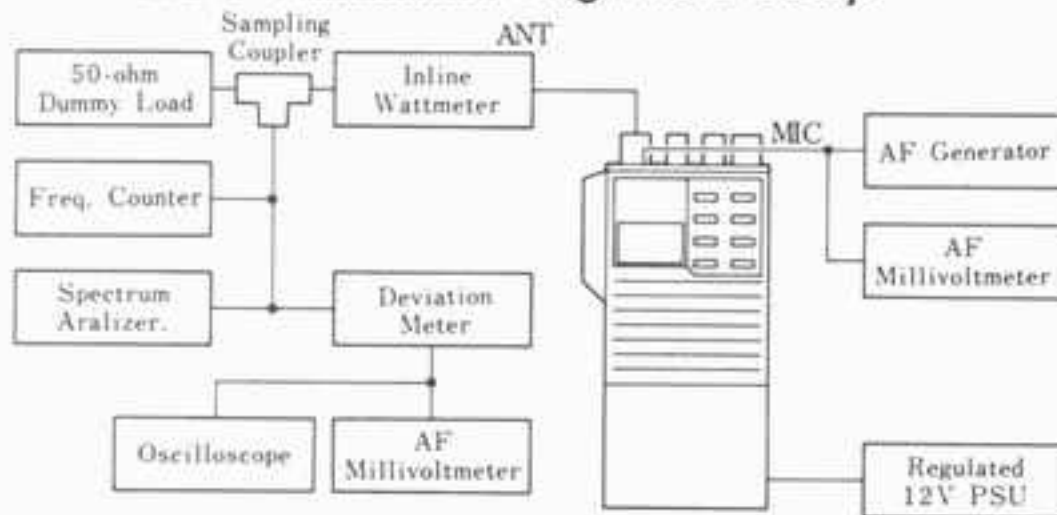
## PLL Reference Frequency

With the transceiver tuned to band center (145 or 146 MHz), adjust TC401 on the PLL Unit, if necessary, so the display frequency matches the frequency counter when transmitting.

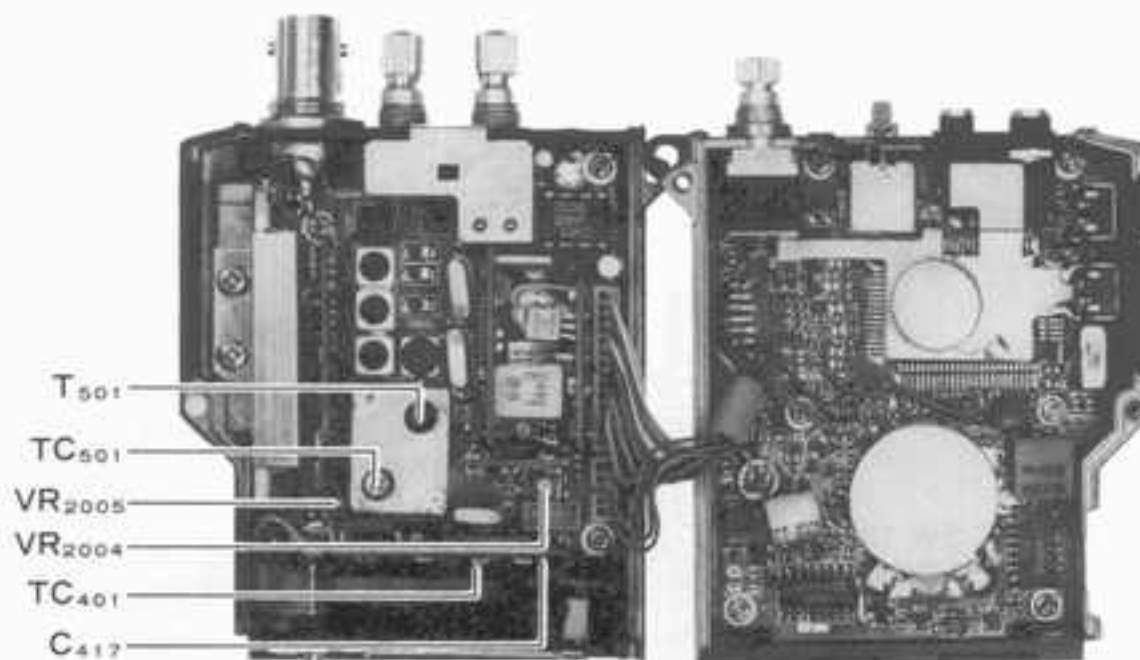
## Modulation Level

- (1) With the transceiver tuned to band center (145 or 146 MHz), adjust the AF generator for 25-mV output at 1 kHz to the MIC jack.
- (2) Adjust VR2004 on the Mother Board for  $\pm 4.8$ -kHz deviation on the deviation meter.

## PLL & Transmitter Alignment Setup



## PLL & Transmitter Alignment Points



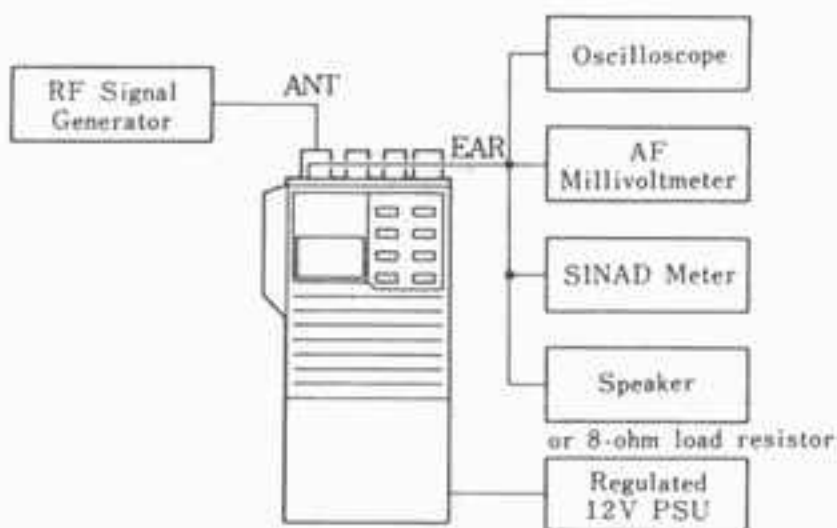
## Receiver

Set up the test equipment as shown below for receiver alignment.

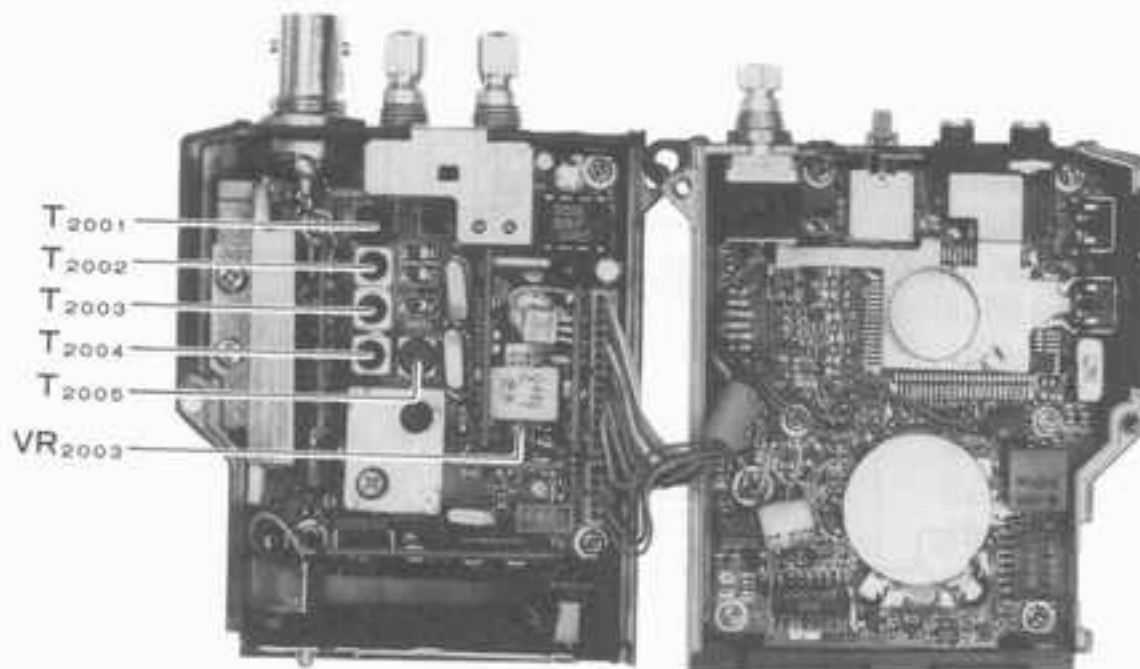
- (1) With the transceiver and the RF signal generator both tuned to band center (145 or 146 MHz), set the generator for  $\pm 3.5$  kHz deviation of 1-kHz tone modulation, and set the output level for 40 dB $\mu$  at the antenna jack.
- (2) Preset VR2003 on the Mother Board fully clockwise.

- (3) Adjust T2001 through T2005 on the Mother Board for maximum S-meter indication, reducing the generator level if more than 4 bargraph segments turn on.
- (4) After adjusting the transformers, generator level should be 0.2  $\mu$ V or less for 12dB SINAD.
- (5) Reduce the RF injection from the signal generator to 20 dB $\mu$ .
- (6) Adjust VR2003 on the Mother Board so that all bargraph segments are just turned on.
- (7) Reduce the generator output so that only 2 segments are on, and confirm that the injection level is 5 dB $\mu$  or less.

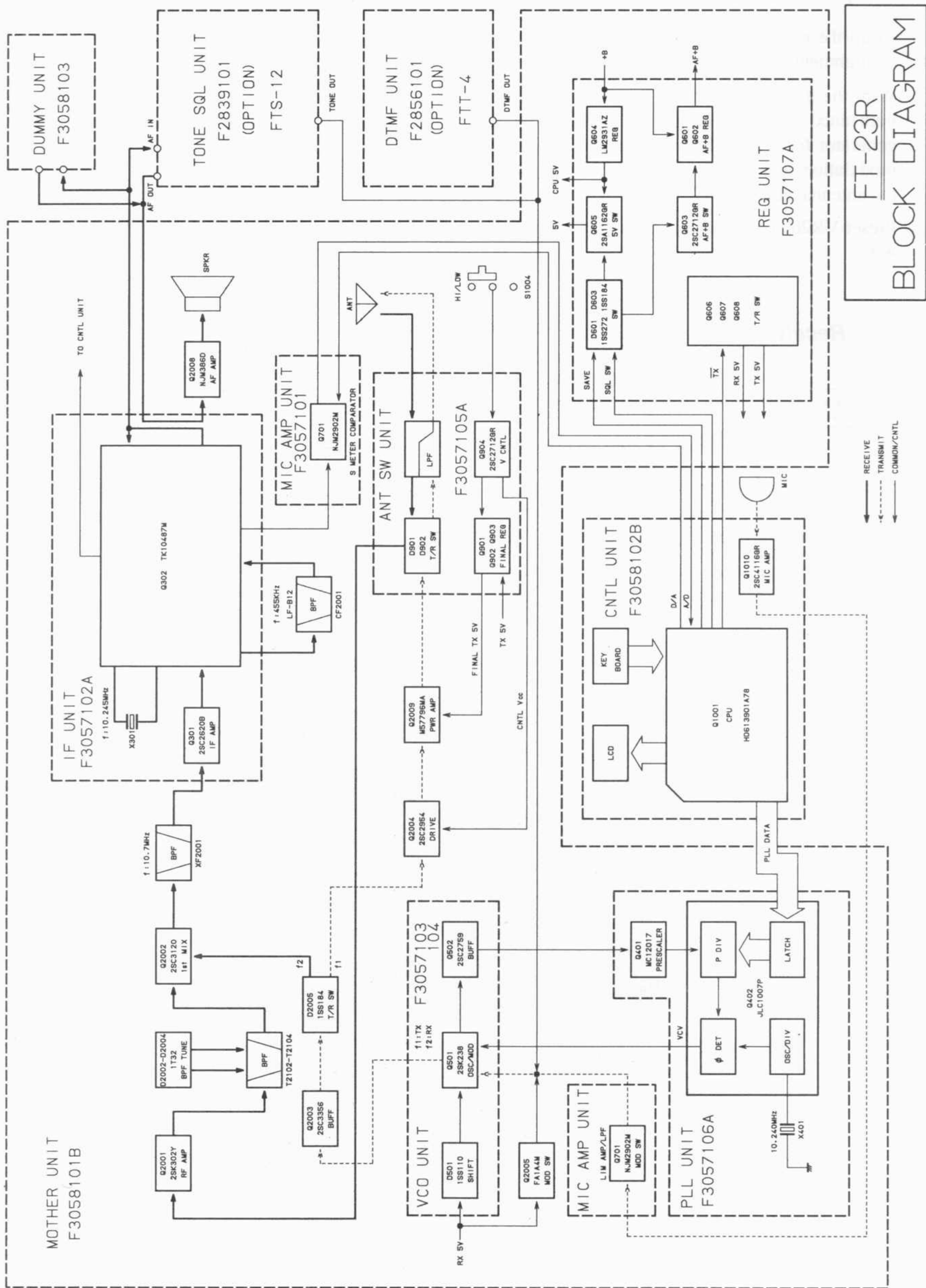
### Receiver Alignment Setup



### Receiver Alignment Points



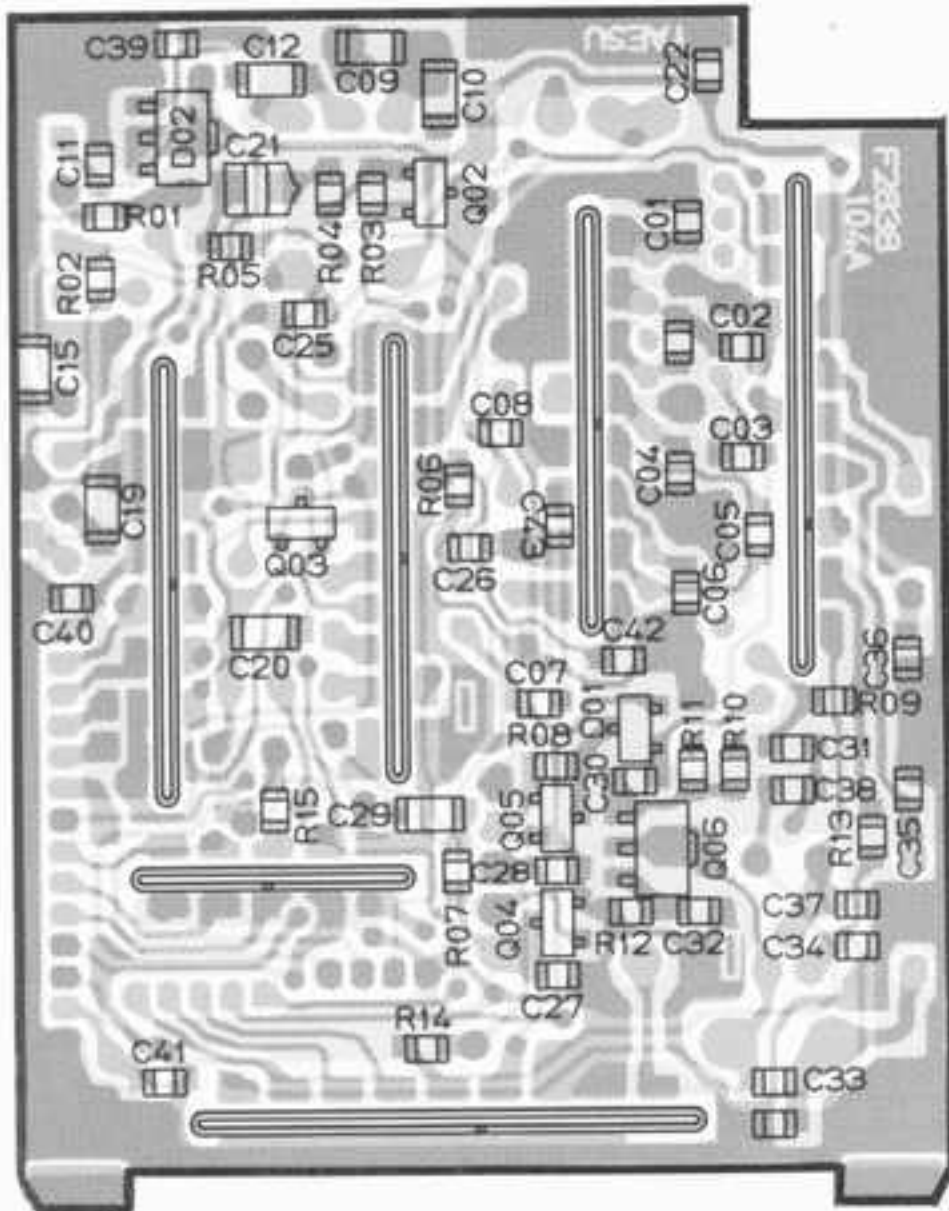




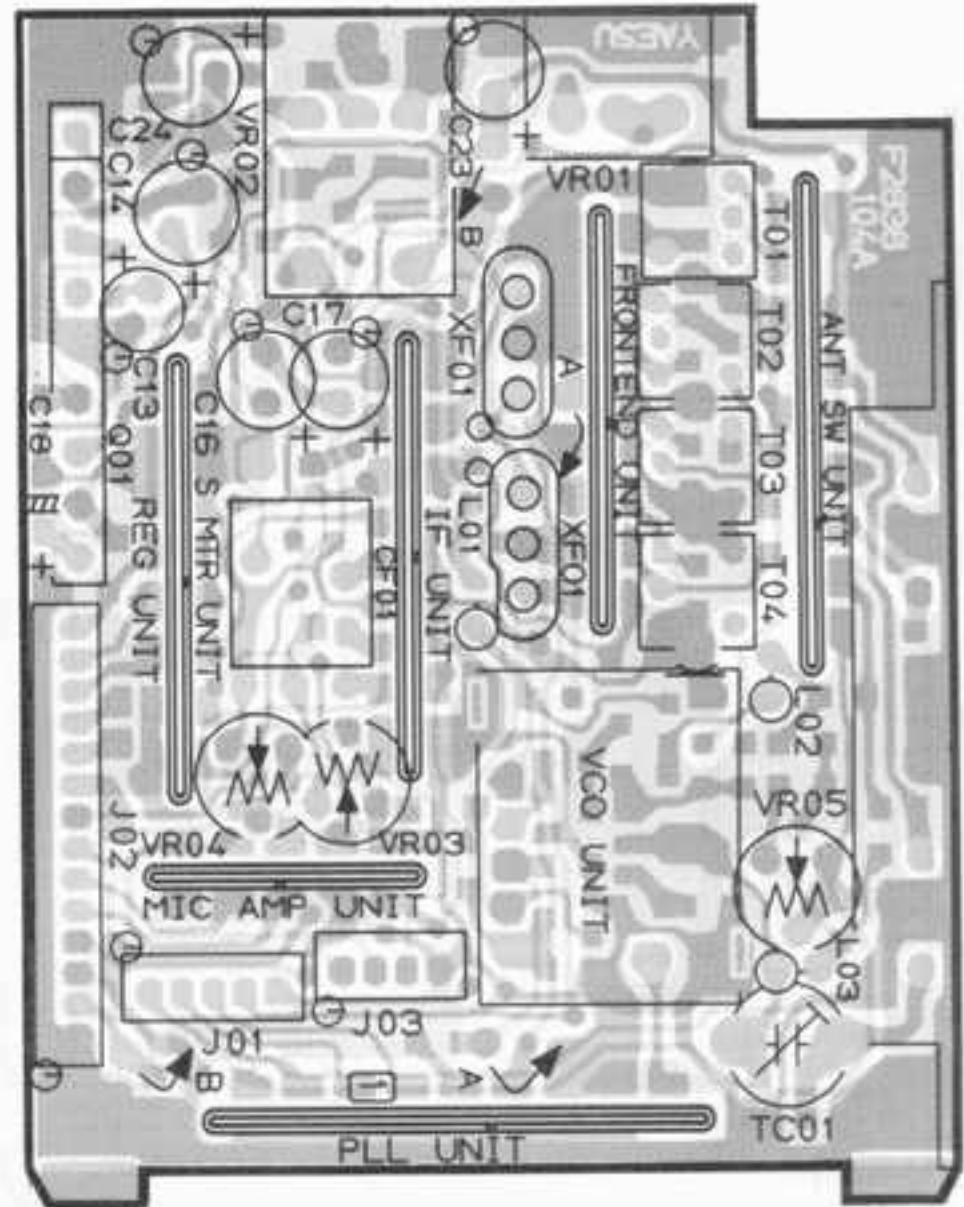
**FT-23R**  
**BLOCK DIAGRAM**



# MOTHER BOARD



(obverse view of "chip-only" side)



(reverse view of "component" side)

## CHIP SEMICONDUCTOR CROSS-REFERENCE

PART LOCATION NO.	ORIGINAL	REPLACEMENT		
	NOMENCLATURE (MARKING) AND PART NUMBER	NOMENCLATURE (MARKING) AND PART NUMBER		
Q102,605,606,607,1002,1012	2SA1162GR(SG) G3111620G	2SA812F/G(M6/M7) G3108120F/G	2SA1052C/D(MC/MD) G3110520C/D	2SA1179F/G(M6/M7) G3111790F/G
Q103,602,603,608,801,802,902,903,904,1003,1004,1005,1006,1010	2SC2712GR/BL(LG/LL) G3327120G/B	2SC1623F/G(L6/L7) G3316230F/G	2SC2462C/D(LC/LD) G3324620D/D	2SC2812F/G(L6/L7) G3328120F/G
Q701	M5224FP G1090726	LA6324M G1090559		
D1001,1002	1SS181(A3) G2070001	MC2836(A4) G2070024	DCA015TA(A4) G2070014	
D603,1007,1008	1SS184(B3) G2070009	MC2838(A6) G2070018	DCB015TA(A6) G20700021	

\* Semiconductors not listed above may be replaced only with original types.

\*\*\* IF UNIT \*\*\*

C40007001 P.C.B. W/COMP.  
F3149100 P.C.B. W/O COMP.

C 0301	K22144803	CHIP CAP.	GRM398103M25PT	0.01uF	25V	B
C 0302	K22174609	CHIP CAP.	GRM398102M50PT	0.001uF	50V	B
C 0303	K22174211	CHIP CAP.	GRM39CH100050PT	10pF	50V	CH
C 0304	K22174229	CHIP CAP.	GRM39CH500J50PT	56pF	50V	CH
C 0305	K22174227	CHIP CAP.	GRM39CH121J50PT	120pF	50V	CH
C 0306	K22144802	CHIP CAP.	GRM398103M25PT	0.01uF	25V	B
C 0307	K22120805	CHIP CAP.	GRM40863M16PT	0.068uF	16V	E
C 0308	K22170820	CHIP CAP.	GRM408183M50PT	0.018uF	50V	B
C 0309	K78600002	CHIP TANTALUM CAP.	F950J475MSAAF1Q2	4.7uF	6.3V	
C 0310	K22144802	CHIP CAP.	GRM398103M25PT	0.01uF	25V	B
C 0311	K22174235	CHIP CAP.	GRM39CH101J50PT	100pF	50V	CH
C 0312	K22120805	CHIP CAP.	GRM40863M16PT	0.068uF	16V	E
C 0313	K22174243	CHIP CAP.	GRM39CH221J50PT	220pF	50V	CH
C 0314	K22174243	CHIP CAP.	GRM39CH221J50PT	220pF	50V	CH
C 0315	K22120805	CHIP CAP.	GRM40863M16PT	0.068uF	16V	E
C 0316	K22144802	CHIP CAP.	GRM398103M25PT	0.01uF	25V	B
C 0317	K22120805	CHIP CAP.	GRM40863M16PT	0.068uF	16V	E
C 0318	K22120805	CHIP CAP.	GRM40863M16PT	0.068uF	16V	E

C00301 87900180 CERAMIC DISC.

C08455C7

D 0301 G2870003 DIODE  
D 0302 G2870003 DIODE  
D 0303 G2870009 DIODE

1S5226 TERSU  
1S5226 TERSU  
1S5184 TERSK

L 0301 L1890018 COIL

32CS 3888-1EDM>P full

Q 0301 G33262078 TRANSISTOR  
Q 0302 G1091308 IC  
Q 0303 G3070031 TRANSISTOR  
Q 0304 G3327127G TRANSISTOR

2SC2620QBT  
MC3372ML  
DT124TK T97  
2SC2712G TERSK

R 0301 J24185222 CHIP RES.  
R 0302 J24185224 CHIP RES.  
R 0303 J24185473 CHIP RES.  
R 0304 J24185471 CHIP RES.  
R 0305 J24185101 CHIP RES.  
R 0306 J24185473 CHIP RES.  
R 0307 J24185223 CHIP RES.  
R 0308 J24185473 CHIP RES.  
R 0309 J24185662 CHIP RES.  
R 0310 J24185102 CHIP RES.  
R 0311 J24185152 CHIP RES.  
R 0312 J24205182 CHIP RES.  
R 0313 J24205473 CHIP RES.  
R 0314 J24185382 CHIP RES.  
R 0315 J24185594 CHIP RES.  
R 0316 J24185332 CHIP RES.  
R 0317 J24185332 CHIP RES.  
R 0318 J24185302 CHIP RES.  
R 0319 J24185332 CHIP RES.  
R 0320 J24185473 CHIP RES.  
R 0321 J24185382 CHIP RES.  
R 0322 J24185104 CHIP RES.

RMC1/10 222JATP 2.2K 1/10W  
RMC1/10 224JATP 220K 1/10W  
RMC1/10 473JATP 47K 1/10W  
RMC1/10 471JATP 470 1/10W  
RMC1/10 101JATP 100 1/10W  
RMC1/10 221JATP 220 1/10W  
RMC1/10 223JATP 22K 1/10W  
RMC1/10 473JATP 47K 1/10W  
RMC1/10 102JATP 1.0K 1/10W  
RMC1/10 102JATP 1K 1/10W  
RMC1/10 332JATP 1.5K 1/10W  
RMC1/10 102JATP 1.0K 1/10W  
RMC1/30T 473J 47K 1/10W  
RMC1/10 102JATP 1.0K 1/10W  
RMC1/10 504JATP 500K 1/10W  
RMC1/10 332JATP 3.3K 1/10W  
RMC1/10 332JATP 3.3K 1/10W  
RMC1/10 302JATP 3K 1/10W  
RMC1/10 332JATP 3.3K 1/10W  
RMC1/10 473JATP 47K 1/10W  
RMC1/10 302JATP 3.0K 1/10W  
RMC1/10 104JATP 100K 1/10W

TH0301 G8490053 THERMISTOR

157-202-53008TF

X 0301 H0102773 X'TAL

CM-1 10.245MHZ

## PARTS LIST

\*\*\* MOTHER BOARD UNIT \*\*\*

CS0851002 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP A1)

CS0851003 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP A2)

CS0851004 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP A3)

CS0851005 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP B)

CS8851006 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP C2)

CS0851007 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP D)

CS0851008 P.C.B. W/COMP./MIC AMP/IF/VCO/  
ANT SW/PLL/REG UNITS(TYP E2)

F30581018 P.C.B. W/O COMP.

C 2001	K22170204	CHIP CAP.	GRM40CJ030C50PT	3pF	50V	CJ
C 2002	K22144602	CHIP CAP.	GRM39B102M25PT	0.01uF	25V	B
C 2003	K22174009	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2004	K22170223	CHIP CAP.	GRM40CH330J50PT	33pF	50V	CH
C 2005	K22170203	CHIP CAP.	GRM40CK020C30PT	2pF	50V	CK
C 2006	K22170203	CHIP CAP.	GRM40CK020C50PT	2pF	50V	CK
C 2008	K22170223	CHIP CAP.	GRM40CH330J50PT	33pF	50V	CH
C 2009	K22170223	CHIP CAP.	GRM40CH330J50PT	33pF	50V	CH
C 2010	K22170223	CHIP CAP.	GRM40CH330J50PT	33pF	50V	CH
C 2011	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2012	K22120805	CHIP CAP.	GRM408H3M16PT	0.068uF	16V	E
C 2013	K22174609	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2014	K22170202	CHIP CAP.	GRM40CK010C50PT	1pF	50V	CK
C 2015	K22170229	CHIP CAP.	GRM40CH360J50PT	56pF	50V	CH
C 2017	K22170817	CHIP CAP.	GRM40B102M50PT	0.01uF	50V	B
C 2018	K22144802	CHIP CAP.	GRM39B102M25PT	0.01uF	25V	B
C 2019	K22170205	CHIP CAP.	GRM40CH050C50PT	5pF	50V	CH
C 2020	K22120805	CHIP CAP.	GRM40E683M16PT	0.068uF	16V	E
C 2022	K22120805	CHIP CAP.	GRM40E683M16PT	0.068uF	16V	E
C 2023	K40089023	AL. ELECTRO. CAP.	RC2-5V470MS	47uF	5V	
C 2024	K40129059	AL. ELECTRO. CAP.	RC3-16V4R7MS	4.7uF	16V	
C 2025	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2026	K40109026	AL. ELECTRO. CAP.	10V8-100(M)CC	100uF	10V	
C 2027	K22120805	CHIP CAP.	GRM40E683M16PT	0.068uF	16V	E
C 2028	K70107476	TANTALUM CAP.	9N1A470M15	47uF	10V	
C 2029	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2030	K40129052	AL. ELECTRO. CAP.	RC3-16V100M	10uF	16V	
C 2031	K40129038	AL. ELECTRO. CAP.	RC2-10V101MS	100uF	16V	
C 2032	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2033	K76100002	CHIP TANTALUM CAP.	F951A335MSAAE1Q2	3.3uF	6.3V	
C 2034	K22141808	CHIP CAP.	GRM42-EB473M25PT	0.047uF	50V	B
C 2035	K22170221	CHIP CAP.	GRM40CH270J50PT	27pF	50V	CH
C 2036	K22170805	CHIP CAP.	GRM40B102M50PT	0.001uF	50V	B
C 2037	K22144802	CHIP CAP.	GRM39B103M25PT	0.01uF	25V	B
C 2038	K22144802	CHIP CAP.	GRM39B103M25PT	0.01uF	25V	B
C 2039	K22170221	CHIP CAP.	GRM40CH270J50PT	27pF	50V	CH
C 2040	K22170211	CHIP CAP.	GRM40CH100D50PT	10pF	50V	CH
C 2041	K22174230	CHIP CAP.	GRM39CH101J50PT	100pF	50V	CH
C 2043	K22170805	CHIP CAP.	GRM40B102M50PT	0.001uF	50V	B
C 2044	K22170805	CHIP CAP.	GRM40B102M50PT	0.001uF	50V	B
C 2045	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2046	K22174809	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B
C 2047	K22174609	CHIP CAP.	GRM39B102M50PT	0.001uF	50V	B



\*\*\* VCO UNIT \*\*\*

	CP1992001	P.C.B. W/COMP.				
	F3057103	P.C.B. W/O COMP.				
	F3057104	P.C.B. W/O COMP.				
C	0501	K22170215	CHIP CAP.	GRM40CH150J50PT	15pF	50V CH
C	0502	K22170243	CHIP CAP.	GRM40CH221J50PT	225pF	50V CH
C	0503	K22170211	CHIP CAP.	GRM40CH1000S0PT	10pF	50V CH
C	0504	K76000003	CHIP TANTALUM CAP.	F950J105MTAAF1Q2	10uF	6.3V
C	0505	K22170005	CHIP CAP.	GRM40B102M50PT	0.001uF	50V B
C	0506	K22170311	CHIP CAP.	GRM40UJ1000S0PT	10pF	50V UJ
C	0507	K22170311	CHIP CAP.	GRM40UJ1000S0PT	10pF	50V UJ
C	0508	K22170201	CHIP CAP.	GRM40CK005C50PT	0.5pF	50V CK
C	0509	K76000003	CHIP TANTALUM CAP.	F950J475MSAAF1Q2	4.7uF	6.3V
C	0510	K22170805	CHIP CAP.	GRM40B102M50PT	0.001uF	50V B
C	0511	K22170243	CHIP CAP.	GRM40CH221J50PT	220pF	50V CH
D	0501	G2090207	DIODE	1S5110		
D	0502	G2070040	DIODE	1T33-T7		
D	0503	G2070040	DIODE	1T33-T7		
L	0501	L1690016	COIL	32CS 380LB-180M=P	1uH	
L	0502	L1690016	COIL	32CS 380LB-180M=P	1uH	
L	0503	L1690016	COIL	32CS 380LB-180M=P	1uH	
L	0504	L1690025	COIL	32CS 380NB-R22M=P	0.22uH	
Q	0501	G30223675	FET	2SK238-T20-K17		
Q	0502	G33275979	TRANSISTOR	2SC0759 T2B-L22		
R	0501	J24205682	CHIP RES.	RMC1/10 68J	6.6K	1/10W
R	0502	J24205103	CHIP RES.	RMC1/10T 10J	10K	1/10W
R	0504	J24205470	CHIP RES.	RMC1/10 470J	47	1/10W
R	0505	J24205101	CHIP RES.	RMC1/10T 101J	100	1/10W
R	0506	J24205682	CHIP RES.	RMC1/10 68J	68K	1/10W
T	0501	L0021684A	COIL	K12-E991X		
TC	0501	K91000151	TRIMMER CAP.	ECK-JA020E12X	50p	
		RD130390	TERMINAL			20ex

\*\*\* RES UNIT \*\*\*

C40011001 P.C.B. W/COMP.  
 F3057107A P.C.B. W/O COMP.

C 0801	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0802	K78100002	CHIP TANTALUM CAP.	F951A885MTAAF1Q2	6.8uF	6.3V	
C 0803	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0804	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0805	K78100002	CHIP TANTALUM CAP.	F951C225MSAAF1Q2	2.2uF	6.3V	
C 0806	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0807	K78080013	CHIP TANTALUM CAP.	F950J47MPCAF1	47uF	6.3V	
C 0808	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0809	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0810	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0811	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0812	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8
C 0813	K22174809	CHIP CAP.	GRN398102M50PT	0.001uF	50V	8

D 0601	G2970048	DIODE	1SS272	TE65R		
D 0602	G2980153	DIODE	8010ER1			
D 0603	G2970009	DIODE	1SS18A	TE65R		

Q 0801	G3207997L	TRANSISTOR	258799-12ML			
Q 0802	G3227127G	TRANSISTOR	25C2712GR	TE65R		
Q 0803	G3227127G	TRANSISTOR	25C2712GR	TE65R		
Q 0804	G1090785	IC	LN2931AZ-5.0			
Q 0805	G3111627G	TRANSISTOR	25A1162GR	TE65R		
Q 0806	G3111627G	TRANSISTOR	25A1162GR	TE65R		
Q 0807	G3111627G	TRANSISTOR	25A1162GR	TE65R		
Q 0808	G3227127G	TRANSISTOR	25C2712GR	TE65R		

R 0601	J24185101	CHIP RES.	RNC 1/10T 101J	100		1/10W
R 0602	J0224582R	CARBON FILM RES.	ED145JHR2	8.2		1/4W
R 0603	J24185223	CHIP RES.	RNC1/16 223JATP	22K		1/10W
R 0604	J24185104	CHIP RES.	RNC1/16 104JATP	100K		1/10W
R 0605	J24185103	CHIP RES.	RNC1/16 103JATP	10K		1/10W
R 0606	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K		1/10W
R 0607	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K		1/10W
R 0608	J24185222	CHIP RES.	RNC1/16 222JATP	2.2K		1/10W
R 0609	J24185104	CHIP RES.	RNC1/16 104JATP	100K		1/10W
R 0610	J24185104	CHIP RES.	RNC1/16 104JATP	100K		1/10W
R 0611	J24185103	CHIP RES.	RNC1/16 103JATP	10K		1/10W
R 0612	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K		1/10W

\*\*\* CONTROL UNIT \*\*\*

C50847002 P.C.B. W/COMP.(TYP A1)  
 C50847003 P.C.B. W/COMP.(TYP A2)  
 C50847004 P.C.B. W/COMP.(TYP A3)  
 C50847005 P.C.B. W/COMP.(TYP B)  
 C50847006 P.C.B. W/COMP.(TYP C2)  
 C50847007 P.C.B. W/COMP.(TYP D)  
 C50847008 P.C.B. W/COMP.(TYP E2)  
 F30581028 P.C.B. W/O COMP.

BT1001	Q3000386	LITHIUM BATTERY	CR2025-T02		
BZ1001	M290005	BUZZER	EF8-RS25007		
C 1001	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP B
C 1001	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP C2
C 1001	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP D
C 1001	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP E2
C 1002	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP B
C 1002	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP C2
C 1002	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP D
C 1002	K22170889	CHIP CAP.	GRM40B222M50PT	0.0022uF 50V	B TYP E2
C 1003	K22141899	CHIP CAP.	GRM42-6B104M25PT	0.1uF 25V	B
C 1004	K22170235	CHIP CAP.	GRM40CH101J50PT	100pF 50V	CH
C 1005	K22170235	CHIP CAP.	GRM40CH101J50PT	100pF 50V	CH
C 1006	K70487475	TANTALUM CHIP CAP.	DN1A4E2M1S	4.7uF 10V	
C 1007	K22120805	CHIP CAP.	GRM40R683M16PT	0.068uF 16V	R
C 1008	K22120805	CHIP CAP.	GRM40R683M16PT	0.068uF 16V	R
C 1009	K22120805	CHIP CAP.	GRM40R683M16PT	0.068uF 16V	R
C 1010	K22120805	CHIP CAP.	GRM40R683M16PT	0.068uF 16V	R
C 1011	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1012	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1013	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1014	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1015	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1016	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1017	K78120009	TANTALUM CHIP CAP.	TESVA1C105M1-6R	1uF 10V	
C 1018	K22170817	CHIP CAP.	GRM40R103M50PT	0.01uF 50V	B
C 1019	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1020	K78088003	TANTALUM CHIP CAP.	F950J106TAAF1Q2	10uF 6.3V	
C 1021	K40069010	AL. ELECTRO. CAP.	K12-6V221H	220uF 6.3V	
C 1022	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1023	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1024	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1025	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1026	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1027	K22174809	CHIP CAP.	GRM398102M50PT	0.001uF 50V	B
C 1028	K18176102	CERAMIC CAP.	D0104B102K30	0.001uF 50V	B
C 1029	K78080003	TANTALUM CHIP CAP.	F950J106TAAF1Q2	10uF 6.3V	
C 1030	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1031	K22170821	CHIP CAP.	GRM40B222M50PT	0.002uF 50V	B
C 1034	K22174617	CHIP CAP.	GRM398472M50PT	0.0047uF 50V	B
C 1035	K22174617	CHIP CAP.	GRM398472M50PT	0.0047uF 50V	B
C 1040	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
C 1042	K22170235	CHIP CAP.	GRM40CH101J50PT	100pF 50V	CH
C 1044	K22170805	CHIP CAP.	GRM40R102M50PT	0.001uF 50V	B
CO1001	W7805400	CERAMIC OSC.	KEE-800H		
D 1001	G2070084	DIODE	1SS300 T668R		



R 0713	J24185104	CHIP RES.	EMC1/16 104JATP	100K	1/16W
R 0714	J24185225	CHIP RES.	EMC1/16 225JATP	2.2K	1/16W
R 0715	J24205223	CHIP RES.	EMC1/16 223J	22K	1/16W
R 0716	J24185104	CHIP RES.	EMC1/16 104JATP	100K	1/16W

R 1008	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1009	J24185105	CHIP RES.	RNC1/16 105JATP	1K	1/16W
R 1010	J24185472	CHIP RES.	RNC1/16 472JATP	47K	1/16W
R 1011	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1012	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K	1/16W
R 1013	J24185104	CHIP RES.	RNC1/16 104JATP	100K	1/16W
R 1014	J24185104	CHIP RES.	RNC1/16 104JATP	100K	1/16W
R 1015	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1016	J24185561	CHIP RES.	RNC1/16 561JATP	560	1/16W
R 1017	J24185561	CHIP RES.	RNC1/16 561JATP	560	1/16W
R 1018	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1019	J24185101	CHIP RES.	RNC1/16 101JATP	100	1/16W
R 1020	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K	1/16W
R 1021	J24185104	CHIP RES.	RNC1/16 104JATP	100K	1/16W
R 1022	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1023	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1024	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1025	J24185474	CHIP RES.	RNC1/16 474JATP	470K	1/16W
R 1026	J24185105	CHIP RES.	RNC1/16 105JATP	1K	1/16W
R 1027	J24185000	CHIP RES.	RNC1/16 000JATP	0	1/16W
R 1028	J24185183	CHIP RES.	RNC1/16 183JATP	18K	1/16W
R 1029	J24185102	CHIP RES.	RNC1/16 102JATP	1K	1/16W
R 1030	J24185104	CHIP RES.	RNC1/16 104JATP	100K	1/16W
R 1031	J24185473	CHIP RES.	RNC1/16 473JATP	47K	1/16W
R 1032	J24185224	CHIP RES.	RNC1/16 224JATP	220K	1/16W
R 1033	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1034	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1035	J24185222	CHIP RES.	RNC1/16 222JATP	2.2K	1/16W
R 1036	J24185152	CHIP RES.	RNC1/16 152JATP	1.5K	1/16W
R 1037	J24185471	CHIP RES.	RNC1/16 471JATP	470	1/16W
R 1038	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K	1/16W
R 1039	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1040	J24185103	CHIP RES.	RNC1/16 103JATP	10K	1/16W
R 1041	J24185472	CHIP RES.	RNC1/16 472JATP	4.7K	1/16W
R 1042	J24185000	CHIP RES.	RNC1/16 000JATP	0	1/16W
R 1043	J24185000	CHIP RES.	RNC1/16 000JATP	0	1/16W
R 1044	J24185000	CHIP RES.	RNC1/16 000JATP	0	1/16W
R 1045	J24185223	CHIP RES.	RNC1/16 223JATP	22K	1/16W
R 1046	J24185000	CHIP RES.	RNC1/16 000JATP	0	1/16W
R 1047	J24185104	CHIP RES.	RNC1/16 104JATP	100K	1/16W

S 1001	N0090018	TACT SWITCH
S 1002	N0090018	TACT SWITCH
S 1003	N0090057	SLIDE SWITCH
S 1004	N4090088	PUSH SWITCH
S 1005	N0190139	ROTARY SWITCH

KHH-15951

KHH-15951

SSSS22

SPJ022K F19

SR0M110178

X 1001	H7900400	CERAMIC OSC.
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R9K-608H

R0118080 SEAL

R7132740 MYLAR

R7132750 MYLAR

R0130380 SHIELD PLATE

R7074930 DOUBLE FACE ADHESIVE

R7109650 DOUBLE FACE ADHESIVE

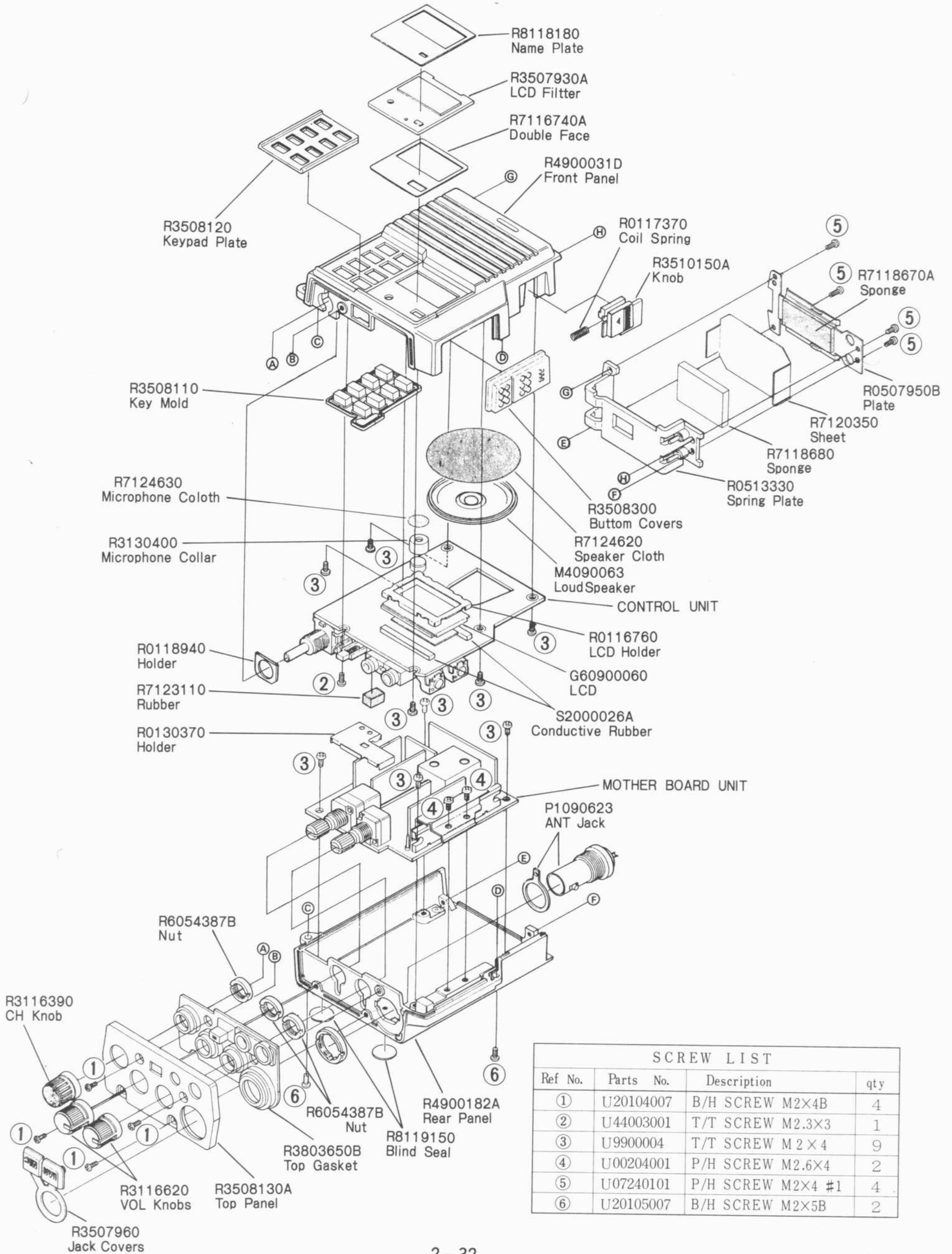
\*\*\* DUMMY UNIT \*\*\*

C50853001 P.C.S. W/COMP.  
F3858103 P.C.S. W/O COMP.

P 3001	P0890702	CONNECTOR	92308-1-032003-T	
B 3001	J24185223	CRIP RES.	ENC1/16 223JATP	22K



# EXPLODED VIEW

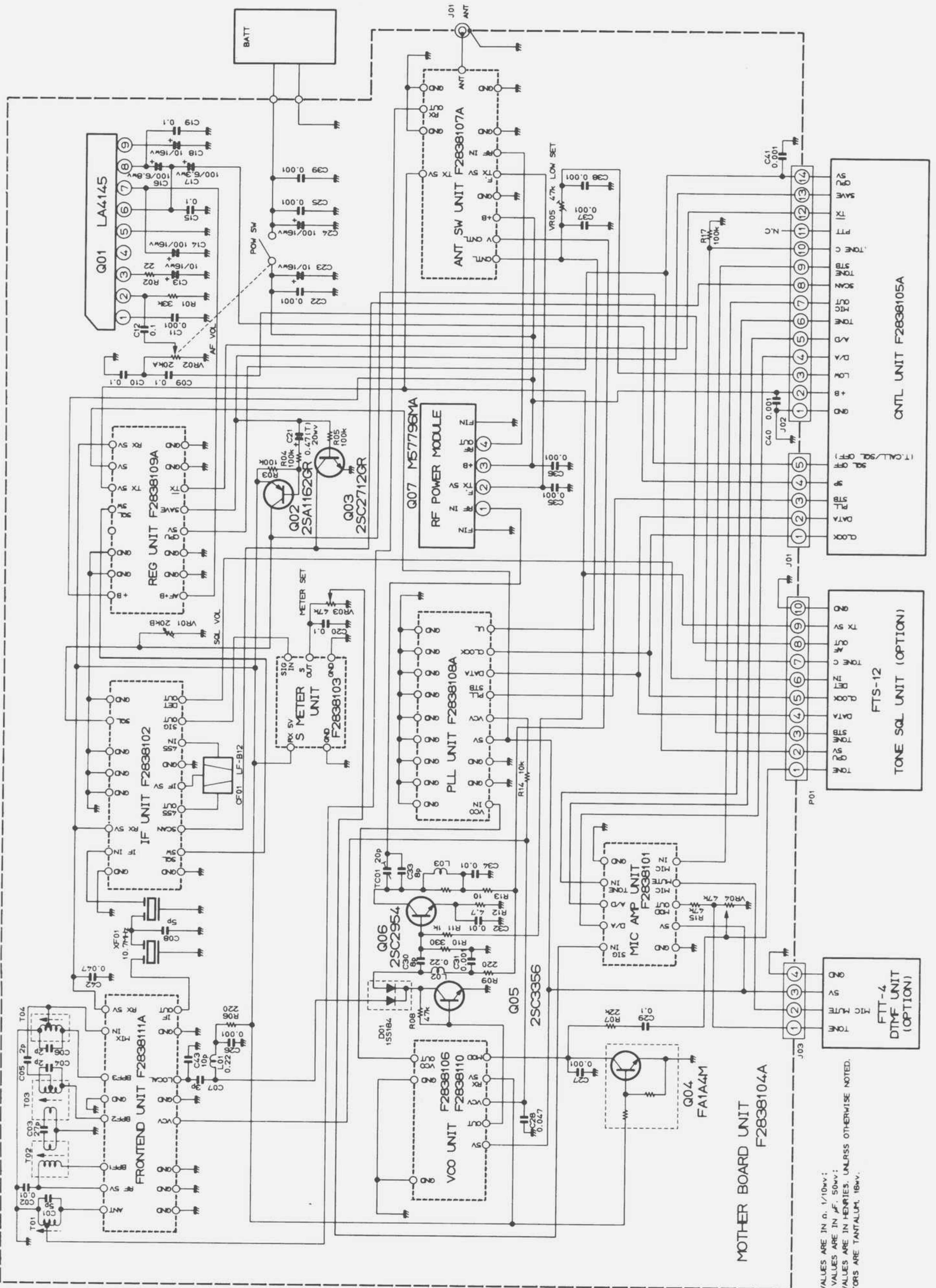


## SCREW LIST

Ref No.	Parts No.	Description	qty
①	U20104007	B/H SCREW M2×4B	4
②	U44003001	T/T SCREW M2.3×3	1
③	U9900004	T/T SCREW M 2 × 4	9
④	U00204001	P/H SCREW M2.6×4	2
⑤	U07240101	P/H SCREW M2×4 #1	4
⑥	U20105007	B/H SCREW M2×5B	2



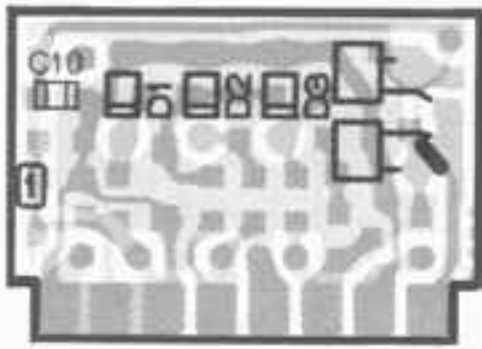
# MOTHER BOARD



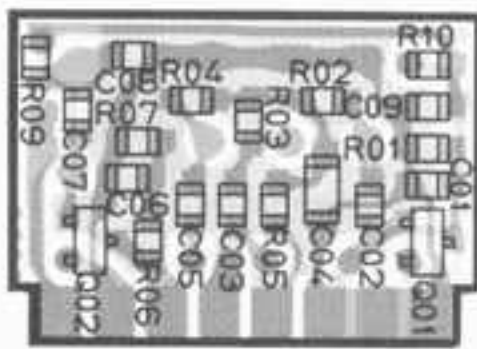
RESISTOR VALUES ARE IN  $\Omega$ , 1/10WV;  
 CAPACITOR VALUES ARE IN  $\mu$ F, 50VV;  
 INDUCTOR VALUES ARE IN HENRIES, UNLESS OTHERWISE NOTED.  
 (T)CAPACITORS ARE TANTALUM, 16WV.



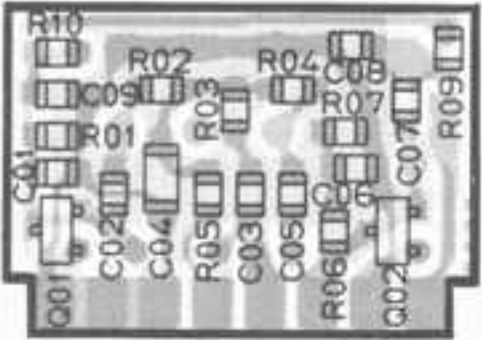
# FRONTEND UNIT



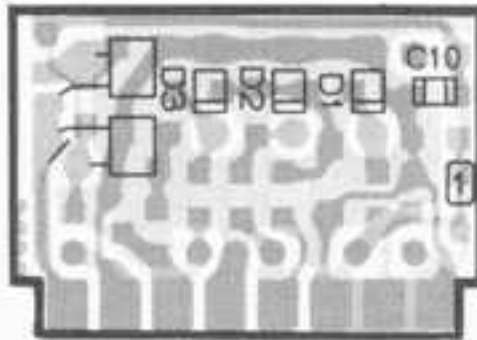
(obverse view of "diode" side)



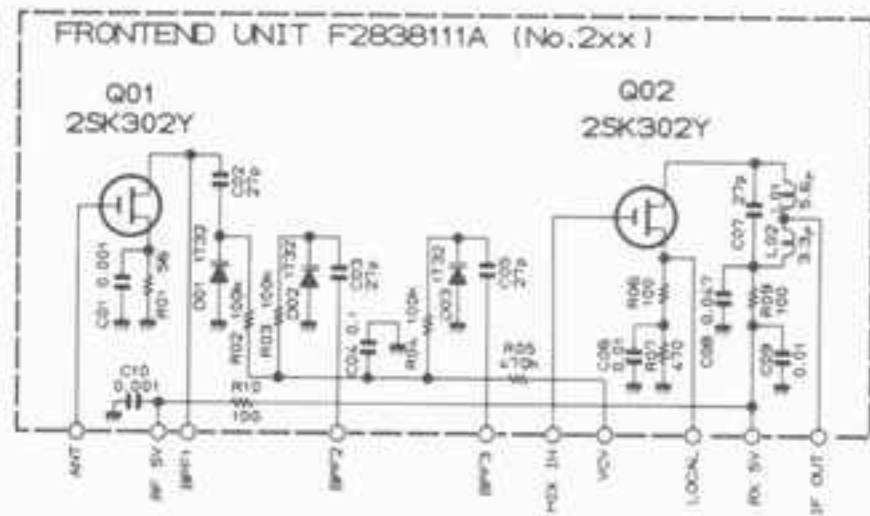
(obverse view of "FET" side)



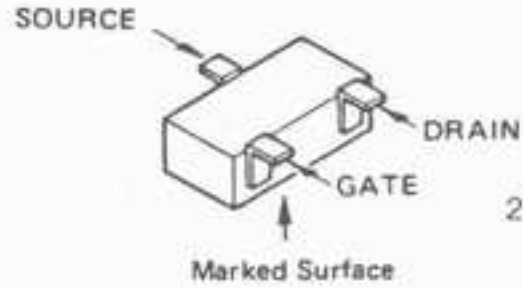
(reverse view of "FET" side)



(reverse view of "diode" side)

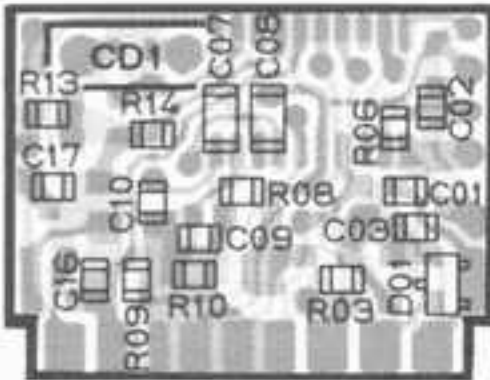


RESISTOR VALUES ARE IN Ω, 1/10W  
CAPACITOR VALUES ARE IN μF, 50V  
INDUCTOR VALUES ARE IN HENRIES, UNLESS OTHERWISE NOTED.

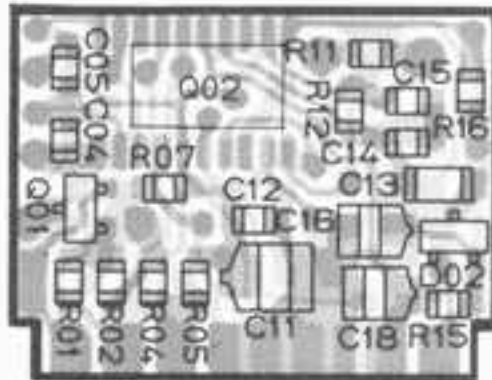


2SK302Y (TY)  
(Q201,202)

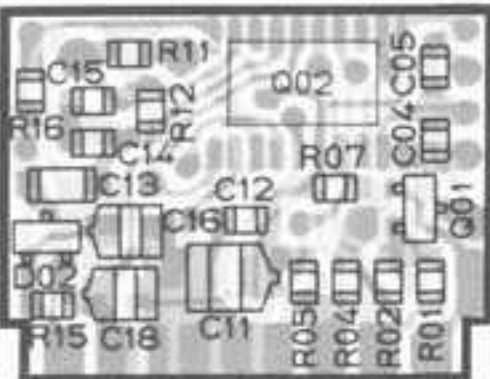
# IF UNIT



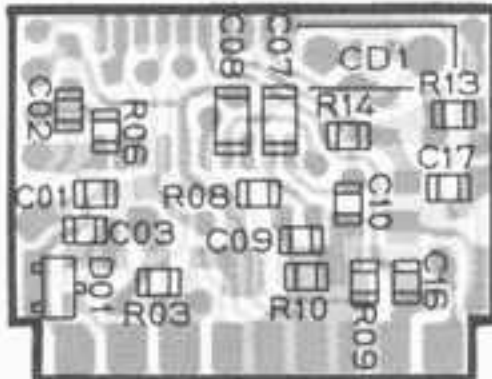
(obverse view of "mixed-component" side)



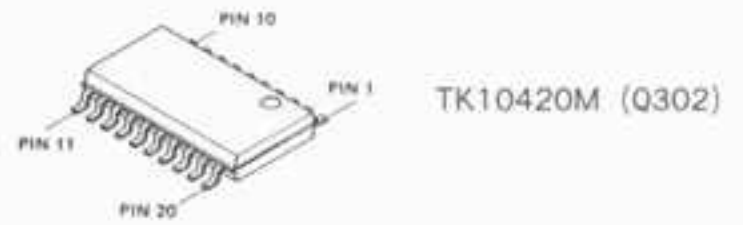
(obverse view of "chip-only" side)



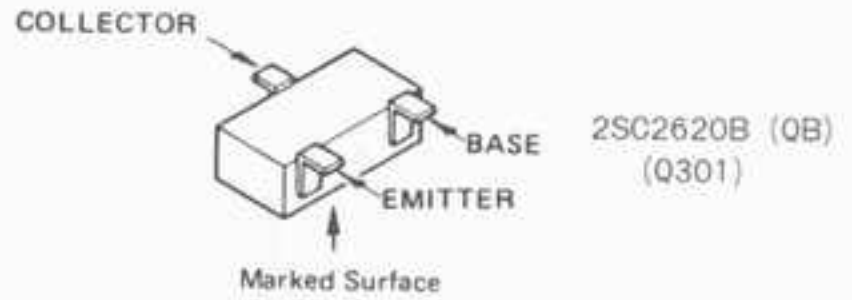
(reverse view of "chip-only" side)



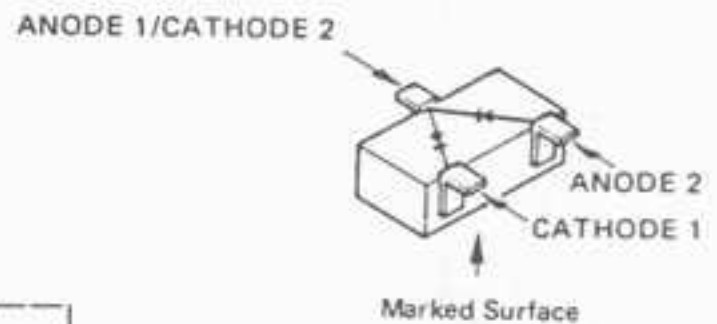
(reverse view of "mixed-component" side)



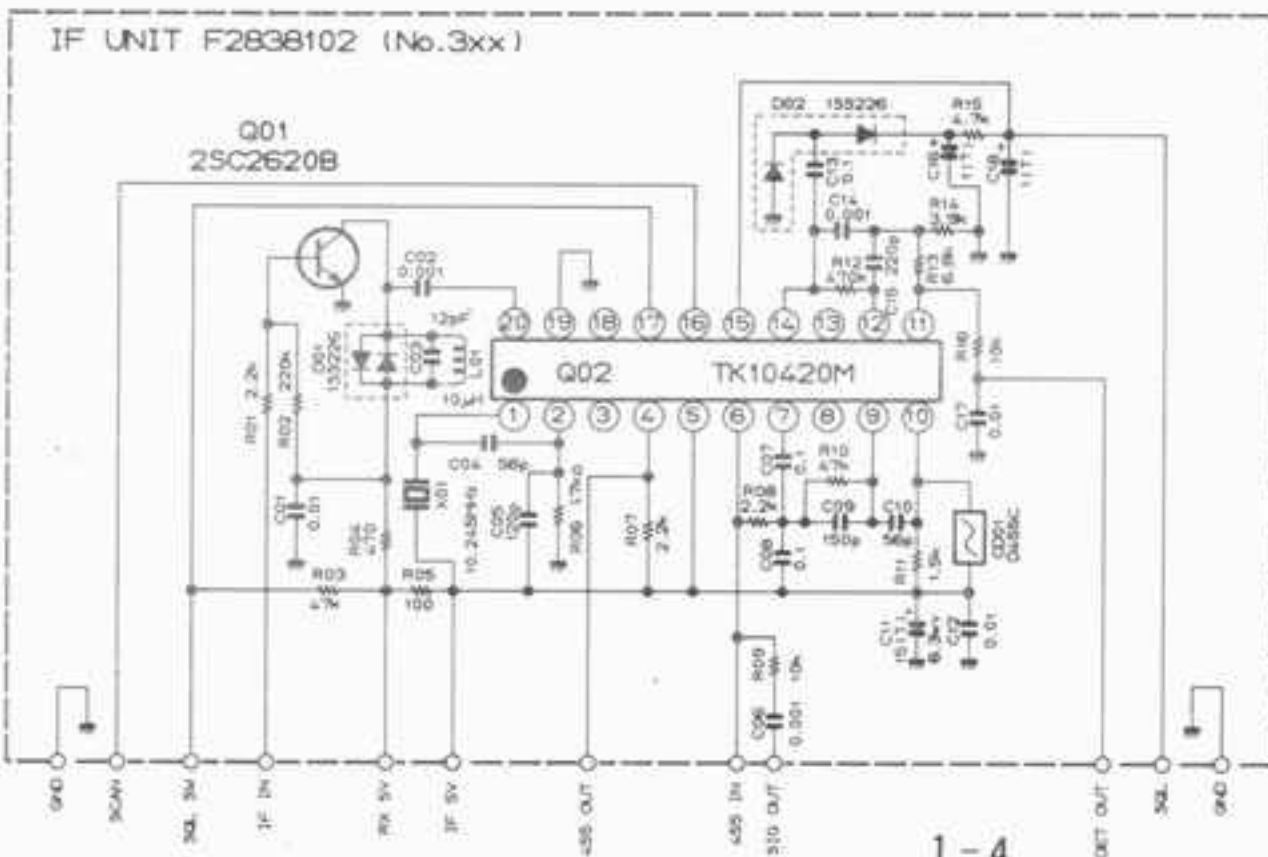
TK10420M (Q302)



2SC2620B (OB)  
(Q301)



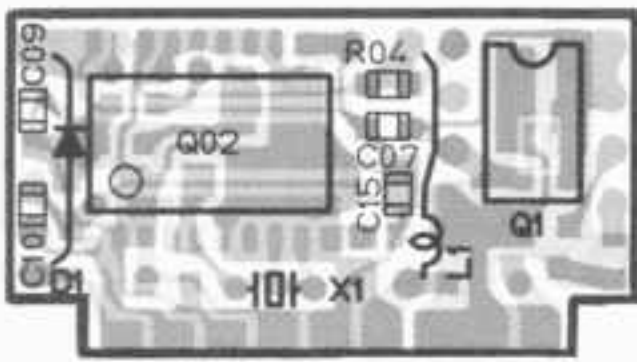
1SS226 (C3)  
(D301,302)



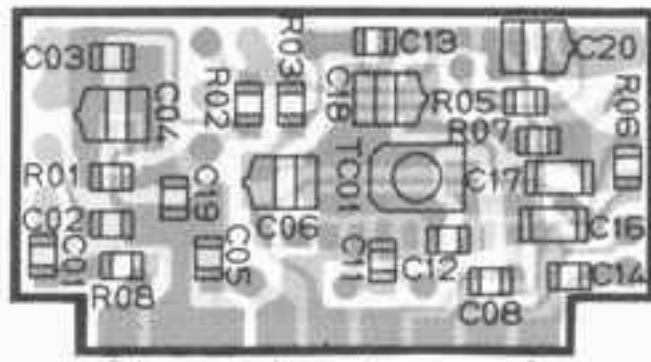
RESISTOR VALUES ARE IN Ω, 1/10W  
CAPACITOR VALUES ARE IN μF, 50V  
INDUCTOR VALUES ARE IN HENRIES, UNLESS OTHERWISE NOTED.  
(T) CAPACITORS ARE TANTALUM, 10V.



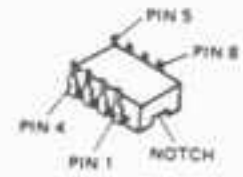
## PLL UNIT



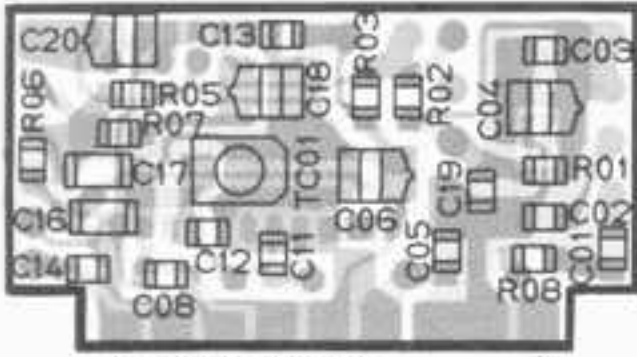
(obverse view of "mixed-component" side)



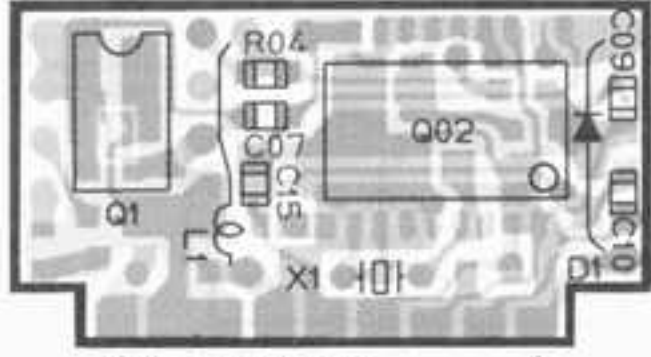
(obverse view of "chip-only" side)



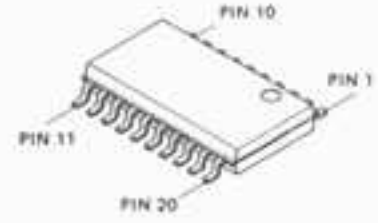
MC12017P (Q401)



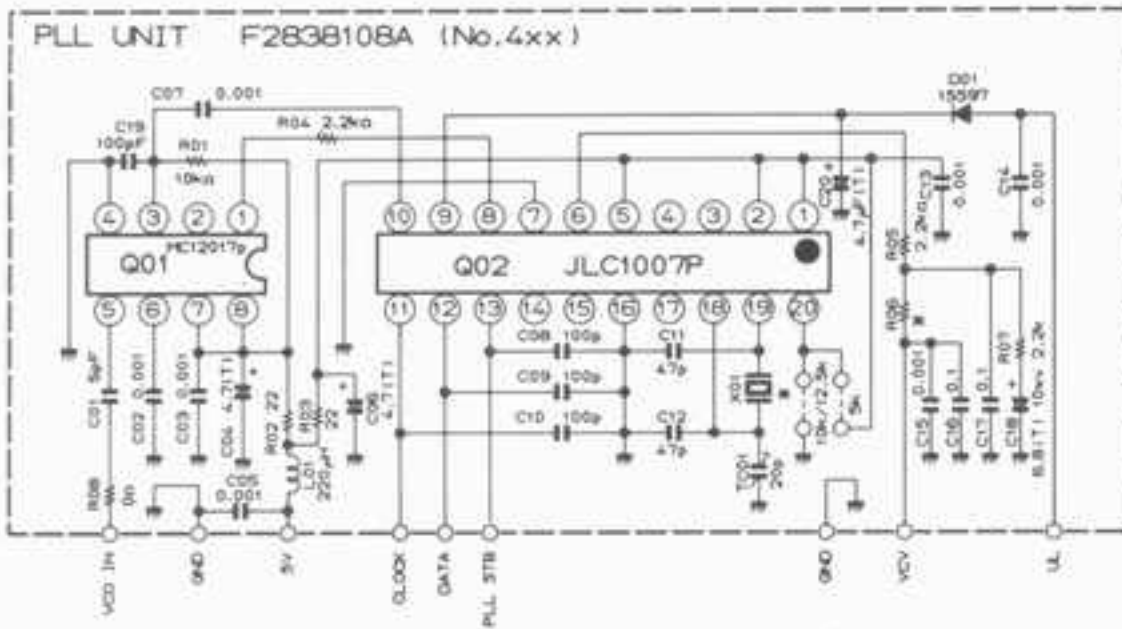
(reverse view of "chip-only" side)



(reverse view of "mixed-component" side)



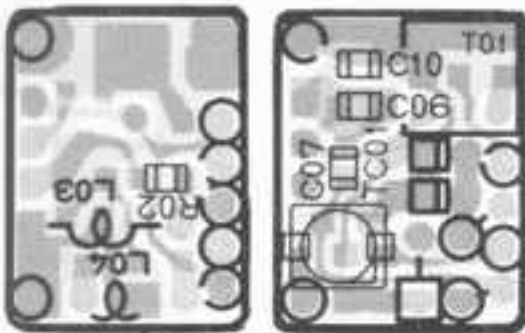
JLC1007P (Q402)



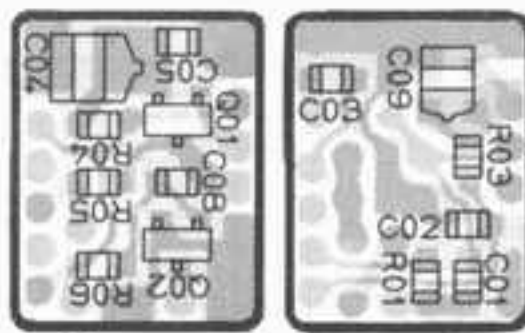
R06	15k $\Omega$ - 5k $\Omega$
	10k $\Omega$ - 10k $\Omega$ STEP
	4.7k $\Omega$ - 12.5k $\Omega$ STEP
X01	10.24MHz - 5MHz STEP
	12.8MHz - 12.5MHz STEP

RESISTOR VALUES ARE IN  $\Omega$ , 1/10 $\Omega$ ;  
CAPACITOR VALUES ARE IN  $\mu$ F, 50V+;  
INDUCTOR VALUES ARE IN HENRIES, UNLESS OTHERWISE NOTED.  
(T) CAPACITORS ARE TANTALUM, 6.3V.

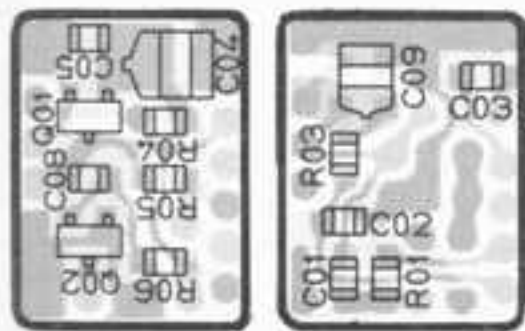
## VCO UNIT



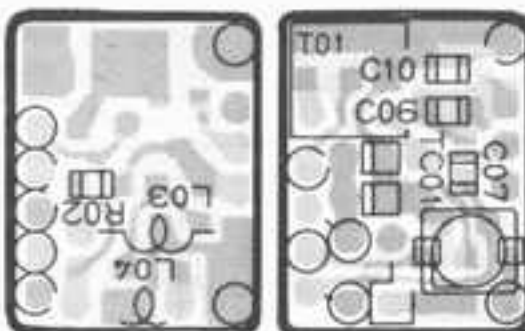
(obverse view of "mixed-component" side)



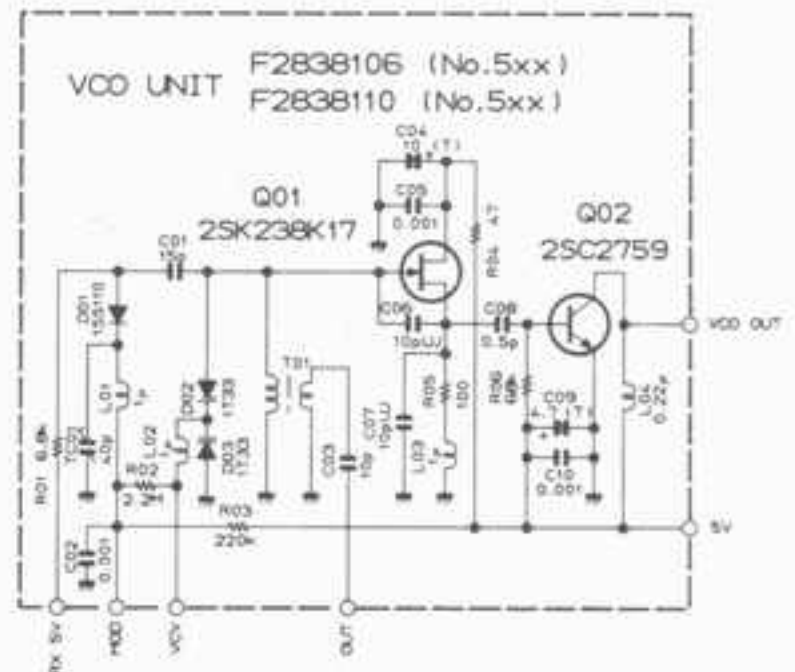
(obverse view of "chip-only" side)



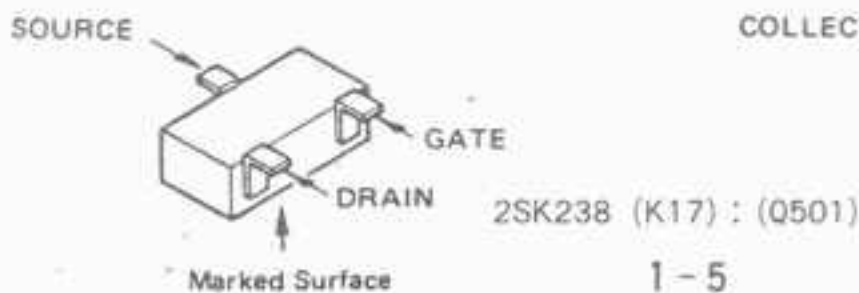
(reverse view of "chip-only" side)



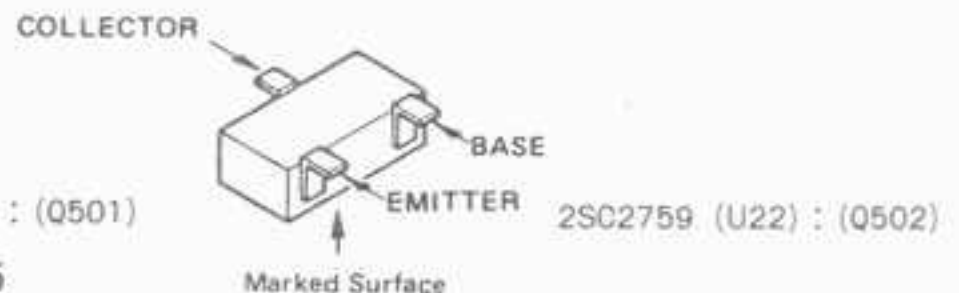
(reverse view of "mixed-component" side)



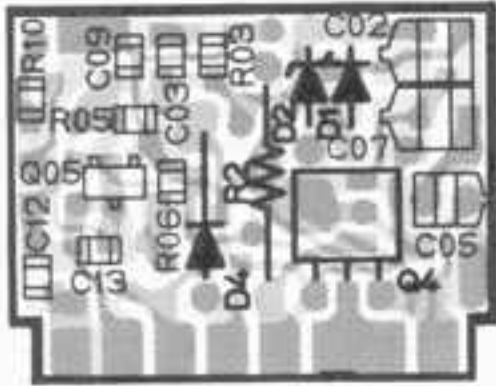
RESISTOR VALUES ARE IN  $\Omega$ , 1/10 $\Omega$ ;  
CAPACITOR VALUES ARE IN  $\mu$ F, 50V+;  
UNLESS OTHERWISE NOTED.  
(T) CAPACITORS ARE TANTALUM, 6.3V.



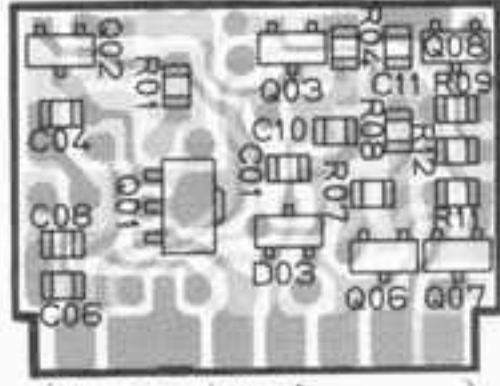
1 - 5



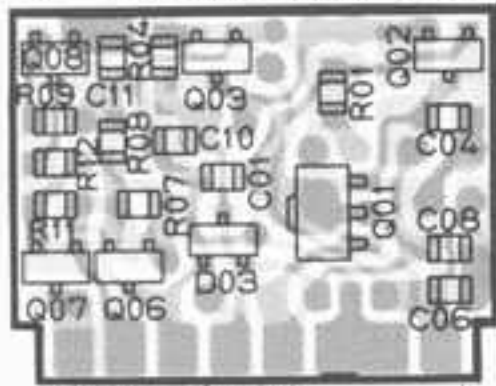
# REG UNIT



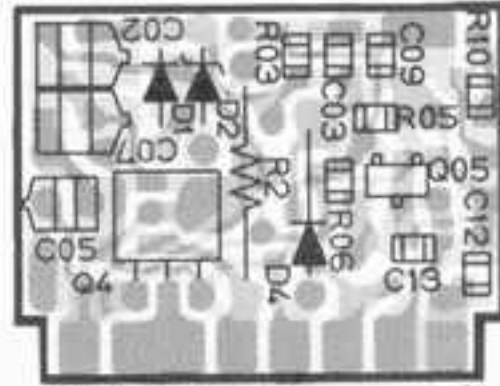
(obverse view of "mixed-component" side)



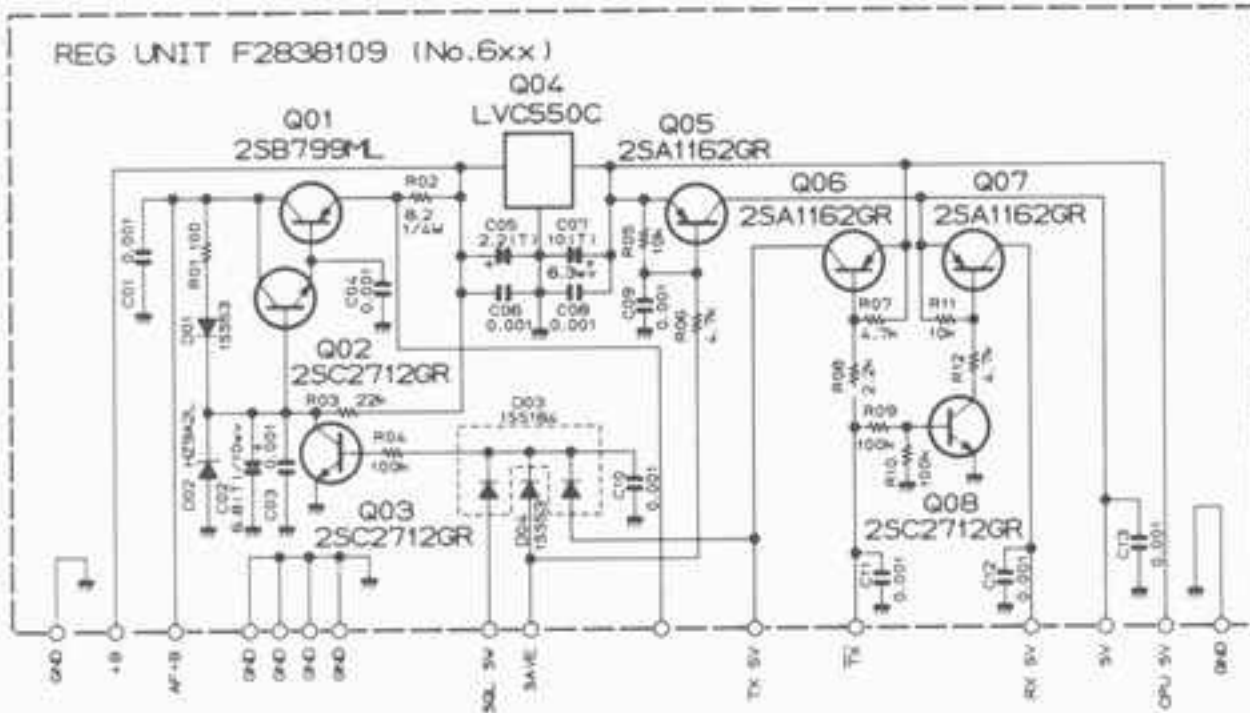
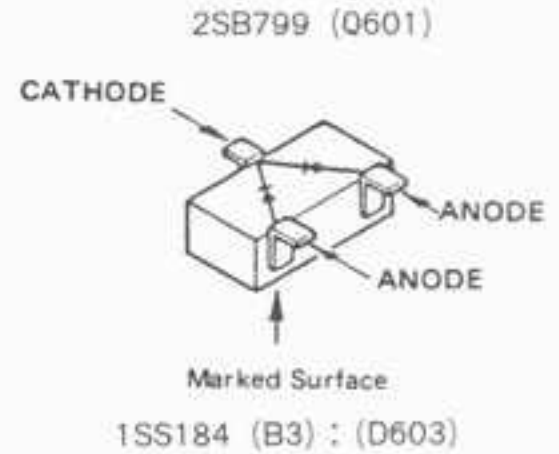
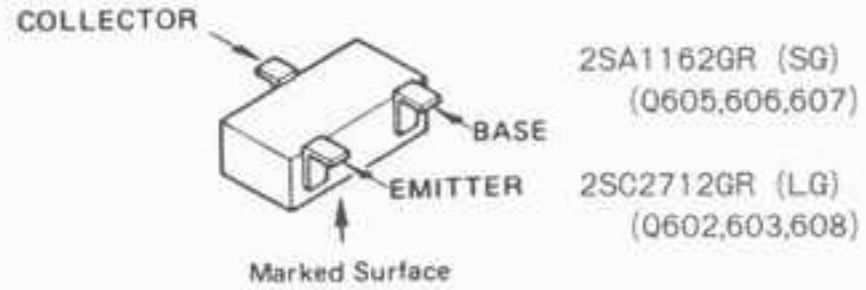
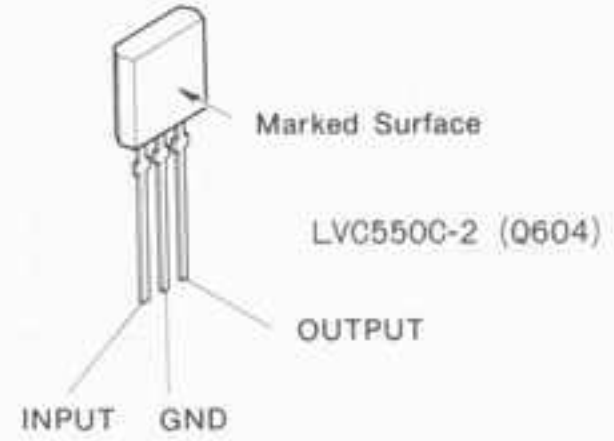
(obverse view of "chip-only" side)



(reverse view of "chip-only" side)

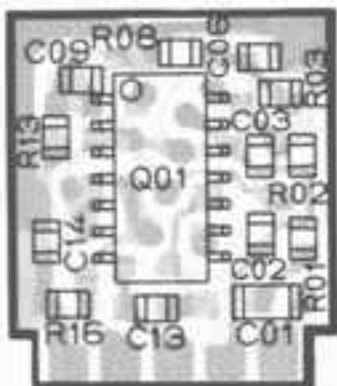


(reverse view of "mixed-component" side)

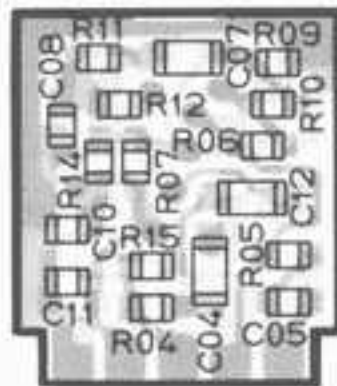


RESISTOR VALUES ARE IN Ω, 1/10W;  
CAPACITOR VALUES ARE IN μF, 50V;  
UNLESS OTHERWISE NOTED.  
(T) CAPACITORS ARE TANTALUM, 10V.

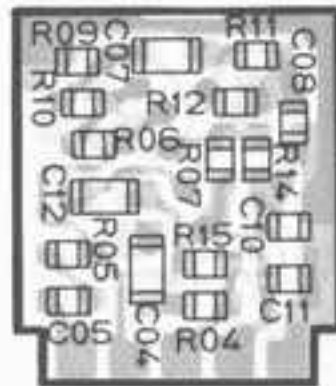
# MIC AMP UNIT



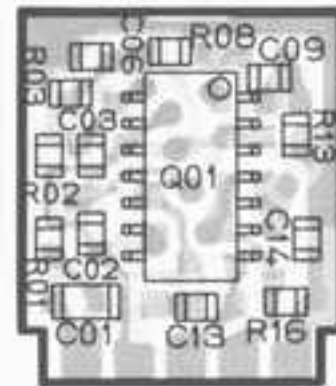
(obverse view of "-IC-" side)



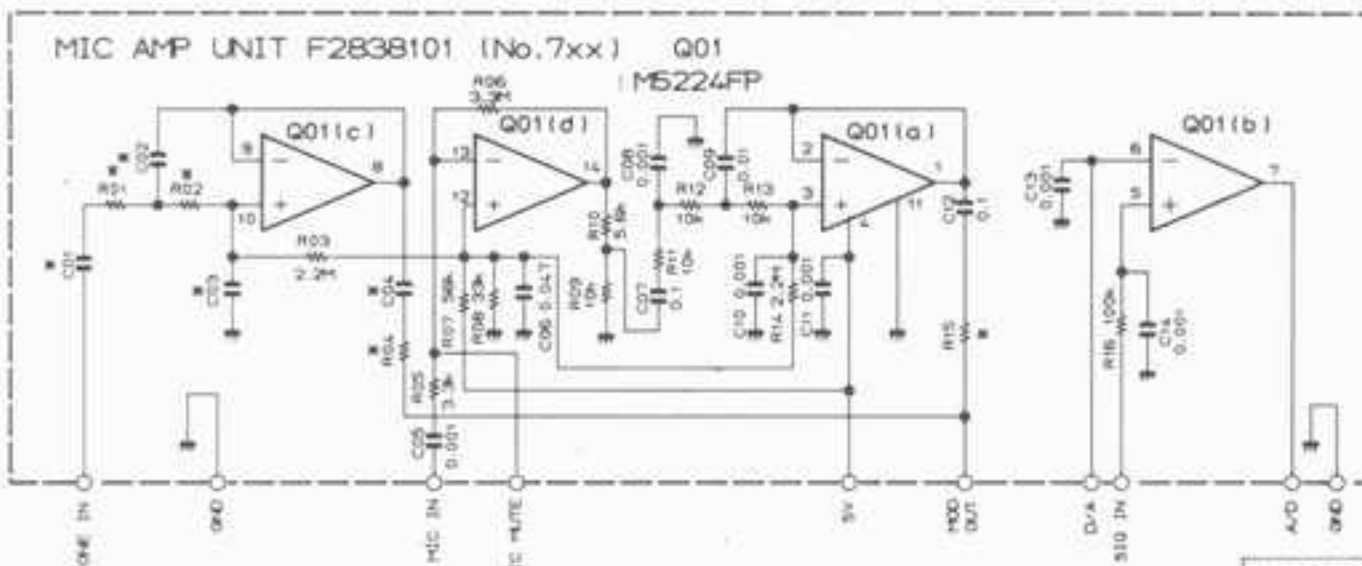
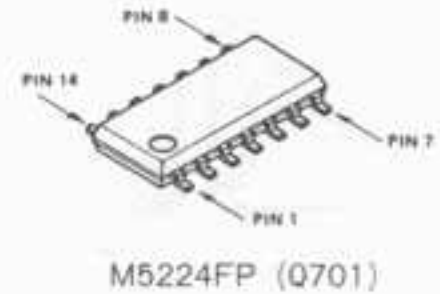
(reverse view of "-C-R-" side)



(obverse view of "-C-R-" side)



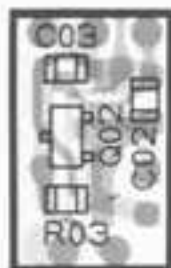
(reverse view of "-IC-" side)



RESISTOR VALUES ARE IN Ω, 1/10W;  
CAPACITOR VALUES ARE IN μF, 50V;  
UNLESS OTHERWISE NOTED.

	C01	C02	C03	C04	R01	R02	R04	R15
B.C.D.E TYPE	0.1	0.01	0.0022	0.1	10k	10k	22k	22k
A.F TYPE	—	—	0.01	—	—	—	—	22k

## S METER UNIT



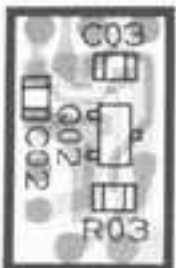
(obverse view of "top" side)



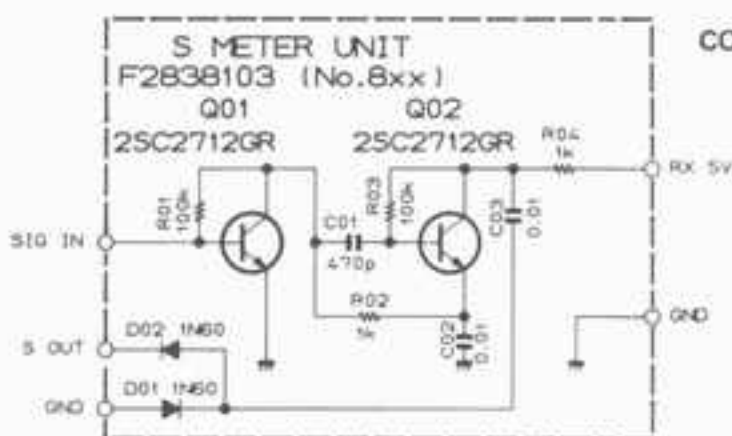
(obverse view of "bottom" side)



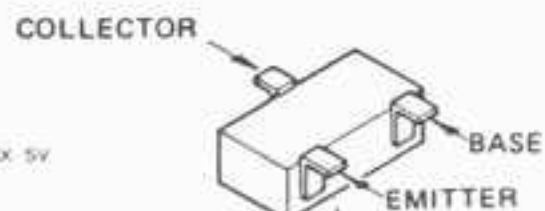
(reverse view of "bottom" side)



(reverse view of "top" side)

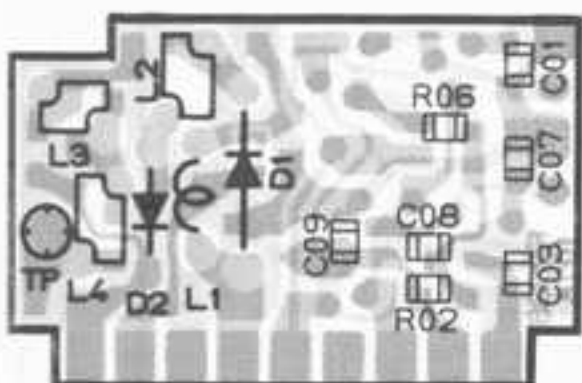


RESISTOR VALUES ARE IN Ω, 1/10W;  
CAPACITOR VALUES ARE IN μF, 50V;  
UNLESS OTHERWISE NOTED.

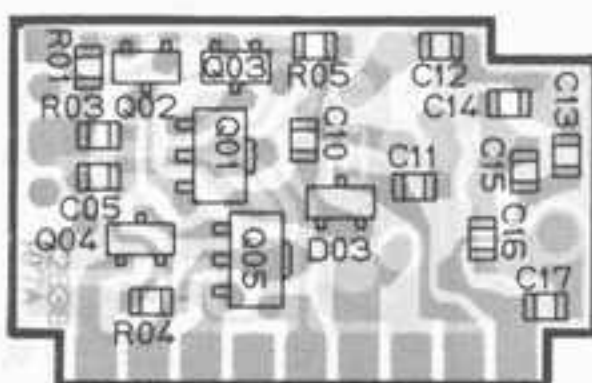


Marked Surface  
25C2712GR (LG)  
(0801,802)

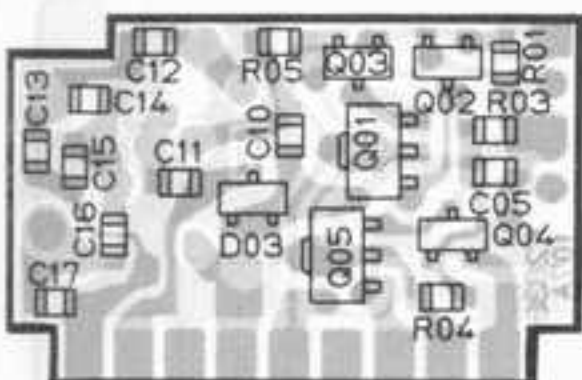
## ANT SW UNIT



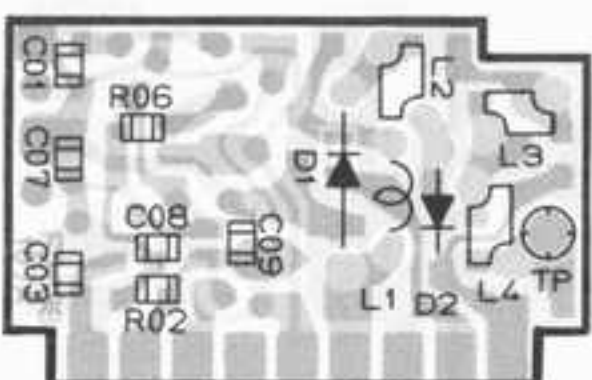
(obverse view of "mixed-component" side)



(obverse view of "chip-only" side)



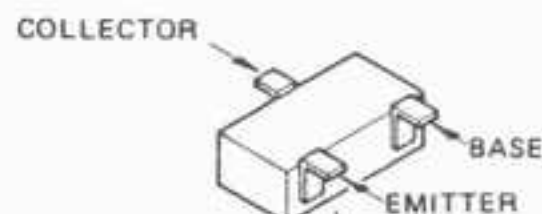
(reverse view of "chip-only" side)



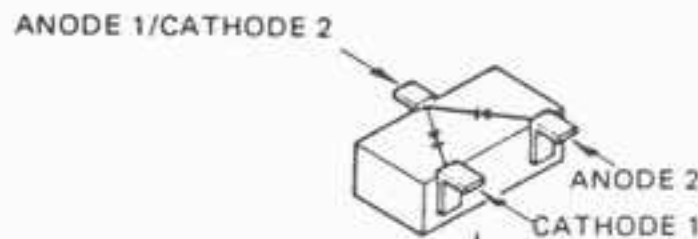
(reverse view of "mixed-component" side)



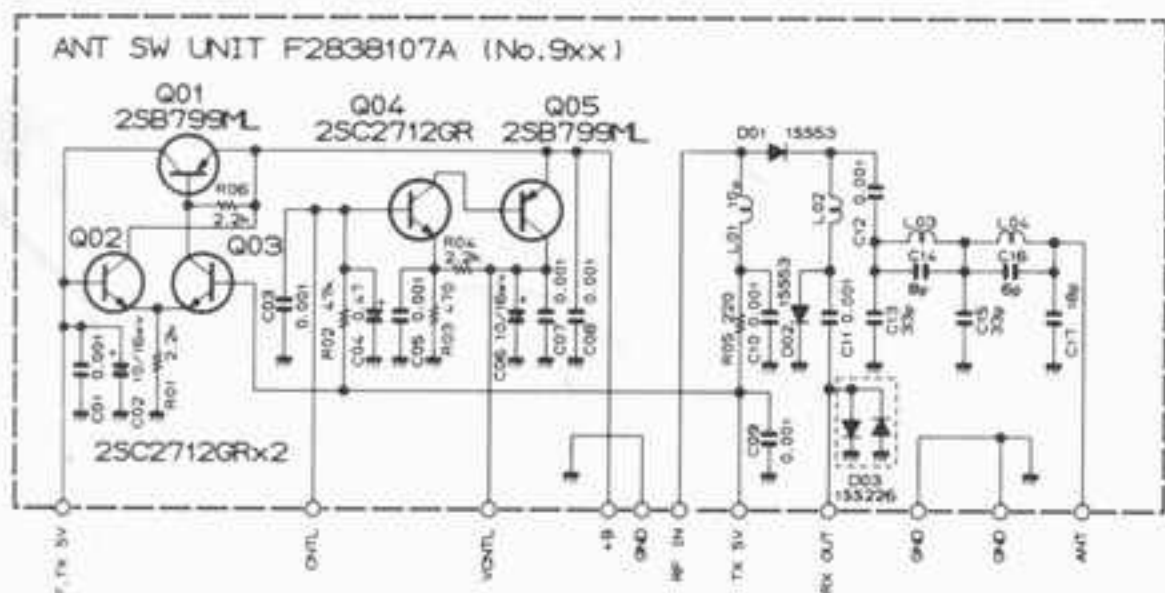
25B799 (0901,905)



Marked Surface  
25C2712GR (LG)  
(0902,903,904)



Marked Surface  
1SS226 (C3) : (D903)



RESISTOR VALUES ARE IN Ω, 1/10W;  
CAPACITOR VALUES ARE IN μF, 50V;  
INDUCTOR VALUES ARE IN HENRIES, UNLESS OTHERWISE NOTED.